



# LPC5410x

**32-bit ARM Cortex-M4/M0+ MCU; 104 kB SRAM; 512 kB flash,  
3 x I2C, 2 x SPI, 4 x USART, 32-bit counter/ timers,  
SCTimer/PWM, 12-bit 5.0 Msamples/sec ADC**

Rev. 2.4 — 13 July 2016

Product data sheet

## 1. General description

The LPC5410x are ARM Cortex-M4 based microcontrollers for embedded applications. These devices include an optional ARM Cortex-M0+ coprocessor, 104 kB of on-chip SRAM, up to 512 kB on-chip flash, five general-purpose timers, one State-Configurable Timer with PWM capabilities (SCTimer/PWM), one RTC/alarm timer, one 24-bit Multi-Rate Timer (MRT), a Repetitive Interrupt Timer (RIT), a Windowed Watchdog Timer (WWDT), four USARTs, two SPIs, three Fast-mode plus I<sup>2</sup>C-bus interfaces with high-speed slave mode, and one 12-bit 5.0 Msamples/sec ADC.

The ARM Cortex-M4 is a 32-bit core that offers system enhancements such as low power consumption, enhanced debug features, and a high level of support block integration. The ARM Cortex-M4 CPU incorporates a 3-stage pipeline, uses a Harvard architecture with separate local instruction and data buses as well as a third bus for peripherals, and includes an internal prefetch unit that supports speculative branching. The ARM Cortex-M4 supports single-cycle digital signal processing and SIMD instructions. A hardware floating-point unit is integrated in the core.

The ARM Cortex-M0+ coprocessor is an energy-efficient and easy-to-use 32-bit core which is code and tool-compatible with the Cortex-M4 core. The Cortex-M0+ coprocessor offers up to 100 MHz performance with a simple instruction set and reduced code size. In LPC5410x, the Cortex-M0 coprocessor hardware multiply is implemented as a 32-cycle iterative multiplier.

## 2. Features and benefits

- Dual processor cores: ARM Cortex-M4 and ARM Cortex-M0+. The M0+ core runs at the same frequency as the M4 core. Both cores operate up to a maximum frequency of 100 MHz.
- ARM Cortex-M4 core (version r0p1):
  - ◆ ARM Cortex-M4 processor, running at a frequency of up to 100 MHz, using the same clock as the Cortex-M4.
  - ◆ Floating Point Unit (FPU) and Memory Protection Unit (MPU).
  - ◆ ARM Cortex-M4 built-in Nested Vectored Interrupt Controller (NVIC).
  - ◆ Non-maskable Interrupt (NMI) input with a selection of sources.
  - ◆ Serial Wire Debug with eight breakpoints and four watch points.  
Includes Serial Wire Output for enhanced debug capabilities.
  - ◆ System tick timer.



- ARM Cortex-M0+ core (version r0p1):
  - ◆ ARM Cortex-M0+ processor, running at a frequency of up to 100 MHz.
  - ◆ ARM Cortex-M0+ built-in Nested Vectored Interrupt Controller (NVIC).
  - ◆ Non-maskable Interrupt (NMI) input with a selection of sources.
  - ◆ Serial Wire Debug with four breakpoints and two watch points.
  - ◆ System tick timer.
- On-chip memory:
  - ◆ Up to 512 kB on-chip flash program memory with flash accelerator and 256 byte page erase and write.
  - ◆ 104 kB total SRAM composed of:
    - ◆ Up to 96 kB contiguous main SRAM.
    - ◆ An additional 8 kB SRAM.
- ROM API support:
  - ◆ Flash In-Application Programming (IAP) and In-System Programming (ISP).
  - ◆ Power control API.
- Serial interfaces:
  - ◆ Four USART interfaces with synchronous mode and 32 kHz mode for wake-up from deep sleep and power down modes. The USARTs have FIFO support from the System FIFO and share a fractional baud-rate generator.
  - ◆ Two SPI interfaces, each with four slave selects and flexible data configuration. The SPIs have FIFO support from the System FIFO. The slave function is able to wake up the device from deep sleep and power down modes.
  - ◆ Three I<sup>2</sup>C-bus interfaces supporting fast mode and Fast-mode Plus with data rates of up to 1Mbit/s and with multiple address recognition and monitor mode. Each I<sup>2</sup>C-bus interface also supports High Speed Mode (3.4 Mbit/s) as a slave. The slave function is able to wake up the device from deep sleep and power down modes.
- Digital peripherals:
  - ◆ DMA controller with 22 channels and 20 programmable triggers, able to access all memories and DMA-capable peripherals.
  - ◆ Up to 50 General-Purpose Input/Output (GPIO) pins. Most GPIOs have configurable pull-up/pull-down resistors, programmable open-drain mode, and input inverter.
  - ◆ GPIO registers are located on the AHB for fast access. The DMA supports GPIO ports.
  - ◆ Up to eight GPIOs (pin interrupts) can be selected as edge-sensitive (rising or falling edges or both) interrupt requests or level-sensitive (active low or active high) interrupt requests. In addition, up to eight GPIOs can be selected to contribute a boolean expression and interrupt generation using the pattern match engine block.
  - ◆ Two GPIO grouped interrupts (GINT) enable an interrupt based on a logical (AND/OR) combination of input states.
  - ◆ CRC engine.
- Timers:
  - ◆ Five 32-bit standard general purpose timers/counters, four of which support up to 4 capture inputs and 4 compare outputs, PWM mode, and external count input. Specific timer events can be selected to generate DMA requests. The fifth timer does not have external pin connections and may be used for internal timing operations.

- ◆ One State Configurable Timer/PWM (SCT/PWM) with 8 inputs (6 external inputs and 2 internal inputs) and 8 output functions (including capture and match). Inputs and outputs can be routed to/from external pins and internally to/from selected peripherals. Internally, the SCT supports 13 captures/matches, 13 events and 13 states.
- ◆ 32-bit Real-time clock (RTC) with 1 s resolution running in the always-on power domain. A timer in the RTC can be used for wake-up from all low power modes including deep power-down, with 1 ms resolution.
- ◆ Multiple-channel multi-rate 24-bit timer (MRT) for repetitive interrupt generation at up to four programmable, fixed rates.
- ◆ Windowed Watchdog Timer (WWDT).
- ◆ Ultra-low power Micro-tick Timer, running from the Watchdog oscillator, that can be used to wake up the device from low power modes.
- ◆ Repetitive Interrupt Timer (RIT) for debug time-stamping and general-purpose use.
- Analog peripheral: 12-bit, 12-channel, Analog-to-Digital Converter (ADC) supporting 5.0 Msamples/s. The ADC supports two independent conversion sequences.
- Clock generation:
  - ◆ 12 MHz internal RC oscillator.
  - ◆ External clock input for clock frequencies of up to 25 MHz.
  - ◆ Internal low-power, watchdog oscillator (WDOSC) with a nominal frequency of 500 kHz.
  - ◆ 32 kHz low-power RTC oscillator.
  - ◆ System PLL allows CPU operation up to the maximum CPU rate. May be run from the internal RC oscillator, the external clock input CLKIN, or the RTC oscillator.
  - ◆ Clock output function for monitoring internal clocks.
  - ◆ Frequency measurement unit for measuring the frequency of any on-chip or off-chip clock signal.
- Power-saving modes and wake-up:
  - ◆ Integrated PMU (Power Management Unit) to minimize power consumption.
  - ◆ Reduced power modes: sleep, deep sleep, power down, and deep power-down.
  - ◆ Wake-up from deep sleep and power down modes via activity on the USART, SPI, and I<sup>2</sup>C peripherals.
  - ◆ Wake-up from sleep, deep sleep, power down, and deep power-down modes using the RTC alarm.
- Single power supply 1.62 V to 3.6 V.
- Power-On Reset (POR).
- Brown-Out Detect (BOD) with separate thresholds for interrupt and forced reset.
- JTAG boundary scan supported.
- Unique device serial number (128 bit) for identification.
- Operating temperature range –40 °C to 105 °C.
- Available in a 3.288 x 3.288 mm WLCSP49 package and LQFP64 package.

### 3. Ordering information

Table 1. Ordering information

| Type number      | Package |                                                                          |          |
|------------------|---------|--------------------------------------------------------------------------|----------|
|                  | Name    | Description                                                              | Version  |
| LPC54102J512UK49 | WLCSP49 | wafer level chip-size package; 49 (7 x 7) bumps; 3.288 x 3.288 x 0.54 mm | -        |
| LPC54102J256UK49 | WLCSP49 | wafer level chip-size package; 49 (7 x 7) bumps; 3.288 x 3.288 x 0.54 mm | -        |
| LPC54101J512UK49 | WLCSP49 | wafer level chip-size package; 49 (7 x 7) bumps; 3.288 x 3.288 x 0.54 mm | -        |
| LPC54101J256UK49 | WLCSP49 | wafer level chip-size package; 49 (7 x 7) bumps; 3.288 x 3.288 x 0.54 mm | -        |
| LPC54102J512BD64 | LQFP64  | plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm   | SOT314-2 |
| LPC54102J256BD64 | LQFP64  | plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm   | SOT314-2 |
| LPC54101J512BD64 | LQFP64  | plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm   | SOT314-2 |
| LPC54101J256BD64 | LQFP64  | plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm   | SOT314-2 |

#### 3.1 Ordering options

Table 2. Ordering options

| Type number      | Device order part number | Flash/kB | Total SRAM/kB | Core M4 w/ FPU | Core M0+ | GPIO |
|------------------|--------------------------|----------|---------------|----------------|----------|------|
| LPC54102J512UK49 | LPC54102J512UK49Z        | 512      | 104           | 1              | 1        | 39   |
| LPC54102J256UK49 | LPC54102J256UK49Z        | 256      | 104           | 1              | 1        | 39   |
| LPC54101J512UK49 | LPC54101J512UK49Z        | 512      | 104           | 1              | 0        | 39   |
| LPC54101J256UK49 | LPC54101J256UK49Z        | 256      | 104           | 1              | 0        | 39   |
| LPC54102J512BD64 | LPC54102J512BD64QL       | 512      | 104           | 1              | 1        | 50   |
| LPC54102J256BD64 | LPC54102J256BD64QL       | 256      | 104           | 1              | 1        | 50   |
| LPC54101J512BD64 | LPC54101J512BD64QL       | 512      | 104           | 1              | 0        | 50   |
| LPC54101J256BD64 | LPC54101J256BD64QL       | 256      | 104           | 1              | 0        | 50   |

- [1] All of the parts include five 32-bit general-purpose timers, one State-Configurable Timer with PWM capabilities (SCTimer/PWM), one RTC/alarm timer, one 24-bit Multi-Rate Timer (MRT), a Windowed Watchdog Timer (WWDT), four USARTs, two SPIs, three Fast-mode plus I2C-bus interfaces with high-speed slave mode, and one 12-bit 5.0 Msamples/sec ADC.

### 4. Marking

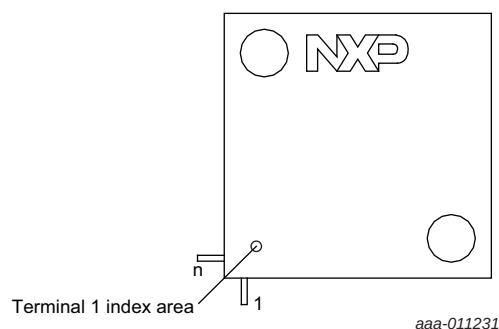


Fig 1. LQFP64 package marking

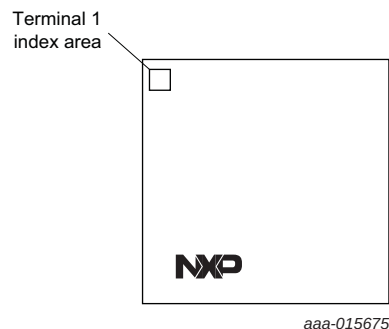


Fig 2. WLCSP49 package marking

The LPC5410x LQFP64 package has the following top-side marking:

- First line: LPC5410xJyyy
  - x: 2 = dual core (M4, M0+), 1 = single core (M4)
  - yyy: flash size
- Second line: BD64
- Third line: xxxxxxxxxxxx
- Fourth line: xxxyywwx[R]z
  - yyww: Date code with yy = year and ww = week.
  - xR = boot code version and device revision.

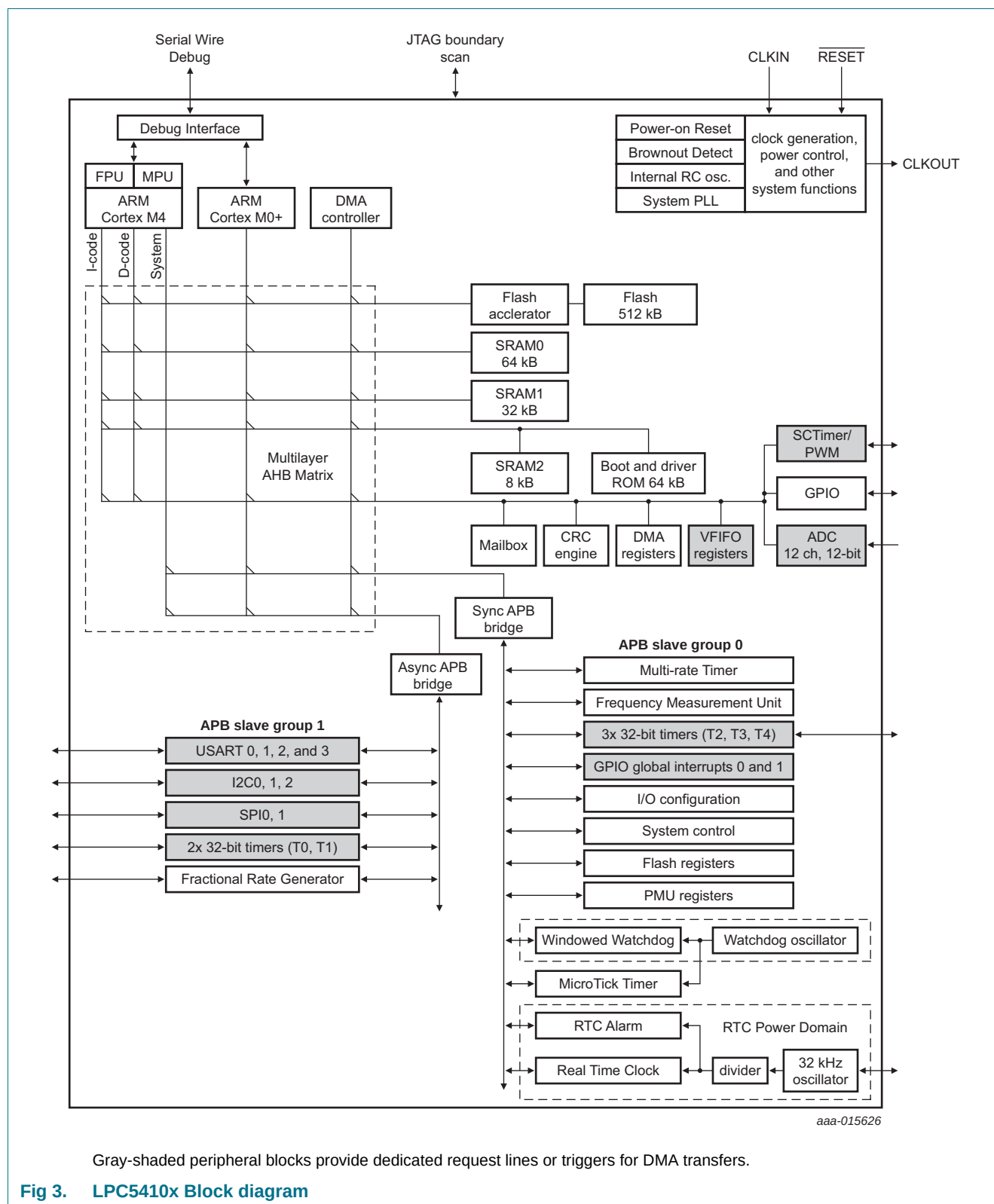
The LPC5410x WLCSP49 package has the following top-side marking:

- First line: LPC5410x
  - x: 2 = dual core (M4, M0+), 1 = single core (M4)
- Second line: JxxxUK49
  - xxx: flash size
- Third line: xxxxxxxx
- Fourth line: xxxyyww
  - yyww: Date code with yy = year and ww = week.
- Fifth line: xxxxx
- Sixth line: NXP x[R]z
  - xR = boot code version and device revision.

**Table 3. Device revision table**

| Revision identifier (R) | Revision description                                 |
|-------------------------|------------------------------------------------------|
| '1B'                    | Initial device revision with boot code version 17.1. |
| '1C'                    | Second device revision with boot code version 17.1.  |

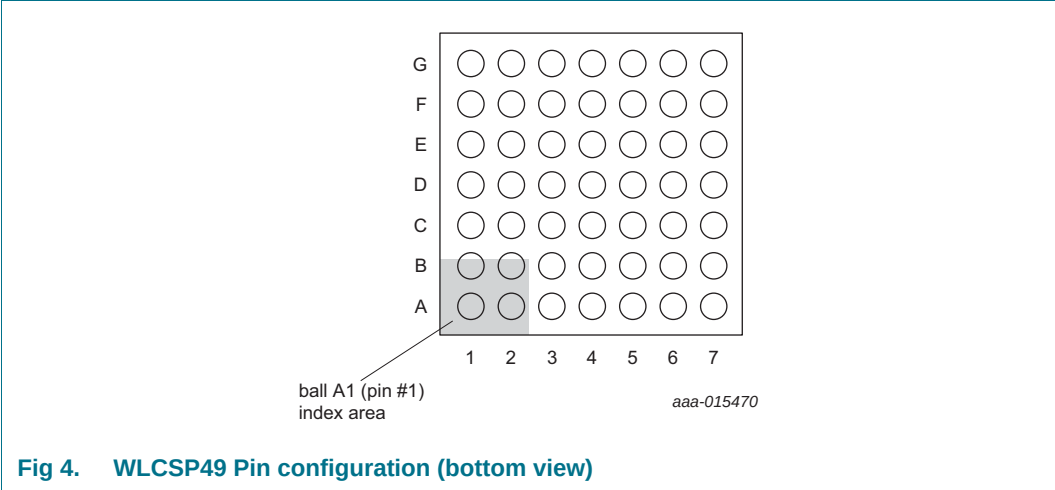
## 5. Block diagram



**Fig 3. LPC5410x Block diagram**

6. Pinning information

6.1 Pinning



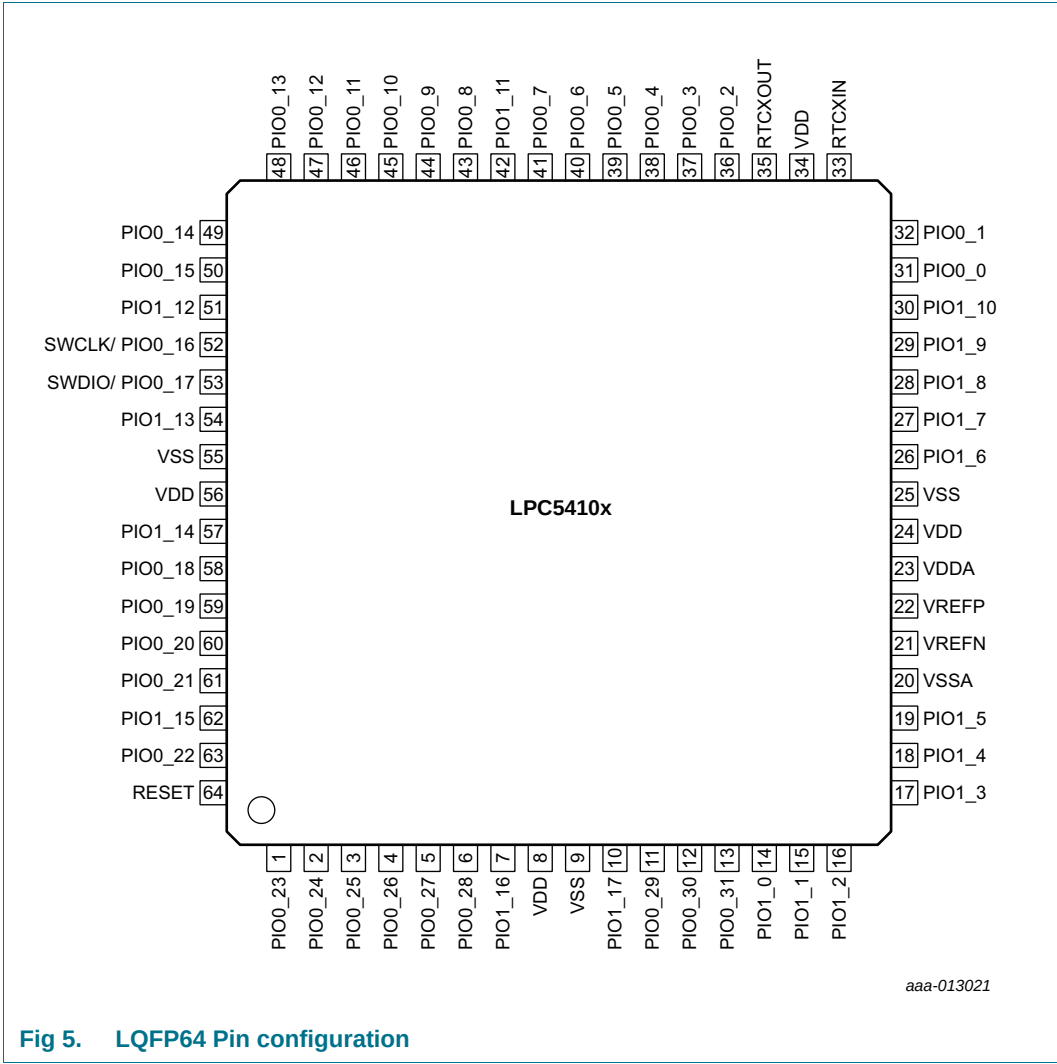


Fig 5. LQFP64 Pin configuration



## 6.2 Pin description

On the LPC5410x, digital pins are grouped into two ports. Each digital pin may support up to four different digital functions and one analog function, including General Purpose I/O (GPIO).

Table 4. Pin description

| Symbol | WLCSP49 | LQFP64 | Reset state <sup>[1]</sup> | Type <sup>[6]</sup> | Description                                                                                                                  |
|--------|---------|--------|----------------------------|---------------------|------------------------------------------------------------------------------------------------------------------------------|
| PIO0_0 | A6      | 31     | <sup>[2]</sup> PU          | I/O                 | <b>PIO0_0</b> — General-purpose digital input/output pin.<br><b>Remark:</b> In ISP mode, this pin is the UART0 RXD function. |
|        |         |        |                            | I                   | <b>U0_RXD</b> — Receiver input for USART0.                                                                                   |
|        |         |        |                            | I/O                 | <b>SPI0_SSEL0</b> — Slave Select 0 for SPI0.                                                                                 |
|        |         |        |                            | I                   | <b>CT32B0_CAP0</b> — 32-bit CT32B0 capture input 0.                                                                          |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |
|        |         |        |                            | O                   | <b>SCT0_OUT3</b> — SCT0 output 3. PWM output 3.                                                                              |
| PIO0_1 | B6      | 32     | <sup>[2]</sup> PU          | I/O                 | <b>PIO0_1</b> — General-purpose digital input/output pin.<br><b>Remark:</b> In ISP mode, this pin is the UART0 TXD function. |
|        |         |        |                            | O                   | <b>U0_TXD</b> — Transmitter output for USART0.                                                                               |
|        |         |        |                            | I/O                 | <b>SPI0_SSEL1</b> — Slave Select 1 for SPI0.                                                                                 |
|        |         |        |                            | I                   | <b>CT32B0_CAP1</b> — 32-bit CT32B0 capture input 1.                                                                          |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |
|        |         |        |                            | O                   | <b>SCT0_OUT1</b> — SCT0 output 1. PWM output 1.                                                                              |
| PIO0_2 | -       | 36     | <sup>[2]</sup> PU          | I/O                 | <b>PIO0_2</b> — General-purpose digital input/output pin.                                                                    |
|        |         |        |                            | I                   | <b>U0_CTS</b> — Clear To Send input for USART0.                                                                              |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |
|        |         |        |                            | I                   | <b>CT32B2_CAP1</b> — 32-bit CT32B2 capture input 1.                                                                          |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |
| PIO0_3 | -       | 37     | <sup>[2]</sup> PU          | I/O                 | <b>PIO0_3</b> — General-purpose digital input/output pin.                                                                    |
|        |         |        |                            | O                   | <b>U0_RTS</b> — Request To Send output for USART0.                                                                           |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |
|        |         |        |                            | O                   | <b>CT32B1_MAT3</b> — 32-bit CT32B1 match output 3.                                                                           |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |
| PIO0_4 | C7      | 38     | <sup>[2]</sup> PU          | I/O                 | <b>PIO0_4</b> — General-purpose digital input/output pin.                                                                    |
|        |         |        |                            | I/O                 | <b>U0_SCLK</b> — USART0 clock in synchronous USART mode.                                                                     |
|        |         |        |                            | I/O                 | <b>SPI0_SSEL2</b> — Slave Select 2 for SPI0.                                                                                 |
|        |         |        |                            | I                   | <b>CT32B0_CAP2</b> — 32-bit CT32B0 capture input 2.                                                                          |
|        |         |        |                            | I                   | <b>R</b> — Reserved.                                                                                                         |

Table 4. Pin description ...continued

| Symbol  | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                |
|---------|---------|--------|-----------------|----------|------------------------------------------------------------|
| PIO0_5  | C6      | 39     | [2] PU          | I/O      | <b>PIO0_5</b> — General-purpose digital input/output pin.  |
|         |         |        |                 | I        | <b>U1_RXD</b> — Receiver input for USART1.                 |
|         |         |        |                 | O        | <b>SCT0_OUT6</b> — SCT0 output 6. PWM output 6.            |
|         |         |        |                 | O        | <b>CT32B0_MAT0</b> — 32-bit CT32B0 match output 0.         |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
| PIO0_6  | D7      | 40     | [2] PU          | I/O      | <b>PIO0_6</b> — General-purpose digital input/output pin.  |
|         |         |        |                 | O        | <b>U1_TXD</b> — Transmitter output for USART1.             |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
|         |         |        |                 | O        | <b>CT32B0_MAT1</b> — 32-bit CT32B0 match output 1.         |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
| PIO0_7  | D6      | 41     | [2] PU          | I/O      | <b>PIO0_7</b> — General-purpose digital input/output pin.  |
|         |         |        |                 | I/O      | <b>U1_SCLK</b> — USART1 clock in synchronous USART mode.   |
|         |         |        |                 | O        | <b>SCT0_OUT0</b> — SCT0 output 0. PWM output 0.            |
|         |         |        |                 | O        | <b>CT32B0_MAT2</b> — 32-bit CT32B0 match output 2.         |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
| PIO0_8  | D5      | 43     | [2] PU          | I/O      | <b>PIO0_8</b> — General-purpose digital input/output pin.  |
|         |         |        |                 | I        | <b>U2_RXD</b> — Receiver input for USART2.                 |
|         |         |        |                 | O        | <b>SCT0_OUT1</b> — SCT0 output 1. PWM output 1.            |
|         |         |        |                 | O        | <b>CT32B0_MAT3</b> — 32-bit CT32B0 match output 3.         |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
| PIO0_9  | E7      | 44     | [2] PU          | I/O      | <b>PIO0_9</b> — General-purpose digital input/output pin.  |
|         |         |        |                 | O        | <b>U2_TXD</b> — Transmitter output for USART2.             |
|         |         |        |                 | O        | <b>SCT0_OUT2</b> — SCT0 output 2. PWM output 2.            |
|         |         |        |                 | I        | <b>CT32B3_CAP0</b> — 32-bit CT32B3 capture input 0.        |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
| PIO0_10 | E6      | 45     | [2] PU          | I/O      | <b>PIO0_10</b> — General-purpose digital input/output pin. |
|         |         |        |                 | I/O      | <b>U2_SCLK</b> — USART2 clock in synchronous USART mode.   |
|         |         |        |                 | O        | <b>SCT0_OUT3</b> — SCT0 output 3. PWM output 3.            |
|         |         |        |                 | O        | <b>CT32B3_MAT0</b> — 32-bit CT32B3 match output 0.         |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |
| PIO0_11 | E5      | 46     | [2] PU          | I/O      | <b>PIO0_11</b> — General-purpose digital input/output pin. |
|         |         |        |                 | I/O      | <b>SPI0_SCK</b> — Serial clock for SPI0.                   |
|         |         |        |                 | I        | <b>U1_RXD</b> — Receiver input for USART1.                 |
|         |         |        |                 | O        | <b>CT32B2_MAT1</b> — 32-bit CT32B2 match output 1.         |
|         |         |        |                 | I        | <b>R</b> — Reserved.                                       |

Table 4. Pin description ...continued

| Symbol            | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                                                                   |
|-------------------|---------|--------|-----------------|----------|---------------------------------------------------------------------------------------------------------------|
| PIO0_12           | F7      | 47     | [2] PU          | I/O      | <b>PIO0_12</b> — General-purpose digital input/output pin.                                                    |
|                   |         |        |                 | I/O      | <b>SPI0_MOSI</b> — Master Out Slave in for SPI0.                                                              |
|                   |         |        |                 | O        | <b>U1_TXD</b> — Transmitter output for USART1.                                                                |
|                   |         |        |                 | O        | <b>CT32B2_MAT3</b> — 32-bit CT32B2 match output 3.                                                            |
|                   |         |        |                 | I        | <b>R</b> — Reserved.                                                                                          |
| PIO0_13           | G7      | 48     | [2] PU          | I/O      | <b>PIO0_13</b> — General-purpose digital input/output pin.                                                    |
|                   |         |        |                 | I/O      | <b>SPI0_MISO</b> — Master In Slave Out for SPI0.                                                              |
|                   |         |        |                 | O        | <b>SCT0_OUT4</b> — SCT0 output 4. PWM output 4.                                                               |
|                   |         |        |                 | O        | <b>CT32B2_MAT0</b> — 32-bit CT32B2 match output 0.                                                            |
|                   |         |        |                 | I        | <b>R</b> — Reserved.                                                                                          |
| PIO0_14/TCK       | F6      | 49     | [2] PU          | I/O      | <b>PIO0_14</b> — General-purpose digital input/output pin.<br>In boundary scan mode: TCK (Test Clock).        |
|                   |         |        |                 | I/O      | <b>SPI0_SSEL0</b> — Slave Select 0 for SPI0.                                                                  |
|                   |         |        |                 | O        | <b>SCT0_OUT5</b> — SCT0 output 5. PWM output 5.                                                               |
|                   |         |        |                 | O        | <b>CT32B2_MAT1</b> — 32-bit CT32B2 match output 1.                                                            |
|                   |         |        |                 | I        | <b>R</b> — Reserved.                                                                                          |
| PIO0_15/TDO       | G6      | 50     | [2] PU          | I/O      | <b>PIO0_15</b> — General-purpose digital input/output pin.<br>In boundary scan mode: TDO (Test Data Out).     |
|                   |         |        |                 | I/O      | <b>SPI0_SSEL1</b> — Slave Select 1 for SPI0.                                                                  |
|                   |         |        |                 | I/O      | <b>SWO</b> — Serial wire trace output.                                                                        |
|                   |         |        |                 | O        | <b>CT32B2_MAT2</b> — 32-bit CT32B2 match output 2.                                                            |
|                   |         |        |                 | I        | <b>R</b> — Reserved.                                                                                          |
| SWCLK/<br>PIO0_16 | F5      | 52     | [2] PU          | I/O      | <b>PIO0_16</b> — General-purpose digital input/output pin. After booting, this pin is connected to the SWCLK. |
|                   |         |        |                 | I/O      | <b>SPI0_SSEL2</b> — Slave Select 2 for SPI0.                                                                  |
|                   |         |        |                 | I        | <b>U1_CTS</b> — Clear To Send input for USART1.                                                               |
|                   |         |        |                 | O        | <b>CT32B3_MAT1</b> — 32-bit CT32B3 match output 1.                                                            |
|                   |         |        |                 | I        | <b>R</b> — Reserved.                                                                                          |
|                   |         |        |                 | I/O      | <b>SWCLK</b> — Serial Wire Clock. This is the default function after booting.                                 |
| SWDIO/<br>PIO0_17 | G5      | 53     | [2] PU          | I/O      | <b>PIO0_17</b> — General-purpose digital input/output pin. After booting, this pin is connected to SWDIO.     |
|                   |         |        |                 | I/O      | <b>SPI0_SSEL3</b> — Slave Select 3 for SPI0.                                                                  |
|                   |         |        |                 | O        | <b>U1_RTS</b> — Request To Send output for USART1.                                                            |
|                   |         |        |                 | O        | <b>CT32B3_MAT2</b> — 32-bit CT32B3 match output 2.                                                            |
|                   |         |        |                 | I        | <b>R</b> — Reserved.                                                                                          |
|                   |         |        |                 | I/O      | <b>SWDIO</b> — Serial Wire Debug I/O. This is the default function after booting.                             |

Table 4. Pin description ...continued

| Symbol       | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                                                                   |
|--------------|---------|--------|-----------------|----------|---------------------------------------------------------------------------------------------------------------|
| PIO0_18/TRST | G4      | 58     | [2]             | PU       | I/O <b>PIO0_18</b> — General-purpose digital input/output pin. In boundary scan mode: TRST (Test Reset).      |
|              |         |        |                 |          | O <b>U3_TXD</b> — Transmitter output for USART3.                                                              |
|              |         |        |                 |          | O <b>SCT0_OUT0</b> — SCT0 output 0. PWM output 0.                                                             |
|              |         |        |                 |          | O <b>CT32B0_MAT0</b> — 32-bit CT32B0 match output 0.                                                          |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |
| PIO0_19/TDI  | G3      | 59     | [2]             | PU       | I/O <b>PIO0_19</b> — General-purpose digital input/output pin. In boundary scan mode: TDI (Test Data In).     |
|              |         |        |                 |          | I/O <b>U3_SCLK</b> — USART3 clock in synchronous USART mode.                                                  |
|              |         |        |                 |          | O <b>SCT0_OUT1</b> — SCT0 output 1. PWM output 1.                                                             |
|              |         |        |                 |          | O <b>CT32B0_MAT1</b> — 32-bit CT32B0 match output 1.                                                          |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |
| PIO0_20/TMS  | F3      | 60     | [2]             | PU       | I/O <b>PIO0_20</b> — General-purpose digital input/output pin. In boundary scan mode: TMS (Test Mode Select). |
|              |         |        |                 |          | I <b>U3_RXD</b> — Receiver input for USART3.                                                                  |
|              |         |        |                 |          | I/O <b>U0_SCLK</b> — USART0 clock in synchronous USART mode.                                                  |
|              |         |        |                 |          | I <b>CT32B3_CAP0</b> — 32-bit CT32B3 capture input 0.                                                         |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |
| PIO0_21      | E3      | 61     | [2]             | PU       | I/O <b>PIO0_21</b> — General-purpose digital input/output pin.                                                |
|              |         |        |                 |          | O <b>CLKOUT</b> — Clock output pin.                                                                           |
|              |         |        |                 |          | O <b>U0_TXD</b> — Transmitter output for USART0.                                                              |
|              |         |        |                 |          | O <b>CT32B3_MAT0</b> — 32-bit CT32B3 match output 0.                                                          |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |
| PIO0_22      | G2      | 63     | [2]             | PU       | I/O <b>PIO0_22</b> — General-purpose digital input/output pin.                                                |
|              |         |        |                 |          | I <b>CLKIN</b> — Clock input.                                                                                 |
|              |         |        |                 |          | I <b>U0_RXD</b> — Receiver input for USART0.                                                                  |
|              |         |        |                 |          | O <b>CT32B3_MAT3</b> — 32-bit CT32B3 match output 3.                                                          |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |
| PIO0_23      | F2      | 1      | [3]             | Z        | I/O <b>PIO0_23</b> — General-purpose digital input/output pin.                                                |
|              |         |        |                 |          | I/O <b>I2C0_SCL</b> — I <sup>2</sup> C0 clock input/output.                                                   |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |
|              |         |        |                 |          | I <b>CT32B0_CAP0</b> — 32-bit CT32B0 capture input 0.                                                         |
|              |         |        |                 |          | I <b>R</b> — Reserved.                                                                                        |

Table 4. Pin description ...continued

| Symbol             | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                                                                                                                                 |
|--------------------|---------|--------|-----------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PIO0_24            | F1      | 2      | [3]             | Z        | I/O <b>PIO0_24</b> — General-purpose digital input/output pin.                                                                                                              |
|                    |         |        |                 |          | I/O <b>I2C0_SDA</b> — I <sup>2</sup> C0 data input/output.                                                                                                                  |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | I <b>CT32B0_CAP1</b> — 32-bit CT32B0 capture input 1.                                                                                                                       |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | O <b>CT32B0_MAT0</b> — 32-bit CT32B0 match output 0.                                                                                                                        |
| PIO0_25            | E2      | 3      | [3]             | Z        | I/O <b>PIO0_25</b> — General-purpose digital input/output pin.                                                                                                              |
|                    |         |        |                 |          | I/O <b>I2C1_SCL</b> — I <sup>2</sup> C1 clock input/output.                                                                                                                 |
|                    |         |        |                 |          | I <b>U1_CTS</b> — Clear To Send input for USART1.                                                                                                                           |
|                    |         |        |                 |          | I <b>CT32B0_CAP2</b> — 32-bit CT32B0 capture input 2.                                                                                                                       |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | I <b>CT32B1_CAP1</b> — 32-bit CT32B1 capture input 1.                                                                                                                       |
| PIO0_26            | E1      | 4      | [3]             | Z        | I/O <b>PIO0_26</b> — General-purpose digital input/output pin.                                                                                                              |
|                    |         |        |                 |          | I/O <b>I2C1_SDA</b> — I <sup>2</sup> C1 data input/output.                                                                                                                  |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | I <b>CT32B0_CAP3</b> — 32-bit CT32B0 capture input 3.                                                                                                                       |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
| PIO0_27            | D2      | 5      | [3]             | Z        | I/O <b>PIO0_27</b> — General-purpose digital input/output pin.                                                                                                              |
|                    |         |        |                 |          | I/O <b>I2C2_SCL</b> — I <sup>2</sup> C2 clock input/output.                                                                                                                 |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | I <b>CT32B2_CAP0</b> — 32-bit CT32B2 capture input 0.                                                                                                                       |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
| PIO0_28            | D1      | 6      | [3]             | Z        | I/O <b>PIO0_28</b> — General-purpose digital input/output pin.                                                                                                              |
|                    |         |        |                 |          | I/O <b>I2C2_SDA</b> — I <sup>2</sup> C2 data input/output.                                                                                                                  |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | O <b>CT32B2_MAT0</b> — 32-bit CT32B2 match output 0.                                                                                                                        |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
| PIO0_29/<br>ADC0_0 | D3      | 11     | [4]             | PU       | I/O; AI <b>PIO0_29/ADC0_0</b> — General-purpose digital input/output pin (default). ADC input channel 0 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | O <b>SCT0_OUT2</b> — SCT0 output 2.                                                                                                                                         |
|                    |         |        |                 |          | O <b>CT32B0_MAT3</b> — 32-bit CT32B0 match output 3.                                                                                                                        |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                      |
|                    |         |        |                 |          | I <b>CT32B0_CAP1</b> — 32-bit CT32B0 capture input 1.                                                                                                                       |
|                    |         |        |                 |          | O <b>CT32B0_MAT1</b> — 32-bit CT32B0 match output 1.                                                                                                                        |

Table 4. Pin description ...continued

| Symbol             | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                                                                                                                                                                                                                                                                                                     |
|--------------------|---------|--------|-----------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PIO0_30/<br>ADC0_1 | C1      | 12     | [4]             | PU       | I/O; <b>PIO0_30/ADC0_1</b> — General-purpose digital input/output pin (default). ADC input channel 1 if the DIGIMODE bit is set to 0 in the IOCON register for this pin.                                                                                                                                                                        |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | O <b>SCT0_OUT3</b> — SCT0 output 3.                                                                                                                                                                                                                                                                                                             |
|                    |         |        |                 |          | O <b>CT32B0_MAT2</b> — 32-bit CT32B0 match output 2.                                                                                                                                                                                                                                                                                            |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | I <b>CT32B0_CAP2</b> — 32-bit CT32B0 capture input 2.                                                                                                                                                                                                                                                                                           |
| PIO0_31/<br>ADC0_2 | C2      | 13     | [4]             | PU       | I/O; <b>PIO0_31/ADC0_2</b> — General-purpose digital input/output pin (default). ADC input channel 2 if the DIGIMODE bit is set to 0 in the IOCON register for this pin.<br><b>Remark:</b> This pin is also used to force In-System Programming mode (ISP) after device reset. See the LPC5410x User Manual (Boot Process chapter) for details. |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | I <b>U2_CTS</b> — Clear To Send input for USART2.                                                                                                                                                                                                                                                                                               |
|                    |         |        |                 |          | I <b>CT32B2_CAP2</b> — 32-bit CT32B2 capture input 2.                                                                                                                                                                                                                                                                                           |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | I <b>CT32B0_CAP3</b> — 32-bit CT32B0 capture input 3.                                                                                                                                                                                                                                                                                           |
| PIO1_0/<br>ADC0_3  | C3      | 14     | [4]             | PU       | I/O; <b>PIO1_0/ADC0_3</b> — General-purpose digital input/output pin (default). ADC input channel 3 if the DIGIMODE bit is set to 0 in the IOCON register for this pin.                                                                                                                                                                         |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | O <b>U2_RTS</b> — Request To Send output for USART2.                                                                                                                                                                                                                                                                                            |
|                    |         |        |                 |          | O <b>CT32B3_MAT1</b> — 32-bit CT32B3 match output 1.                                                                                                                                                                                                                                                                                            |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | I <b>CT32B0_CAP0</b> — 32-bit CT32B0 capture input 0.                                                                                                                                                                                                                                                                                           |
| PIO1_1/<br>ADC0_4  | B1      | 15     | [4]             | PU       | I/O; <b>PIO1_1/ADC0_4</b> — General-purpose digital input/output pin (default). ADC input channel 4 if the DIGIMODE bit is set to 0 in the IOCON register for this pin.                                                                                                                                                                         |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | I/O <b>SWO</b> — Serial wire trace output.                                                                                                                                                                                                                                                                                                      |
|                    |         |        |                 |          | O <b>SCT0_OUT4</b> — SCT0 output 4.                                                                                                                                                                                                                                                                                                             |
| PIO1_2/<br>ADC0_5  | A1      | 16     | [4]             | PU       | I/O; <b>PIO1_2/ADC0_5</b> — General-purpose digital input/output pin (default). ADC input channel 5 if the DIGIMODE bit is set to 0 in the IOCON register for this pin.                                                                                                                                                                         |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                                                                                                                                                                                          |
|                    |         |        |                 |          | I/O <b>SPI1_SSEL3</b> — Slave Select 3 for SPI1.                                                                                                                                                                                                                                                                                                |
|                    |         |        |                 |          | O <b>SCT0_OUT5</b> — SCT0 output 5.                                                                                                                                                                                                                                                                                                             |

Table 4. Pin description ...continued

| Symbol            | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                                                                                                                             |
|-------------------|---------|--------|-----------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PIO1_3/<br>ADC0_6 | B2      | 17     | [4]             | PU       | I/O; <b>PIO1_3/ADC0_6</b> — General-purpose digital input/output pin (default). ADC input channel 6 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                   |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | I/O <b>SPI1_SSEL2</b> — Slave Select 2 for SPI1.                                                                                                                        |
|                   |         |        |                 |          | O <b>SCT0_OUT6</b> — SCT0 output 6.                                                                                                                                     |
|                   |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | I/O <b>SPI0_SCK</b> — Serial clock for SPI0.                                                                                                                            |
|                   |         |        |                 |          | I <b>CT32B0_CAP1</b> — 32-bit CT32B0 capture input 1.                                                                                                                   |
| PIO1_4/<br>ADC0_7 | A2      | 18     | [4]             | PU       | I/O; <b>PIO1_4/ADC0_7</b> — General-purpose digital input/output pin (default). ADC input channel 7 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                   |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | I/O <b>SPI1_SSEL1</b> — Slave Select 1 for SPI1.                                                                                                                        |
|                   |         |        |                 |          | O <b>SCT0_OUT7</b> — SCT0 output 7.                                                                                                                                     |
|                   |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | I/O <b>SPI0_MISO</b> — Master In Slave Out for SPI0.                                                                                                                    |
|                   |         |        |                 |          | O <b>CT32B0_MAT1</b> — 32-bit CT32B0 match output 1.                                                                                                                    |
| PIO1_5/<br>ADC0_8 | B3      | 19     | [4]             | PU       | I/O; <b>PIO1_5/ADC0_8</b> — General-purpose digital input/output pin (default). ADC input channel 8 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                   |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | I/O <b>SPI1_SSEL0</b> — Slave Select 0 for SPI1.                                                                                                                        |
|                   |         |        |                 |          | I <b>CT32B1_CAP0</b> — 32-bit CT32B1 capture input 0.                                                                                                                   |
|                   |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | O <b>CT32B1_MAT3</b> — 32-bit CT32B1 match output 3.                                                                                                                    |
|                   |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                  |
| PIO1_6/<br>ADC0_9 | A5      | 26     | [4]             | PU       | I/O; <b>PIO1_6/ADC0_9</b> — General-purpose digital input/output pin (default). ADC input channel 9 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                   |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | I/O <b>SPI1_SCK</b> — Serial clock for SPI1.                                                                                                                            |
|                   |         |        |                 |          | I <b>CT32B1_CAP2</b> — 32-bit CT32B1 capture input 2.                                                                                                                   |
|                   |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                  |
|                   |         |        |                 |          | O <b>CT32B1_MAT2</b> — 32-bit CT32B1 match output 2.                                                                                                                    |
|                   |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                  |

Table 4. Pin description ...continued

| Symbol             | WLCSP49 | LQFP64 | Reset state [1] | Type [6] | Description                                                                                                                                                                  |
|--------------------|---------|--------|-----------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PIO1_7/<br>ADC0_10 | B5      | 27     | [4]             | PU       | I/O; AI <b>PIO1_7/ADC0_10</b> — General-purpose digital input/output pin (default). ADC input channel 10 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | I/O <b>SPI1_MOSI</b> — Master Out Slave in for SPI1.                                                                                                                         |
|                    |         |        |                 |          | O <b>CT32B1_MAT2</b> — 32-bit CT32B1 match output 2.                                                                                                                         |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | I <b>CT32B1_CAP2</b> — 32-bit CT32B1 capture input 2.                                                                                                                        |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
| PIO1_8/<br>ADC0_11 | C5      | 28     | [4]             | PU       | I/O; AI <b>PIO1_8/ADC0_11</b> — General-purpose digital input/output pin (default). ADC input channel 11 if the DIGIMODE bit is set to 0 in the IOCON register for this pin. |
|                    |         |        |                 |          | - <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | I/O <b>SPI1_MISO</b> — Master In Slave Out for SPI1.                                                                                                                         |
|                    |         |        |                 |          | O <b>CT32B1_MAT3</b> — 32-bit CT32B1 match output 3.                                                                                                                         |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | I <b>CT32B1_CAP3</b> — 32-bit CT32B1 capture input 3.                                                                                                                        |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
| PIO1_9             | -       | 29     | [2]             | PU       | I/O <b>PIO1_9</b> — General-purpose digital input/output pin.                                                                                                                |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | I/O <b>SPI0_MOSI</b> — Master Out Slave In for SPI0.                                                                                                                         |
|                    |         |        |                 |          | I <b>CT32B0_CAP2</b> — 32-bit CT32B0 capture input 2.                                                                                                                        |
| PIO1_10            | -       | 30     | [2]             | PU       | I/O <b>PIO1_10</b> — General-purpose digital input/output pin.                                                                                                               |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | O <b>U1_TXD</b> — Transmitter output for USART1.                                                                                                                             |
|                    |         |        |                 |          | O <b>SCT0_OUT4</b> — SCT0 output 4.                                                                                                                                          |
| PIO1_11            | -       | 42     | [2]             | PU       | I/O <b>PIO1_11</b> — General-purpose digital input/output pin.                                                                                                               |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | O <b>U1_RTS</b> — Request To Send output for USART1.                                                                                                                         |
|                    |         |        |                 |          | I <b>CT32B1_CAP0</b> — 32-bit CT32B1 capture input 0.                                                                                                                        |
| PIO1_12            | -       | 51     | [2]             | PU       | I/O <b>PIO1_12</b> — General-purpose digital input/output pin.                                                                                                               |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | I <b>U3_RXD</b> — Receiver input for USART3.                                                                                                                                 |
|                    |         |        |                 |          | O <b>CT32B1_MAT0</b> — 32-bit CT32B1 match output 0.                                                                                                                         |
|                    |         |        |                 |          | I/O <b>SPI1_SCK</b> — Serial clock for SPI1.                                                                                                                                 |
| PIO1_13            | -       | 54     | [2]             | PU       | I/O <b>PIO1_13</b> — General-purpose digital input/output pin.                                                                                                               |
|                    |         |        |                 |          | I <b>R</b> — Reserved.                                                                                                                                                       |
|                    |         |        |                 |          | O <b>U3_TXD</b> — Transmitter output for USART3.                                                                                                                             |
|                    |         |        |                 |          | O <b>CT32B1_MAT1</b> — 32-bit CT32B1 match output 1.                                                                                                                         |
|                    |         |        |                 |          | I/O <b>SPI1_MOSI</b> — Master Out Slave In for SPI1.                                                                                                                         |



Table 4. Pin description ...continued

| Symbol  | WLCSP49 | LQFP64        | Reset state [1] | Type [6] | Description                                                                                                                                                                                                               |
|---------|---------|---------------|-----------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PIO1_14 | -       | 57            | [2] PU          | I/O      | <b>PIO1_14</b> — General-purpose digital input/output pin.                                                                                                                                                                |
|         |         |               |                 | I        | <b>R</b> — Reserved.                                                                                                                                                                                                      |
|         |         |               |                 | I        | <b>U2_RXD</b> — Receiver input for USART2.                                                                                                                                                                                |
|         |         |               |                 | O        | <b>SCT0_OUT7</b> — SCT0 output 7.                                                                                                                                                                                         |
|         |         |               |                 | I/O      | <b>SPI1_MISO</b> — Master In Slave Out for SPI1.                                                                                                                                                                          |
| PIO1_15 | -       | 62            | [2] PU          | I/O      | <b>PIO1_15</b> — General-purpose digital input/output pin.                                                                                                                                                                |
|         |         |               |                 | I        | <b>R</b> — Reserved.                                                                                                                                                                                                      |
|         |         |               |                 | O        | <b>SCT0_OUT5</b> — SCT0 output 5.                                                                                                                                                                                         |
|         |         |               |                 | I        | <b>CT32B1_CAP3</b> — 32-bit CT32B1 capture input 3.                                                                                                                                                                       |
|         |         |               |                 | I/O      | <b>SPI1_SSEL0</b> — Slave Select 0 for SPI1.                                                                                                                                                                              |
| PIO1_16 | -       | 7             | [2] PU          | I/O      | <b>PIO1_16</b> — General-purpose digital input/output pin.                                                                                                                                                                |
|         |         |               |                 | I        | <b>R</b> — Reserved.                                                                                                                                                                                                      |
|         |         |               |                 | O        | <b>CT32B0_MAT0</b> — 32-bit CT32B0 match output 0.                                                                                                                                                                        |
|         |         |               |                 | I        | <b>CT32B0_CAP0</b> — 32-bit CT32B0 capture input 0.                                                                                                                                                                       |
|         |         |               |                 | I/O      | <b>SPI1_SSEL1</b> — Slave Select 1 for SPI1.                                                                                                                                                                              |
| PIO1_17 | -       | 10            | [2] PU          | I/O      | <b>PIO1_17</b> — General-purpose digital input/output pin.                                                                                                                                                                |
| RESET   | G1      | 64            | [5] PU          | I        | External reset input: A LOW on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. Wakes up the part from deep power-down mode. |
| RTCXIN  | A7      | 33            | -               | -        | RTC oscillator input.                                                                                                                                                                                                     |
| RTCXOUT | B7      | 35            | -               | -        | RTC oscillator output.                                                                                                                                                                                                    |
| VREFP   | B4      | 22            | -               | -        | ADC positive reference voltage.                                                                                                                                                                                           |
| VREFN   | -       | 21            | -               | -        | ADC negative reference voltage.                                                                                                                                                                                           |
| VDDA    | A4      | 23            | -               | -        | Analog supply voltage.                                                                                                                                                                                                    |
| VDD     | C4, F4  | 8, 24, 56, 34 | -               | -        | Single 1.62 V to 3.6 V power supply powers internal digital functions and I/Os.                                                                                                                                           |
| VSS     | D4, E4  | 9, 25, 55     | -               | -        | Ground.                                                                                                                                                                                                                   |
| VSSA    | A3      | 20            | -               | -        | Analog ground.                                                                                                                                                                                                            |

- [1] PU = input mode, pull-up enabled (pull-up resistor pulls up pin to  $V_{DD}$ ). Z = high impedance; pull-up or pull-down disabled. Reset state reflects the pin state at reset without boot code operation. For pin states in the different power modes, see [Section 6.2.2 “Pin states in different power modes”](#). For termination on unused pins, see [Section 6.2.1 “Termination of unused pins”](#).
- [2] 5 V tolerant pad with programmable glitch filter (5 V tolerant if  $V_{DD}$  present; if  $V_{DD}$  not present, do not exceed 3.6 V); provides digital I/O functions with TTL levels and hysteresis; normal drive strength. See [Figure 27](#). Pulse width of spikes or glitches suppressed by input filter is from 3 ns to 16 ns (simulated value).
- [3] True open-drain pin. I2C-bus pins compliant with the I2C-bus specification for I2C standard mode, I2C Fast-mode, and I2C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.

- [4] 5 V tolerant pin providing standard digital I/O functions with configurable modes, configurable hysteresis, and analog input. When configured as an analog input, the digital section of the pin is disabled, and the pin is not 5 V tolerant.
- [5] Reset pad. 5 V tolerant pad with glitch filter with hysteresis. Pulse width of spikes or glitches suppressed by input filter is from 3 ns to 20 ns (simulated value)
- [6] I = Input; AI = Analog input; O = Output

### 6.2.1 Termination of unused pins

[Table 5](#) shows how to terminate pins that are **not** used in the application. In many cases, unused pins should be connected externally or configured correctly by software to minimize the overall power consumption of the part.

Unused pins with GPIO function should be configured as outputs set to LOW with their internal pull-up disabled. To configure a GPIO pin as output and drive it LOW, select the GPIO function in the IOCON register, select output in the GPIO DIR register, and write a 0 to the GPIO PORT register for that pin. Disable the pull-up in the pin's IOCON register.

In addition, it is recommended to configure all GPIO pins that are not bonded out on smaller packages as outputs driven LOW with their internal pull-up disabled.

**Table 5. Termination of unused pins**

| Pin                         | Default state <sup>[1]</sup> | Recommended termination of unused pins                                                                 |
|-----------------------------|------------------------------|--------------------------------------------------------------------------------------------------------|
| $\overline{\text{RESET}}$   | I; PU                        | The $\overline{\text{RESET}}$ pin can be left unconnected if the application does not use it.          |
| all PION_m (not open-drain) | I; PU                        | Can be left unconnected if driven LOW and configured as GPIO output with pull-up disabled by software. |
| PION_m (I2C open-drain)     | IA                           | Can be left unconnected if driven LOW and configured as GPIO output by software.                       |
| RTCXIN                      | -                            | Connect to ground. When grounded, the RTC oscillator is disabled.                                      |
| RTCXOUT                     | -                            | Can be left unconnected.                                                                               |
| VREFP                       | -                            | Tie to VDD.                                                                                            |
| VREFN                       | -                            | Tie to VSS.                                                                                            |
| VDDA                        | -                            | Tie to VDD.                                                                                            |
| VSSA                        | -                            | Tie to VSS.                                                                                            |

[1] I = Input, IA = Inactive (no pull-up/pull-down enabled), PU = Pull-Up.

### 6.2.2 Pin states in different power modes

**Table 6. Pin states in different power modes**

| Pin                                          | Active                                                                                        | Sleep | Deep sleep/Power down | Deep power-down |
|----------------------------------------------|-----------------------------------------------------------------------------------------------|-------|-----------------------|-----------------|
| PION_m pins (not I2C)                        | As configured in the IOCON <sup>[1]</sup> . Default: internal pull-up enabled.                |       |                       | Floating.       |
| PIO0_23 to PIO0_28 (open-drain I2C-bus pins) | As configured in the IOCON <sup>[1]</sup> .                                                   |       |                       | Floating.       |
| $\overline{\text{RESET}}$                    | Reset function enabled. Default: input, internal pull-up enabled.<br>Reset function disabled. |       |                       |                 |

[1] Default and programmed pin states are retained in sleep, deep sleep, and power down modes.

## 7. Functional description

### 7.1 Architectural overview

The ARM Cortex-M4 includes three AHB-Lite buses, one system bus and the I-code and D-code buses. One bus is dedicated for instruction fetch (I-code), and one bus is dedicated for data access (D-code). The use of two core buses allows for simultaneous operations if concurrent operations target different devices.

A multi-layer AHB matrix connects the CPU buses and other bus masters to peripherals in a flexible manner that optimizes performance by allowing peripherals on different slave ports of the matrix to be accessed simultaneously by different bus masters. Connections in the multilayer matrix are shown in [Figure 3](#).

APB peripherals are connected to the AHB matrix via two APB buses using separate slave ports from the multilayer AHB matrix. This allows for better performance by reducing collisions between the CPU and the DMA controller, and also for peripherals on the asynchronous bridge to have a fixed clock that does not track the system clock.

### 7.2 ARM Cortex-M4 processor

The ARM Cortex-M4 is a general purpose, 32-bit microprocessor, which offers high performance and very low power consumption. The ARM Cortex-M4 offers many new features, including a Thumb-2 instruction set, low interrupt latency, hardware multiply and divide, interruptable/continuable multiple load and store instructions, automatic state save and restore for interrupts, tightly integrated interrupt controller with wake-up interrupt controller, and multiple core buses capable of simultaneous accesses.

A 3-stage pipeline is employed so that all parts of the processing and memory systems can operate continuously. Typically, while one instruction is being executed, its successor is being decoded, and a third instruction is being fetched from memory.

### 7.3 ARM Cortex-M4 integrated Floating Point Unit (FPU)

The FPU fully supports single-precision add, subtract, multiply, divide, multiply and accumulate, and square root operations. It also provides conversions between fixed-point and floating-point data formats, and floating-point constant instructions.

The FPU provides floating-point computation functionality that is compliant with the ANSI/IEEE Std 754-2008, IEEE Standard for Binary Floating-Point Arithmetic, referred to as the IEEE 754 standard.

### 7.4 Memory Protection Unit (MPU)

The Cortex-M4 includes a Memory Protection Unit (MPU) which can be used to improve the reliability of an embedded system by protecting critical data within the user application.

The MPU allows separating processing tasks by disallowing access to each other's data, disabling access to memory regions, allowing memory regions to be defined as read-only and detecting unexpected memory accesses that could potentially break the system.

The MPU separates the memory into distinct regions and implements protection by preventing disallowed accesses. The MPU supports up to eight regions each of which can be divided into eight subregions. Accesses to memory locations that are not defined in the MPU regions, or not permitted by the region setting, will cause the Memory Management Fault exception to take place.

## 7.5 Nested Vectored Interrupt Controller (NVIC) for Cortex-M4

The NVIC is an integral part of the Cortex-M4. The tight coupling to the CPU allows for low interrupt latency and efficient processing of late arriving interrupts.

### 7.5.1 Features

- Controls system exceptions and peripheral interrupts.
- 37 vectored interrupts.
- Eight programmable interrupt priority levels, with hardware priority level masking.
- Relocatable vector table.
- Non-Maskable Interrupt (NMI).
- Software interrupt generation.

### 7.5.2 Interrupt sources

Each peripheral device has one interrupt line connected to the NVIC but may have several interrupt flags.

## 7.6 ARM Cortex-M0+ co-processor

The ARM Cortex-M0+ co-processor offers high performance and very low power consumption. This processor uses a 2-stage pipeline von Neumann architecture and a small but powerful instruction set providing high-end processing hardware. The processor includes an NVIC with 32 interrupts and a separate system tick timer. In LPC5410x, the Cortex-M0 coprocessor hardware multiply is implemented as a 32-cycle iterative multiplier.

## 7.7 Nested Vectored Interrupt Controller (NVIC) for Cortex-M0+

The NVIC is an integral part of the Cortex-M0+. The tight coupling to the CPU allows for low interrupt latency and efficient processing of late arriving interrupts.

### 7.7.1 Features

- Controls system exceptions and peripheral interrupts.
- 32 vectored interrupts.
- Four programmable interrupt priority levels, with hardware priority level masking.
- Relocatable vector table.
- Non-Maskable Interrupt (NMI).
- Software interrupt generation.

### 7.7.2 Interrupt sources

Each peripheral device has one interrupt line connected to the NVIC but may have several interrupt flags.

### 7.8 System Tick timer (SysTick)

The ARM Cortex-M4 and ARM Cortex-M0+ cores include a system tick timer (SysTick) that is intended to generate a dedicated SYSTICK exception. The clock source for the SysTick can be the system clock or the SYSTICK clock.

### 7.9 On-chip static RAM

The LPC5410x support 104 kB SRAM with separate bus master access for higher throughput and individual power control for low-power operation.

### 7.10 On-chip flash

The LPC5410x supports 512 kB of on-chip flash memory.

### 7.11 On-chip ROM

The 64 kB on-chip ROM contains the boot loader and the following Application Programming Interfaces (API):

- In-System Programming (ISP) and In-Application Programming (IAP) support for flash programming.
- Power control API for configuring power consumption and PLL settings.

7.12 Memory mapping

The LPC5410x incorporates several distinct memory regions. The APB peripheral area is 512 kB in size and is divided to allow for up to 32 peripherals. Each peripheral is allocated 16 kB of space simplifying the address decoding. The registers incorporated into the CPU, such as NVIC, SysTick, and sleep mode control, are located on the private peripheral bus.

Figure 6 shows the overall map of the entire address space from the user program viewpoint following reset.

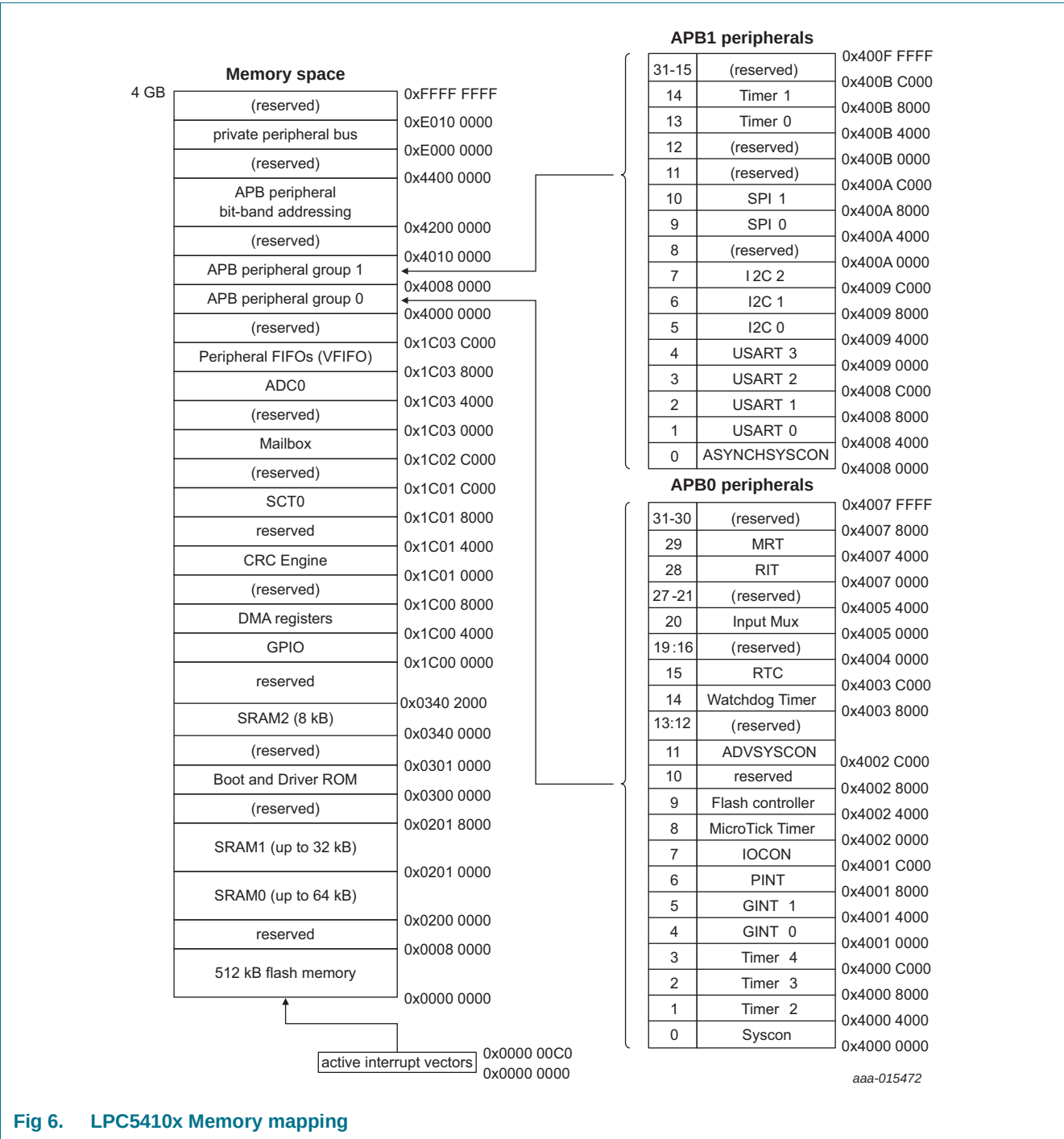


Fig 6. LPC5410x Memory mapping

## 7.13 General Purpose I/O (GPIO)

The LPC5410x provides two GPIO ports with a total of 50 GPIO pins.

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The current level of a port pin can be read back no matter what peripheral is selected for that pin.

See [Table 4](#) for the default state on reset.

### 7.13.1 Features

- Accelerated GPIO functions:
  - GPIO registers are located on the AHB so that the fastest possible I/O timing can be achieved.
  - Mask registers allow treating sets of port bits as a group, leaving other bits unchanged.
  - All GPIO registers are byte and half-word addressable.
  - Entire port value can be written in one instruction.
- Bit-level set, clear and toggle registers allow a single instruction set, clear or toggle of any number of bits in one port.
- Direction control of individual bits.
- All I/O default to inputs after reset.
- All GPIO pins can be selected to create an edge or level-sensitive GPIO interrupt request.
- One GPIO group interrupt can be triggered by a combination of any pin or pins.

## 7.14 Pin interrupt/pattern engine

The pin interrupt block configures up to eight pins from all digital pins for providing eight external interrupts connected to the NVIC. The pattern match engine can be used in conjunction with software to create complex state machines based on pin inputs. Any digital pin, independent of the function selected through the switch matrix can be configured through the SYSCON block as an input to the pin interrupt or pattern match engine. The registers that control the pin interrupt or pattern match engine are located on the I/O+ bus for fast single-cycle access.

### 7.14.1 Features

- Pin interrupts:
  - Up to eight pins can be selected from all GPIO pins on ports 0 and 1 as edge-sensitive or level-sensitive interrupt requests. Each request creates a separate interrupt in the NVIC.
  - Edge-sensitive interrupt pins can interrupt on rising or falling edges or both.
  - Level-sensitive interrupt pins can be HIGH-active or LOW-active.
  - Level-sensitive interrupt pins can be HIGH-active or LOW-active.
  - Pin interrupts can wake up the device from sleep mode, deep sleep mode, and power down mode.



- Pattern match engine:
  - Up to eight pins can be selected from all digital pins on ports 0 and 1 to contribute to a boolean expression. The boolean expression consists of specified levels and/or transitions on various combinations of these pins.
  - Each bit slice minterm (product term) comprising of the specified boolean expression can generate its own, dedicated interrupt request.
  - Any occurrence of a pattern match can also be programmed to generate an RXEV notification to the CPU. The RXEV signal can be connected to a pin.
  - Pattern match can be used in conjunction with software to create complex state machines based on pin inputs.
  - Pattern match engine facilitates wake-up only from active and sleep modes.

## 7.15 AHB peripherals

### 7.15.1 DMA controller

The DMA controller allows peripheral-to memory, memory-to-peripheral, and memory-to-memory transactions. Each DMA stream provides unidirectional DMA transfers for a single source and destination.

#### 7.15.1.1 Features

- 22 channels, 21 of which are connected to peripheral DMA requests. These come from the USART, SPI, and I<sup>2</sup>C peripherals. One spare channels has no DMA request connected, and can be used for functions such as memory-to-memory moves.
- DMA operations can be triggered by on- or off-chip events. Each DMA channel can select one trigger input from 20 sources. Trigger sources include ADC interrupts, Timer interrupts, pin interrupts, and the SCT DMA request lines.
- Priority is user selectable for each channel.
- Continuous priority arbitration.
- Address cache.
- Efficient use of data bus.
- Supports single transfers up to 1,024 words.
- Address increment options allow packing and/or unpacking data.

## 7.16 Digital serial peripherals

### 7.16.1 USART

#### 7.16.1.1 Features

- Synchronous mode with master or slave operation. Includes data phase selection and continuous clock option.
- Maximum bit rates of 6.25 Mbit/s in asynchronous mode.
- Maximum supported bit rate of 24 Mbit/s for USART master and slave synchronous modes.
- 7, 8, or 9 data bits and 1 or 2 stop bits.

- Multiprocessor/multidrop (9-bit) mode with software address compare.
- RS-485 transceiver output enable.
- Autobaud mode for automatic baud rate detection
- Parity generation and checking: odd, even, or none.
- Software selectable oversampling from 5 to 16 clocks in asynchronous mode.
- One transmit and one receive data buffer.
- RTS/CTS for hardware signaling for automatic flow control. Software flow control can be performed using Delta CTS detect, Transmit Disable control, and any GPIO as an RTS output.
- FIFO support from the System FIFO.
- Received data and status can optionally be read from a single register
- Break generation and detection.
- Receive data is 2 of 3 sample "voting". Status flag set when one sample differs.
- Built-in Baud Rate Generator with auto-baud function.
- A fractional rate divider is shared among all USARTs.
- Interrupts available for Receiver Ready, Transmitter Ready, Receiver Idle, change in receiver break detect, Framing error, Parity error, Overrun, Underrun, Delta CTS detect, and receiver sample noise detected.
- Loopback mode for testing of data and flow control.
- In synchronous slave mode, wakes up the part from deep sleep and power down modes.
- Special operating mode allows operation at up to 9600 baud using the 32 kHz RTC oscillator as the UART clock. This mode can be used while the device is in deep sleep or power down mode and can wake-up the device when a character is received.
- USART transmit and receive functions work with the system DMA controller.
- Activity on the USART synchronous slave mode allows wake-up from deep sleep and power down modes on any enabled interrupt.

## 7.16.2 SPI serial I/O controller

### 7.16.2.1 Features

- Master and slave operation.
- Maximum supported bit rate for SPI master mode is 71 Mbit/s, and the maximum supported bit rate for SPI slave mode is 21 Mbit/s.
- Data frames of 1 to 16 bits supported directly. Larger frames supported by software or DMA set-up.
- Data can be transmitted to a slave without the need to read incoming data. This can be useful while setting up an SPI memory.
- Control information can optionally be written along with data. This allows very versatile operation, including "any length" frames.
- Up to four Slave Select input/outputs with selectable polarity and flexible usage.
- Supports DMA transfers: SPIn transmit and receive functions can operated with the system DMA controller.

- FIFO support from the System FIFO.
- Activity on the SPI in slave mode allows wake-up from deep sleep and power down modes on any enabled interrupt.

## 7.17 I<sup>2</sup>C-bus interface

The I<sup>2</sup>C-bus is bidirectional for inter-IC control using only two wires: a serial clock line (SCL) and a serial data line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (for example, an LCD driver) or a transmitter with the capability to both receive and send information (such as memory). Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I<sup>2</sup>C is a multi-master bus and can be controlled by more than one bus master connected to it.

### 7.17.1 Features

- All I<sup>2</sup>Cs support standard (up to 100 Kbits/s), fast mode (up to 400 Kbits/s), and Fast-mode Plus (up to 1 Mbit/s).
- All I<sup>2</sup>Cs support high-speed slave mode with data rates of up to 3.4 Mbit/s.
- Independent Master, Slave, and Monitor functions.
- Supports both Multi-master and Multi-master with Slave functions.
- Multiple I<sup>2</sup>C slave addresses supported in hardware.
- One slave address can be selectively qualified with a bit mask or an address range in order to respond to multiple I<sup>2</sup>C-bus addresses.
- 10-bit addressing supported with software assist.
- Supports System Management Bus (SMBus).
- No chip clocks are required in order to receive and compare an address as a Slave, so this event can wake up the device from power down mode.
- Supports the I<sup>2</sup>C-bus specification up to Fast-mode Plus (FM+, up to 1 MHz) in both master and slave modes. High-speed (HS, up to 3.4 MHz) I<sup>2</sup>C is support in slave mode only.
- Activity on the I<sup>2</sup>C in slave mode allows wake-up from deep sleep and power down modes on any enabled interrupt.

## 7.18 Counter/timers

### 7.18.1 General-purpose 32-bit timers/external event counter

The LPC5410x includes five general-purpose 32-bit timer/counters.

The timer/counter is designed to count cycles of the system derived clock or an externally-supplied clock. It can optionally generate interrupts, generate timed DMA requests, or perform other actions at specified timer values, based on four match registers. Each timer/counter also includes two capture inputs to trap the timer value when an input signal transitions, optionally generating an interrupt.

#### 7.18.1.1 Features

- Each is a 32-bit counter/timer with a programmable 32-bit prescaler. Four of the timers include external capture and match pin connections.

- Counter or timer operation.
- For each timer with pin connections, up to 4 32-bit capture channels that can take a snapshot of the timer value when an input signal transitions. A capture event may also optionally generate an interrupt.
- The timer and prescaler may be configured to be cleared on a designated capture event. This feature permits easy pulse-width measurement by clearing the timer on the leading edge of an input pulse and capturing the timer value on the trailing edge.
- Four 32-bit match registers that allow:
  - Continuous operation with optional interrupt generation on match.
  - Stop timer on match with optional interrupt generation.
  - Reset timer on match with optional interrupt generation.
- For each timer with pin connections, up to 4 external outputs corresponding to match registers with the following capabilities:
  - Set LOW on match.
  - Set HIGH on match.
  - Toggle on match.
  - Do nothing on match.
- PWM: for each timer with pin connections, up to 3 match outputs can be used as single edge controlled PWM outputs.

### 7.18.2 State Configurable Timer/PWM (SCTimer/PWM)

The SCTimer/PWM (SCT0) allows a wide variety of timing, counting, output modulation, and input capture operations. The inputs and outputs of the SCTimer/PWM are shared with the capture and match inputs/outputs of the 32-bit general-purpose counter/timers.

The SCTimer/PWM can be configured as two 16-bit counters or a unified 32-bit counter. In the two-counter case, in addition to the counter value the following operational elements are independent for each half:

- State variable
- Limit, halt, stop, and start conditions
- Values of Match/Capture registers, plus reload or capture control values

In the two-counter case, the following operational elements are global to the SCT, but the last three can use match conditions from either counter:

- Clock selection
- Inputs
- Events
- Outputs
- Interrupts

### 7.18.2.1 Features

- Two 16-bit counters or one 32-bit counter.
- Counter(s) clocked by bus clock or selected input.
- Up counter(s) or up-down counter(s).
- State variable allows sequencing across multiple counter cycles.
- Event combines input or output condition and/or counter match in a specified state.
- Events control outputs, interrupts, and the SCT states.
  - Match register 0 can be used as an automatic limit.
  - In bi-directional mode, events can be enabled based on the count direction.
  - Match events can be held until another qualifying event occurs.
- Selected event(s) can limit, halt, start, or stop a counter.
- Supports:
  - 8 inputs (6 GPIO pins, ADC0\_THCMP\_IRQ, DEBUG\_HALTED)
  - up to 8 outputs
  - 13 match/capture registers
  - 13 events
  - 13 states
- PWM capabilities including dead time and emergency abort functions

### 7.18.3 Windowed WatchDog Timer (WWDT)

The purpose of the watchdog is to reset the controller if software fails to periodically service it within a programmable time window.

#### 7.18.3.1 Features

- Internally resets chip if not reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time-out period, both programmable.
- Optional warning interrupt can be generated at a programmable time prior to watchdog time-out.
- Programmable 24-bit timer with internal fixed pre-scaler.
- Selectable time period from 1,024 watchdog clocks ( $T_{WDCLK} \times 256 \times 4$ ) to over 67 million watchdog clocks ( $T_{WDCLK} \times 2^{24} \times 4$ ) in increments of 4 watchdog clocks.
- “Safe” watchdog operation. Once enabled, requires a hardware reset or a Watchdog reset to be disabled.
- Incorrect feed sequence causes immediate watchdog event if enabled.
- The watchdog reload value can optionally be protected such that it can only be changed after the “warning interrupt” time is reached.
- Flag to indicate Watchdog reset.
- The Watchdog clock (WDCLK) source is the fixed 500 kHz clock (+/- 40%) provided by the low-power watchdog oscillator.
- The Watchdog timer can be configured to run in deep sleep or power down mode.

- Debug mode.

#### 7.18.4 RTC timer

The RTC block has two timers: main RTC timer, and high-resolution/wake-up timer. The main RTC timer is a 32-bit timer that uses a 1 Hz clock and is intended to run continuously as a real-time clock. When the timer value reaches a match value, an interrupt is raised. The alarm interrupt can also wake up the part from any low power mode, if enabled.

The high-resolution or wake-up timer is a 16-bit timer that uses a 1 kHz clock and operates as a one-shot down timer. When the timer is loaded, it starts counting down to 0 at which point an interrupt is raised. The interrupt can wake up the part from any low power mode, if enabled. This timer is intended to be used for timed wake-up from deep sleep, power down, or deep power-down modes. The high-resolution wake-up timer can be disabled to conserve power if not used.

The RTC timer uses the 32 kHz clock input to create a 1 Hz or 1 kHz clock

##### 7.18.4.1 Features

- The RTC oscillator has the following clock outputs:
  - 32 kHz clock, selectable for system clock and CLKOUT pin.
  - 1 Hz clock for RTC timing.
  - 1 kHz clock for high-resolution RTC timing.
- 32-bit, 1 Hz RTC counter and associated match register for alarm generation.
- Separate 16-bit high-resolution/wake-up timer clocked at 1 kHz for 1 ms resolution with a more than one minute maximum time-out period.
- RTC alarm and high-resolution/wake-up timer time-out each generate independent interrupt requests. Either time-out can wake up the part from any of the low power modes, including deep power-down.

#### 7.18.5 Multi-Rate Timer (MRT)

The Multi-Rate Timer (MRT) provides a repetitive interrupt timer with four channels. Each channel can be programmed with an independent time interval, and each channel operates independently from the other channels.

##### 7.18.5.1 Features

- 24-bit interrupt timer.
- Four channels independently counting down from individually set values.
- Repeat interrupt, one-shot interrupt, and one-shot bus stall modes.

#### 7.18.6 Repetitive Interrupt Timer (RIT)

The Repetitive Interrupt Timer provides a versatile means of generating interrupts at specified time intervals, without using a standard timer. It is intended for repeating interrupts that are not related to Operating System interrupts. However, it could be used as an alternative to the System Tick Timer if there are different system requirements.

#### 7.18.6.1 Features

- 48-bit counter running from the main clock. Counter can be free-running or be reset by a generated interrupt.
- 48-bit compare value.
- 48-bit compare mask. An interrupt is generated when the counter value equals the compare value, after masking. This allows for combinations not possible with a simple compare.

#### 7.18.7 Micro-tick timer (UTICK)

The ultra-low power Micro-tick Timer, running from the Watchdog oscillator, can be used to wake up the device from low power modes.

##### 7.18.7.1 Features

- Ultra simple timer.
- Write once to start.
- Interrupt or software polling.

#### 7.19 12-bit Analog-to-Digital Converter (ADC)

The ADC supports a resolution of 12-bit and fast conversion rates of up to 5.0 Msamples/s. Sequences of analog-to-digital conversions can be triggered by multiple sources. Possible trigger sources are the SCT, external pins, and the ARM TXEV interrupt.

The ADC supports a variable clocking scheme with clocking synchronous to the system clock or independent, asynchronous clocking for high-speed conversions

The ADC includes a hardware threshold compare function with zero-crossing detection. The threshold crossing interrupt is connected internally to the SCT inputs for tight timing control between the ADC and the SCT.

##### 7.19.1 Features

- 12-bit successive approximation analog to digital converter.
- Input multiplexing among up to 12 pins.
- Two configurable conversion sequences with independent triggers.
- Optional automatic high/low threshold comparison and “zero crossing” detection.
- Measurement range VREFN to VREFP (typically 3 V; not to exceed VDDA voltage level).
- 12-bit conversion rate of 5.0 MHz. Options for reduced resolution at higher conversion rates.

- Burst conversion mode for single or multiple inputs.
- Synchronous or asynchronous operation. Asynchronous operation maximizes flexibility in choosing the ADC clock frequency, Synchronous mode minimizes trigger latency and can eliminate uncertainty and jitter in response to a trigger.

## 7.20 System control

### 7.20.1 Clock sources

The LPC5410x supports two external and three internal clock sources:

- The Internal RC (IRC).
- Watchdog oscillator (WDOSC).
- External clock source from the digital I/O pin CLKIN.
- External RTC 32 KHz clock.
- Output of the system PLL.

#### 7.20.1.1 Internal RC oscillator (IRC)

The IRC can be used as the clock that drives the system PLL and subsequently the CPU. The nominal IRC frequency is 12 MHz.

Upon power-up or any chip reset, the LPC5410x uses the IRC as the clock source. Software may later switch to one of the other available clock sources.

#### 7.20.1.2 Watchdog oscillator (WDOSC)

The watchdog oscillator is a low-power internal oscillator. The WDOSC can be used to provide a clock to the WWDT and to the entire chip. The nominal output frequency is 500 kHz.

#### 7.20.1.3 Clock input pin (CLKIN)

An external square-wave clock source (up to 25 MHz) can be supplied on the digital I/O pin CLKIN.

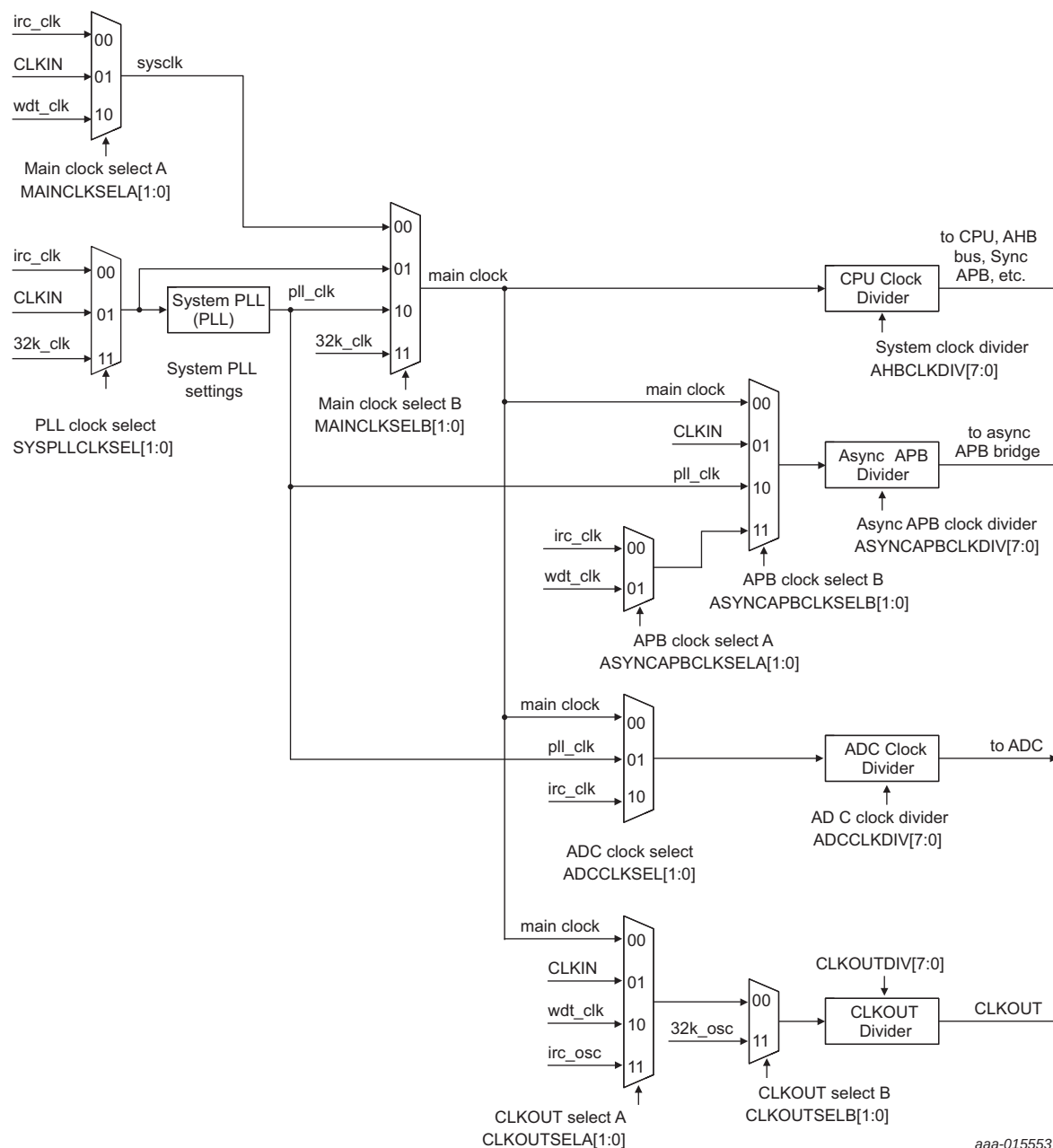
### 7.20.2 System PLL

The system PLL accepts an input clock frequency in the range of 32 kHz to 12 MHz. The input frequency is multiplied up to a high frequency with a Current Controlled Oscillator (CCO).

The PLL can be enabled or disabled by software.



### 7.20.3 Clock Generation



aaa-015553

Fig 7. LPC5410x clock generation

### 7.20.4 Power control

The LPC5410x support a variety of power control features. In Active mode, when the chip is running, power and clocks to selected peripherals can be optimized for power consumption. In addition, there are four special modes of processor power reduction with different peripherals running: Sleep mode, deep sleep mode, power down mode, and deep power-down mode, activated by the power mode configure API.

#### 7.20.4.1 Sleep mode

When sleep mode is entered, the clock to the core is stopped along with any unused peripherals. Waking up from the sleep mode does not need any special sequence other than re-enabling the clock to the ARM core.

In sleep mode, execution of instructions is suspended until either a reset or interrupt occurs. Peripheral functions continue operation during sleep mode and may generate interrupts to cause the processor to resume execution. Sleep mode eliminates dynamic power used by the processor itself, memory systems and related controllers, internal buses, and unused peripherals. The processor state and registers, peripheral registers, and internal SRAM values are maintained, and the logic levels of the pins remain static.

#### 7.20.4.2 Deep sleep mode

In deep sleep mode, all peripheral clocks and all clock sources are off with the option of keeping the 32 kHz clock and the WDOSC running. In addition, all analog blocks are shut down and the flash is put in stand-by mode. In deep sleep mode, the application can keep some of the internal clocks and the BOD circuit running for self-timed wake-up and BOD protection.

The LPC5410x can wake up from deep sleep mode via a reset, digital pins selected as inputs to the pin interrupt block, RTC alarm, Micro-tick, a watchdog timer reset interrupt, BOD interrupt/reset, or an interrupt from the USART (in 32 kHz mode or synchronous slave mode), the SPI, or any of the I2C peripherals. For wake-up from deep sleep mode, the SPI, USART, and I2C peripherals must be configured in slave mode.

Any interrupt used for waking up from deep sleep mode must be enabled in one of the SYSCON wake-up enable registers and the NVIC.

In deep sleep mode, the processor state and registers, peripheral registers, and internal SRAM values are maintained, and the logic levels of the pins remain static. deep sleep mode allows for very low quiescent power and fast wake-up options.

#### 7.20.4.3 Power down mode

In power down mode, all peripheral clocks and all clock sources are off with the option of keeping the 32 kHz clock, and the WDOSC running. In addition, all analog blocks and the flash are shut down. In power down mode, the application can keep the BOD circuit running for BOD protection.

The LPC5410x can wake up from power down mode via a reset, digital pins selected as inputs to the pin interrupt block, RTC alarm, Micro-tick, a watchdog timer reset interrupt, BOD interrupt/reset, or an interrupt from the USART (in 32 kHz mode or synchronous slave mode), the SPI, or any of the I2C peripherals. For wake-up from power down mode, the SPI, USART, and I2C peripherals must be configured in slave mode.

In power down mode, the processor state and registers, peripheral registers, and internal SRAM values are maintained, and the logic levels of the pins remain static. Power down mode reduces power consumption compared to deep sleep mode at the expense of longer wake-up times.

7.20.4.4 Deep power-down mode

In deep power-down mode, power is shut off to the entire chip except for the RTC power domain and the RESET pin. The LPC5410x can wake up from deep power down mode via the RESET pin and the RTC alarm.

7.20.5 Brownout detection

The LPC5410x includes a monitor for the voltage level on the V<sub>DD</sub> pin. If this voltage falls below a fixed level, the BOD sets a flag that can be polled or cause an interrupt. In addition, a separate threshold levels can be selected to cause chip reset and interrupt.

7.20.6 Safety

The LPC5410x includes a Windowed WatchDog Timer (WWDT), which can be enabled by software after reset. Once enabled, the WWDT remains locked and cannot be modified in any way until a reset occurs.

7.21 Code security (Code Read Protection - CRP)

This feature of the LPC5410x allows user to enable different levels of security in the system so that access to the on-chip flash and use of the Serial Wire Debugger (SWD) and In-System Programming (ISP) can be restricted. When needed, CRP is invoked by programming a specific pattern into a dedicated flash location. IAP commands are not affected by the CRP.

In addition, ISP entry can be invoked by pulling a pin on the LPC5410x LOW on reset. This pin is called the ISP entry pin.

There are three levels of Code Read Protection:

- 1. CRP1 disables access to the chip via the SWD and allows partial flash update (excluding flash sector 0) using a limited set of the ISP commands. This mode is useful when CRP is required and flash field updates are needed but all sectors cannot be erased.
- 2. CRP2 disables access to the chip via the SWD and only allows full flash erase and update using a reduced set of the ISP commands.
- 3. CRP3 fully disables any access to the chip via SWD and ISP. It is up to the user's application to provide (if needed) flash update mechanism using IAP calls or a call to reinvoke ISP command to enable a flash update via USART.
- 4. In addition to the three CRP levels, sampling of the ISP entry pin for valid user code can be disabled (No\_ISP mode). For details, see the LPC5410x user manual.

CAUTION



If level three Code Read Protection (CRP3) is selected, no future factory testing can be performed on the device.

## 7.22 Emulation and debugging

Debug and trace functions are integrated into the ARM Cortex-M4 and ARM Cortex-M0+. Serial wire debug and trace functions are supported. The ARM Cortex-M4 is configured to support up to eight breakpoints and four watch points. The ARM Cortex-M0+ is configured to support up to four breakpoints and two watch points. In addition, JTAG boundary scan mode is provided.

The ARM SYSREQ reset is supported and causes the processor to reset the peripherals, execute the boot code, restart from address 0x0000 0000, and break at the user entry point.

The SWD pins are multiplexed with other digital I/O pins. On reset, the pins assume the SWD functions by default.

## 8. Limiting values

**Table 7. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).<sup>[1]</sup>

| Symbol                 | Parameter                               | Conditions                                                                                  |        | Min  | Max             | Unit |
|------------------------|-----------------------------------------|---------------------------------------------------------------------------------------------|--------|------|-----------------|------|
| V <sub>DD</sub>        | supply voltage (core and external rail) | on pin VDD                                                                                  | [2]    | −0.5 | +4.6            | V    |
| V <sub>DDA</sub>       | analog supply voltage                   | on pin VDDA                                                                                 |        | −0.5 | +4.6            | V    |
| V <sub>ref</sub>       | reference voltage                       | on pin VREFP                                                                                | -      | −0.5 | +4.6            | V    |
| V <sub>I</sub>         | input voltage                           | only valid when the V <sub>DD</sub> > 1.8 V;<br>5 V tolerant I/O pins                       | [6][7] | −0.5 | 5.0             | V    |
| V <sub>I</sub>         | input voltage                           | on I2C open-drain pins                                                                      | [5]    | −0.5 | +5.0            | V    |
| V <sub>IA</sub>        | analog input voltage                    | on digital pins configured for an analog function                                           | [8][9] | −0.5 | V <sub>DD</sub> | V    |
| I <sub>DD</sub>        | total supply current                    |                                                                                             | [3]    | -    | 60              | mA   |
| I <sub>SS</sub>        | total ground current                    |                                                                                             | [3]    | -    | 60              | mA   |
| I <sub>latch</sub>     | I/O latch-up current                    | −(0.5V <sub>DD</sub> ) < V <sub>I</sub> < (1.5V <sub>DD</sub> );<br>T <sub>j</sub> < 125 °C |        | -    | 100             | mA   |
| V <sub>i(rtcx)</sub>   | 32 kHz oscillator input voltage         |                                                                                             | [2]    | −0.5 | 4.6             | V    |
| T <sub>stg</sub>       | storage temperature                     |                                                                                             | [10]   | −65  | +150            | °C   |
| T <sub>j(max)</sub>    | maximum junction temperature            |                                                                                             |        | -    | +150            | °C   |
| P <sub>tot(pack)</sub> | total power dissipation (per package)   | based on package heat transfer, not device power consumption                                |        | -    | 1.5             | W    |
| V <sub>ESD</sub>       | electrostatic discharge voltage         | human body model; all pins                                                                  | [4]    |      | 4000            | V    |

[1] The following applies to the limiting values:

- This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.
  - Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V<sub>SS</sub> unless otherwise noted.
  - The limiting values are stress ratings only and operating the part at these values is not recommended and proper operation is not guaranteed. The conditions for functional operation are specified in [Table 16](#).
- [2] Maximum/minimum voltage above the maximum operating voltage (see [Table 16](#)) and below ground that can be applied for a short time (< 10 ms) to a device without leading to irrecoverable failure. Failure includes the loss of reliability and shorter lifetime of the device.
- [3] The peak current is limited to 25 times the corresponding maximum current.
- [4] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 kΩ series resistor.
- [5] V<sub>DD</sub> present or not present. Compliant with the I<sup>2</sup>C-bus standard. 5.5 V can be applied to this pin when V<sub>DD</sub> is powered down.
- [6] Applies to all 5 V tolerant I/O pins except true open-drain pins.
- [7] Including the voltage on outputs in 3-state mode.

- [8] An ADC input voltage above 3.6 V can be applied for a short time without leading to immediate, unrecoverable failure. Accumulated exposure to elevated voltages at 4.6 V must be less than  $10^6$  s total over the lifetime of the device. Applying an elevated voltage to the ADC inputs for a long time affects the reliability of the device and reduces its lifetime.
- [9] It is recommended to connect an overvoltage protection diode between the analog input pin and the voltage supply pin.
- [10] Dependent on package type.

## 9. Thermal characteristics

The average chip junction temperature,  $T_j$  (°C), can be calculated using the following equation:

$$T_j = T_{amb} + (P_D \times R_{th(j-a)}) \quad (1)$$

- $T_{amb}$  = ambient temperature (°C),
- $R_{th(j-a)}$  = the package junction-to-ambient thermal resistance (°C/W)
- $P_D$  = sum of internal and I/O power dissipation

The internal power dissipation is the product of  $I_{DD}$  and  $V_{DD}$ . The I/O power dissipation of the I/O pins is often small and many times can be negligible. However it can be significant in some applications.

**Table 8. Thermal resistance**

| Symbol                 | Parameter                                   | Conditions                              | Max/Min    | Unit |
|------------------------|---------------------------------------------|-----------------------------------------|------------|------|
| <b>LQFP64 Package</b>  |                                             |                                         |            |      |
| $R_{th(j-a)}$          | thermal resistance from junction to ambient | JEDEC (4.5 in × 4 in); still air        | 58 ± 15 %  | °C/W |
|                        |                                             | Single-layer (4.5 in × 3 in); still air | 81 ± 15 %  | °C/W |
| $R_{th(j-c)}$          | thermal resistance from junction to case    |                                         | 18 ± 15 %  | °C/W |
| <b>WLCSP49 Package</b> |                                             |                                         |            |      |
| $R_{th(j-a)}$          | thermal resistance from junction to ambient | JEDEC (4.5 in × 4 in); still air        | 41 ± 15 %  | °C/W |
| $R_{th(j-c)}$          | thermal resistance from junction to case    |                                         | 0.3 ± 15 % | °C/W |

## 10. Static characteristics

### 10.1 General operating conditions

**Table 9. General operating conditions**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.

| Symbol               | Parameter                               | Conditions                |     | Min              | Typ | Max              | Unit |
|----------------------|-----------------------------------------|---------------------------|-----|------------------|-----|------------------|------|
| f <sub>clk</sub>     | clock frequency                         | internal CPU/system clock |     | -                | -   | 100              | MHz  |
| V <sub>DD</sub>      | supply voltage (core and external rail) |                           |     | 1.62             | -   | 3.6              | V    |
| V <sub>DDA</sub>     | analog supply voltage                   |                           | [1] | 1.62             | -   | 3.6              | V    |
| V <sub>refp</sub>    | ADC positive reference voltage          | V <sub>DDA</sub> ≥ 2 V    | [2] | 2.0              | -   | V <sub>DDA</sub> | V    |
|                      |                                         | V <sub>DDA</sub> < 2 V    |     | V <sub>DDA</sub> | -   | V <sub>DDA</sub> | V    |
| RTC oscillator pins  |                                         |                           |     |                  |     |                  |      |
| V <sub>i(rtcx)</sub> | 32 kHz oscillator input voltage         | on pin RTCXIN             |     | −0.5             | -   | +3.6             | V    |
| V <sub>o(rtcx)</sub> | 32 kHz oscillator output voltage        | on pin RTCXOUT            |     | −0.5             | -   | +3.6             | V    |

[1] The  $V_{DD}$  voltage must be equal or lower than the voltage level on  $V_{DDA}$ .

[2] The  $V_{refp}$  voltage must not exceed the voltage level on  $V_{DDA}$ .

### 10.2 CoreMark data

**Table 10. CoreMark score**

$T_{amb} = 25\text{ }^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V}$

| Parameter                                                         | Conditions                                                                             |              | Typ | Unit                 |
|-------------------------------------------------------------------|----------------------------------------------------------------------------------------|--------------|-----|----------------------|
| <b>ARM Cortex-M4 in active mode; ARM Cortex-M0+ in sleep mode</b> |                                                                                        |              |     |                      |
| CoreMark score                                                    | CoreMark code executed from SRAM;<br>CCLK = 12 MHz                                     | [1][3][4][5] | 2.6 | (Iterations/s) / MHz |
|                                                                   | CCLK = 48 MHz                                                                          | [2][3][4][5] | 2.6 | (Iterations/s) / MHz |
|                                                                   | CCLK = 84 MHz                                                                          | [2][3][4][5] | 2.6 | (Iterations/s) / MHz |
|                                                                   | CCLK = 100 MHz                                                                         | [2][3][4][5] | 2.6 | (Iterations/s) / MHz |
| CoreMark score                                                    | CoreMark code executed from flash;<br>CCLK = 12 MHz; 1 system clock flash access time. | [1][3][4][6] | 2.6 | (Iterations/s) / MHz |
|                                                                   | CCLK = 48 MHz; 3 system clock flash access time.                                       | [2][3][4][6] | 2.4 | (Iterations/s) / MHz |
|                                                                   | CCLK = 84 MHz; 4 system clock flash access time.                                       | [2][3][4][6] | 2.3 | (Iterations/s) / MHz |
|                                                                   | CCLK = 100 MHz; 5 system clock flash access time.                                      | [2][3][4][6] | 2.2 | (Iterations/s) / MHz |

[1] Clock source 12 MHz IRC. PLL disabled.

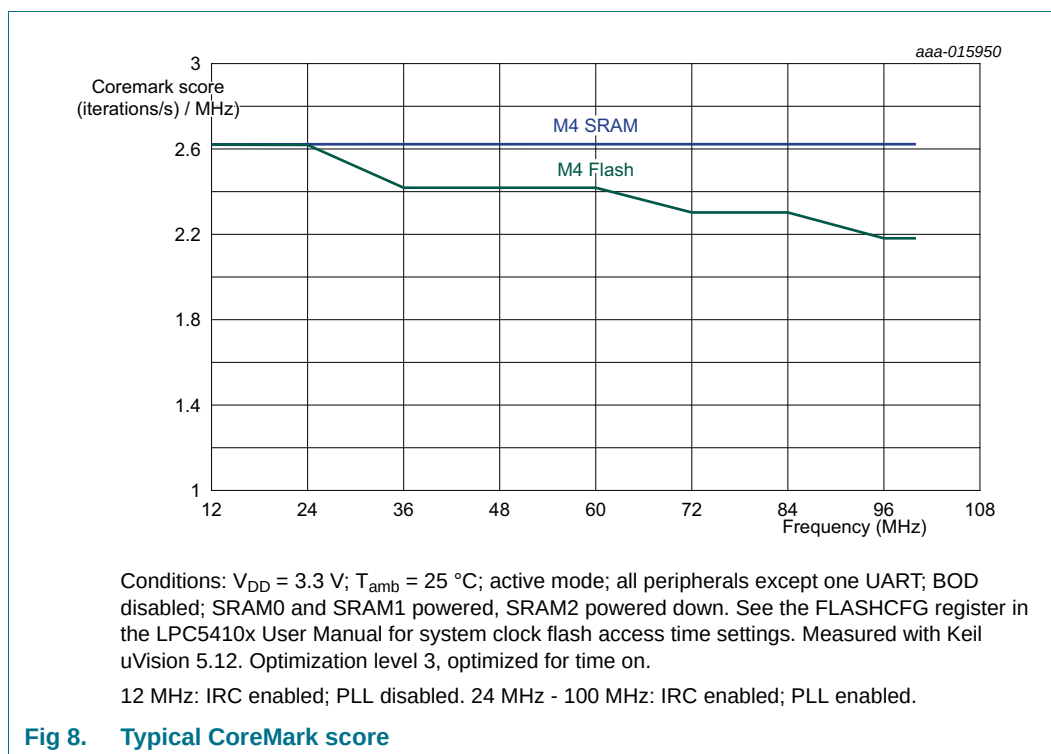
[2] Clock source 12 MHz IRC. PLL enabled.

[3] Characterized through bench measurements using typical samples.

[4] Compiler settings: Keil  $\mu$ Vision v.5.12, optimization level 3, optimized for time on.



- [5] SRAM0 and SRAM1 powered, SRAM2 powered down.  
[6] See the FLASHCFG register in the LPC5410x User Manual for system clock flash access time settings.



### 10.3 Power consumption

Power measurements in Active, sleep, deep sleep, and power down modes were performed under the following conditions:

- Configure all pins as GPIO with pull-up resistor disabled in the IOCON block.
- Configure GPIO pins as outputs using the GPIO DIR register.
- Write 1 to the GPIO CLR register to drive the outputs LOW.
- All peripherals disabled.

**Table 11. Static characteristics: Power consumption in active and sleep modes**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ .

| Symbol                                                            | Parameter      | Conditions                                                                          |           | Min | Typ <sup>[1]</sup> | Max | Unit |
|-------------------------------------------------------------------|----------------|-------------------------------------------------------------------------------------|-----------|-----|--------------------|-----|------|
| <b>ARM Cortex-M0+ in active mode; ARM Cortex-M4 in sleep mode</b> |                |                                                                                     |           |     |                    |     |      |
| $I_{DD}$                                                          | supply current | CoreMark code executed from SRAM; flash powered down                                |           |     |                    |     |      |
|                                                                   |                | CCLK = 12 MHz                                                                       | [2][4][6] | -   | 1.2                | -   | mA   |
|                                                                   |                | CCLK = 48 MHz                                                                       | [3][4][6] | -   | 3.0                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz                                                                       | [3][4][6] | -   | 4.5                | -   | mA   |
|                                                                   |                | CCLK = 100 MHz                                                                      | [3][4][6] | -   | 5.5                | -   | mA   |
| $I_{DD}$                                                          | supply current | CoreMark code executed from flash; CCLK = 12 MHz; 1 system clock flash access time. | [2][4][6] | -   | 1.5                | -   | mA   |
|                                                                   |                | CCLK = 48 MHz; 3 system clock flash access time.                                    | [3][4][6] | -   | 3.6                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz; 6 system clock flash access time.                                    | [3][4][6] | -   | 5.4                | -   | mA   |
|                                                                   |                | CCLK = 100 MHz; 7 system clock flash access time.                                   | [3][4][6] | -   | 6.6                | -   | mA   |
| $I_{DD}$                                                          | supply current | Calculating Fibonacci numbers executed from flash; CCLK = 12 MHz                    | [2][4][5] | -   | 1.5                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz                                                                       | [3][4][5] | -   | 6.2                | -   | mA   |
|                                                                   |                | CCLK = 96 MHz                                                                       | [3][4][5] | -   | 7.2                | -   | mA   |

**Table 11. Static characteristics: Power consumption in active and sleep modes** $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ .

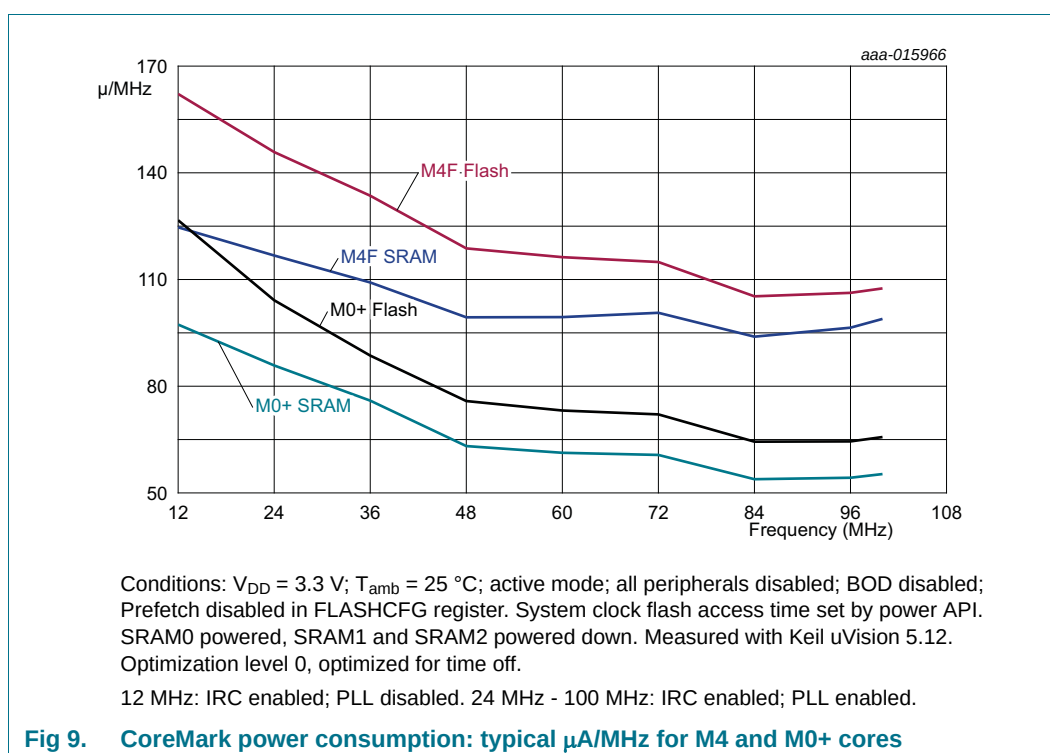
| Symbol                                                            | Parameter      | Conditions                                                                          |           | Min | Typ <sup>[1]</sup> | Max | Unit |
|-------------------------------------------------------------------|----------------|-------------------------------------------------------------------------------------|-----------|-----|--------------------|-----|------|
| <b>ARM Cortex-M4 in active mode; ARM Cortex-M0+ in sleep mode</b> |                |                                                                                     |           |     |                    |     |      |
| $I_{DD}$                                                          | supply current | CoreMark code executed from SRAM; flash powered down                                |           |     |                    |     |      |
|                                                                   |                | CCLK = 12 MHz                                                                       | [2][4][6] | -   | 1.5                | -   | mA   |
|                                                                   |                | CCLK = 48 MHz                                                                       | [3][4][6] | -   | 4.8                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz                                                                       | [3][4][6] | -   | 7.9                | -   | mA   |
|                                                                   |                | CCLK = 100 MHz                                                                      | [3][4][6] | -   | 9.9                | -   | mA   |
| $I_{DD}$                                                          | supply current | CoreMark code executed from flash; CCLK = 12 MHz; 1 system clock flash access time. | [2][4][6] | -   | 1.9                | -   | mA   |
|                                                                   |                | CCLK = 48 MHz; 3 system clock flash access time.                                    | [3][4][6] | -   | 5.7                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz; 6 system clock flash access time.                                    | [3][4][6] | -   | 8.8                | -   | mA   |
|                                                                   |                | CCLK = 100 MHz; 7 system clock flash access time.                                   | [3][4][6] | -   | 10.7               | -   | mA   |
| $I_{DD}$                                                          | supply current | Calculating Fibonacci numbers executed from SRAM; CCLK = 12 MHz                     | [2][4][5] | -   | 1.7                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz                                                                       | [3][4][5] | -   | 8.0                | -   | mA   |
|                                                                   |                | CCLK = 96 MHz                                                                       | [3][4][5] | -   | 9.4                | -   | mA   |
| $I_{DD}$                                                          | supply current | Calculating Fibonacci numbers executed from flash; CCLK = 12 MHz                    | [2][4][5] | -   | 1.7                | -   | mA   |
|                                                                   |                | CCLK = 84 MHz                                                                       | [3][4][5] | -   | 8.0                | -   | mA   |
|                                                                   |                | CCLK = 96 MHz                                                                       | [3][4][5] | -   | 9.4                | -   | mA   |

**Table 11. Static characteristics: Power consumption in active and sleep modes**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ .

| Symbol                                                           | Parameter      | Conditions     |           | Min | Typ <sup>[1]</sup> | Max | Unit |
|------------------------------------------------------------------|----------------|----------------|-----------|-----|--------------------|-----|------|
| <b>ARM Cortex-M4 in sleep mode; ARM Cortex-M0+ in sleep mode</b> |                |                |           |     |                    |     |      |
| I <sub>DD</sub>                                                  | supply current | CCLK = 12 MHz  | [2][4][7] | -   | 990                | -   | μA   |
|                                                                  |                | CCLK = 100 MHz | [3][4][7] | -   | 4.0                | -   | mA   |

- [1] Typical ratings are not guaranteed. Typical values listed are at room temperature (25 °C), 3.3V.
- [2] Clock source 12 MHz IRC. PLL disabled.
- [3] Clock source 12 MHz IRC. PLL enabled.
- [4] Characterized through bench measurements using typical samples.
- [5] Compiler settings: Keil μVision v.5.10, optimization level 0, optimized for time off.
- [6] Prefetch disabled in FLASHCFG register. System clock flash access time set by power API. SRAM0 powered, SRAM1 and SRAM2 powered down. Compiler settings: Keil μVision v.5.12, optimization level 0, optimized for time off.
- [7] First 8 kB in SRAM0 powered; Flash, SRAM1, and SRAM2 are powered down; all peripheral clocks disabled. Compiler settings: Keil μVision v.5.12, optimization level 0, optimized for time off.



**Table 12. Static characteristics: Power consumption in deep sleep, power down, and deep power-down modes**  
 $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ ,  $1.62\text{ V} \leq V_{DD} \leq 2.0\text{ V}$ ; unless otherwise specified.

| Symbol          | Parameter      | Conditions                                                                                                   |     | Min | Typ <sup>[1][2]</sup> | Max <sup>[3]</sup> | Unit |
|-----------------|----------------|--------------------------------------------------------------------------------------------------------------|-----|-----|-----------------------|--------------------|------|
| I <sub>DD</sub> | supply current | Deep sleep mode; all SRAM on:<br>T <sub>amb</sub> = 25 °C                                                    | [2] | -   | 235                   | 380                | μA   |
|                 |                | T <sub>amb</sub> = 105 °C                                                                                    |     | -   | -                     | 1.9                | mA   |
|                 |                | Power down mode;<br>first 8 kB in SRAM0 powered:<br>T <sub>amb</sub> = 25 °C                                 | [2] | -   | 4                     | 8                  | μA   |
|                 |                | T <sub>amb</sub> = 105 °C                                                                                    |     | -   | -                     | 110                | μA   |
|                 |                | SRAM0 (64 kB) powered                                                                                        |     | -   | 6.7                   | -                  | μA   |
|                 |                | SRAM0 (64 kB), SRAM1 (32 kB) powered                                                                         |     | -   | 7.8                   | -                  | μA   |
|                 |                | SRAM0 (64 kB), SRAM1 (32 kB), SRAM2 (8 kB) powered                                                           |     | -   | 8.2                   | -                  | μA   |
|                 |                | Deep power-down mode;<br>RTC oscillator input grounded (RTC oscillator disabled)<br>T <sub>amb</sub> = 25 °C | [2] | -   | 160                   | 340                | nA   |
|                 |                | T <sub>amb</sub> = 105 °C                                                                                    |     | -   | -                     | 14                 | μA   |
|                 |                | RTC oscillator running with external crystal                                                                 |     | -   | 114                   | -                  | nA   |

[1] Typical ratings are not guaranteed. Typical values listed are at room temperature (25 °C).

[2] Characterized through bench measurements using typical samples. V<sub>DD</sub> = 1.62 V

[3] Guaranteed by characterization, not tested in production. V<sub>DD</sub> = 2.0 V

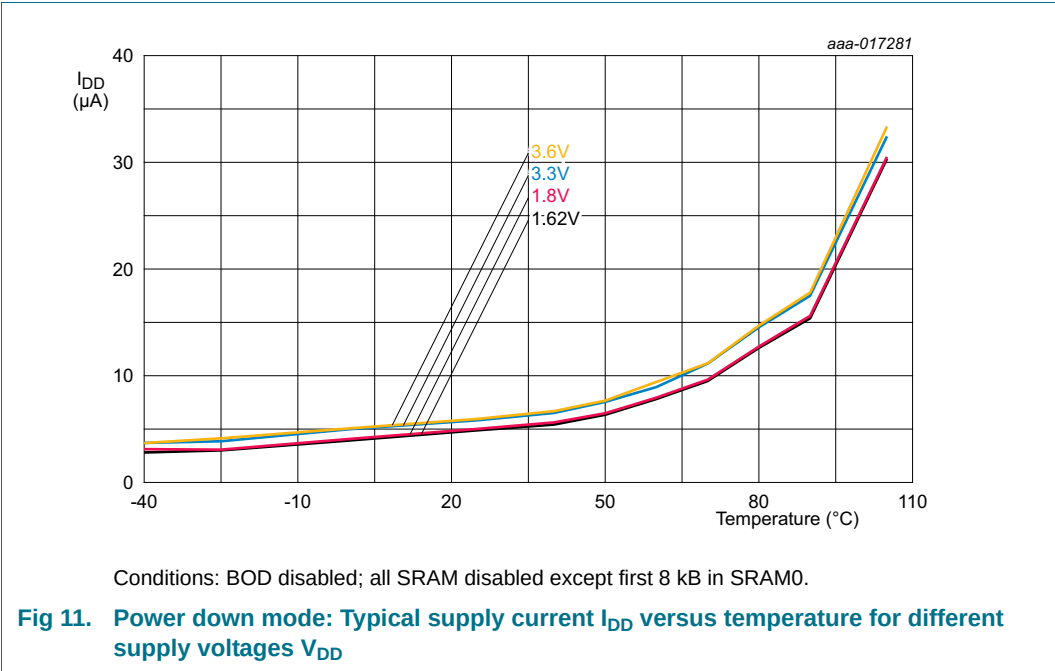
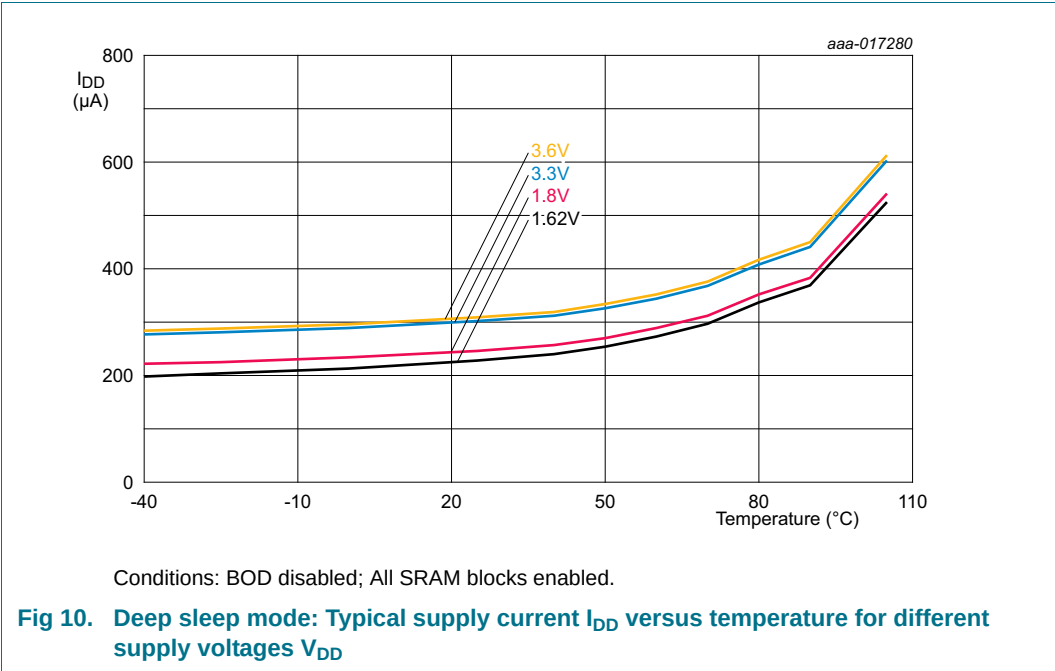
**Table 13. Static characteristics: Power consumption in deep sleep, power down, and deep power-down modes**  
 $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ ,  $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ ; unless otherwise specified.

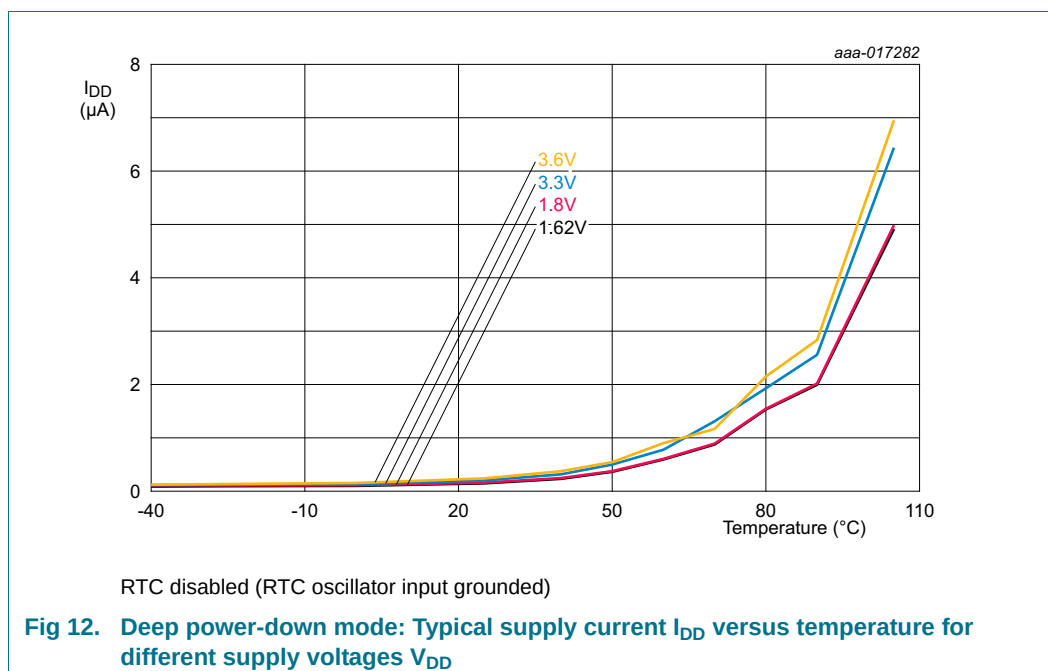
| Symbol          | Parameter      | Conditions                                                                                                                 |     | Min | Typ <sup>[1][2]</sup> | Max <sup>[3]</sup> | Unit          |
|-----------------|----------------|----------------------------------------------------------------------------------------------------------------------------|-----|-----|-----------------------|--------------------|---------------|
| I <sub>DD</sub> | supply current | Deep sleep mode; all SRAM on:<br>$T_{amb} = 25\text{ }^{\circ}\text{C}$                                                    | [2] | -   | 306                   | 480                | $\mu\text{A}$ |
|                 |                | $T_{amb} = 105\text{ }^{\circ}\text{C}$                                                                                    |     | -   | -                     | 2.3                | mA            |
|                 |                | Power down mode;<br>first 8 kB in SRAM0 powered:<br>$T_{amb} = 25\text{ }^{\circ}\text{C}$                                 | [2] | -   | 5                     | 10                 | $\mu\text{A}$ |
|                 |                | $T_{amb} = 105\text{ }^{\circ}\text{C}$                                                                                    |     | -   | -                     | 115                | $\mu\text{A}$ |
|                 |                | SRAM0 (64 kB) powered                                                                                                      |     | -   | 7.3                   | -                  | $\mu\text{A}$ |
|                 |                | SRAM0 (64 kB), SRAM1 (32 kB) powered                                                                                       |     | -   | 8.6                   | -                  | $\mu\text{A}$ |
|                 |                | SRAM0 (64 kB), SRAM1 (32 kB), SRAM2 (8 kB) powered                                                                         |     | -   | 9                     | -                  | $\mu\text{A}$ |
|                 |                | Deep power-down mode;<br>RTC oscillator input grounded (RTC oscillator disabled)<br>$T_{amb} = 25\text{ }^{\circ}\text{C}$ | [2] | -   | 200                   | 570                | nA            |
|                 |                | $T_{amb} = 105\text{ }^{\circ}\text{C}$                                                                                    |     |     | -                     | 20                 | $\mu\text{A}$ |
|                 |                | RTC oscillator running with external crystal                                                                               |     | -   | 280                   | -                  | nA            |
|                 |                |                                                                                                                            |     |     |                       |                    |               |

[1] Typical ratings are not guaranteed. Typical values listed are at room temperature (25 °C).

[2] Characterized through bench measurements using typical samples.  $V_{DD} = 3.3\text{ V}$

[3] Tested in production,  $V_{DD} = 3.6\text{ V}$



**Table 14. Typical peripheral power consumption**<sup>[1][2][3]</sup> $V_{DD} = 3.3\text{ V}$ ;  $T_{amb} = 25\text{ °C}$ 

| Peripheral | $I_{DD}$ in $\mu\text{A}$ |
|------------|---------------------------|
| IRC        | 262                       |
| WDT OSC    | 2.0                       |
| Flash      | 200.0                     |
| BOD        | 2.0                       |
| CLKOUT     | 37                        |

- [1] The supply current per peripheral is measured as the difference in supply current between the peripheral block enabled and the peripheral block disabled using PDRUNCFG register. All other blocks are disabled and no code accessing the peripheral is executed.
- [2] The supply currents are shown for system clock frequencies of 12 MHz.
- [3] Typical ratings are not guaranteed. Characterized through bench measurements using typical samples.

**Table 15. Typical AHB/APB peripheral power consumption**<sup>[3][4][5]</sup> $V_{DD} = 3.3\text{ V}$ ;  $T = 25\text{ °C}$ 

| Peripheral            | $I_{DD}$ in $\mu\text{A}$ | $I_{DD}$ in $\mu\text{A/MHz}$            | $I_{DD}$ in $\mu\text{A/MHz}$           |
|-----------------------|---------------------------|------------------------------------------|-----------------------------------------|
| <b>AHB peripheral</b> |                           | <b>CPU: 12 MHz, sync APB bus: 12 MHz</b> | <b>CPU: 96MHz, sync APB bus: 96 MHz</b> |
| GPIO0                 | [1]                       | 0.50                                     | 0.7                                     |
| GPIO1                 | [1]                       | 0.42                                     | 0.52                                    |
| DMA                   | -                         | 5.0                                      | 6.86                                    |
| CRC                   | -                         | 0.42                                     | 0.50                                    |
| MAILBOX               | -                         | 0.17                                     | 0.20                                    |
| ADC0                  | -                         | 2.25                                     | 2.92                                    |
| SCTimer/PWM           | -                         | 5.08                                     | 7.07                                    |



**Table 15. Typical AHB/APB peripheral power consumption**<sup>[3][4][5]</sup> $V_{DD} = 3.3\text{ V}$ ;  $T = 25\text{ }^{\circ}\text{C}$ 

| Peripheral                  |                | $I_{DD}$ in $\mu\text{A}$ | $I_{DD}$ in $\mu\text{A/MHz}$             | $I_{DD}$ in $\mu\text{A/MHz}$                          |
|-----------------------------|----------------|---------------------------|-------------------------------------------|--------------------------------------------------------|
| FIFO                        |                | -                         | 3.17                                      | 4.49                                                   |
| <b>Sync APB peripheral</b>  |                |                           | <b>CPU: 12 MHz, sync APB bus: 12 MHz</b>  | <b>CPU: 96MHz, sync APB bus: 96 MHz</b>                |
| INPUTMUX                    | <sup>[1]</sup> | -                         | 0.83                                      | 0.96                                                   |
| IOCON                       | <sup>[1]</sup> | -                         | 1.25                                      | 1.55                                                   |
| PINT                        |                | -                         | 0.83                                      | 1.05                                                   |
| GINT                        |                | -                         | 0.50                                      | 0.61                                                   |
| WWDT                        |                | -                         | 0.17                                      | 0.28                                                   |
| MRT                         |                | -                         | 0.50                                      | 0.65                                                   |
| RTC                         |                | -                         | 0.08                                      | 0.09                                                   |
| RIT                         |                | -                         | 0.50                                      | 0.71                                                   |
| UTICK                       |                | -                         | 0.17                                      | 0.11                                                   |
| Timer2                      |                | -                         | 0.58                                      | 0.67                                                   |
| Timer3                      |                | -                         | 0.42                                      | 0.42                                                   |
| Timer4                      |                | -                         | 0.50                                      | 0.57                                                   |
| <b>Async APB peripheral</b> |                |                           | <b>CPU: 12 MHz, Async APB bus: 12 MHz</b> | <b>CPU: 96MHz, Async APB bus: 12 MHz<sup>[2]</sup></b> |
| USART0                      |                | -                         | 0.67                                      | 0.11                                                   |
| USART1                      |                | -                         | 0.75                                      | 0.07                                                   |
| USART2                      |                | -                         | 0.67                                      | 0.11                                                   |
| USART3                      |                | -                         | 0.75                                      | 0.07                                                   |
| I2C0                        |                | -                         | 0.92                                      | 0.10                                                   |
| I2C1                        |                | -                         | 0.83                                      | 0.26                                                   |
| I2C2                        |                | -                         | 0.83                                      | 0.25                                                   |
| SPIO0                       |                | -                         | 0.92                                      | 0.21                                                   |
| SPIO1                       |                | -                         | 0.83                                      | 0.25                                                   |
| CTimer0                     |                | -                         | 0.58                                      | 0.18                                                   |
| CTimer1                     |                | -                         | 0.42                                      | 0.14                                                   |
| Fractional Rate Generator   |                | -                         | 4.17                                      | 0.73                                                   |

- [1] Turn off the peripheral when the configuration is done.
- [2] For optimal system power consumption, use fixed low frequency Async APB bus when the CPU is at a higher frequency.
- [3] The supply current per peripheral is measured as the difference in supply current between the peripheral block enabled and the peripheral block disabled using ASYNCAPBCLKCTRL, AHBCLKCTRL0/1, and PDRUNCFG register. All other blocks are disabled and no code accessing the peripheral is executed.
- [4] The supply currents are shown for system clock frequencies of 12 MHz and 96 MHz.
- [5] Typical ratings are not guaranteed. Characterized through bench measurements using typical samples.

## 10.4 Pin characteristics

**Table 16. Static characteristics: pin characteristics**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  unless otherwise specified. Values tested in production unless otherwise specified.

| Symbol                        | Parameter                               | Conditions                                                                         |        | Min                  | Typ <sup>[1]</sup> | Max                 | Unit |
|-------------------------------|-----------------------------------------|------------------------------------------------------------------------------------|--------|----------------------|--------------------|---------------------|------|
| <b>RESET pin</b>              |                                         |                                                                                    |        |                      |                    |                     |      |
| $V_{IH}$                      | HIGH-level input voltage                |                                                                                    |        | $0.8 \times V_{DD}$  | -                  | 5.0                 | V    |
| $V_{IL}$                      | LOW-level input voltage                 |                                                                                    |        | -0.5                 | -                  | $0.3 \times V_{DD}$ | V    |
| $V_{hys}$                     | hysteresis voltage                      |                                                                                    | [9]    | $0.05 \times V_{DD}$ | -                  | -                   | V    |
| <b>Standard I/O pins</b>      |                                         |                                                                                    |        |                      |                    |                     |      |
| <b>Input characteristics</b>  |                                         |                                                                                    |        |                      |                    |                     |      |
| $I_{IL}$                      | LOW-level input current                 | $V_I = 0\text{ V}$ ; on-chip pull-up resistor disabled                             |        | -                    | 3.0                | 180                 | nA   |
| $I_{IH}$                      | HIGH-level input current                | $V_I = V_{DD}$ ; $V_{DD} = 3.6\text{ V}$ ; for RESETN pin                          |        |                      | 3.0                | 180                 | nA   |
| $I_{IH}$                      | HIGH-level input current                | $V_I = V_{DD}$ ; on-chip pull-down resistor disabled                               |        | -                    | 3.0                | 180                 | nA   |
| $V_I$                         | input voltage                           | pin configured to provide a digital function;<br>$V_{DD} > 1.8\text{ V}$           | [3]    | 0                    | -                  | 5.0                 | V    |
|                               |                                         | $V_{DD} = 0\text{ V}$                                                              |        | 0                    | -                  | 3.6                 | V    |
| $V_{IH}$                      | HIGH-level input voltage                | $1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$                                         |        | 1.5                  | -                  | 5.0                 | V    |
|                               |                                         | $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$                                       |        | 2.0                  | -                  | 5.0                 | V    |
| $V_{IL}$                      | LOW-level input voltage                 | $1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$                                         |        | -0.5                 | -                  | +0.4                | V    |
|                               |                                         | $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$                                       |        | -0.5                 | -                  | +0.8                | V    |
| $V_{hys}$                     | hysteresis voltage                      |                                                                                    | [9]    | $0.1 \times V_{DD}$  | -                  | -                   | V    |
| <b>Output characteristics</b> |                                         |                                                                                    |        |                      |                    |                     |      |
| $V_O$                         | output voltage                          | output active                                                                      |        | 0                    | -                  | $V_{DD}$            | V    |
| $I_{OZ}$                      | OFF-state output current                | $V_O = 0\text{ V}$ ; $V_O = V_{DD}$ ; on-chip pull-up/pull-down resistors disabled |        | -                    | 3                  | 180                 | nA   |
| $V_{OH}$                      | HIGH-level output voltage               | $I_{OH} = -4\text{ mA}$ ; $1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$               |        | $V_{DD} - 0.4$       | -                  | -                   | V    |
|                               |                                         | $I_{OH} = -6\text{ mA}$ ; $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$             |        | $V_{DD} - 0.4$       | -                  | -                   | V    |
| $V_{OL}$                      | LOW-level output voltage                | $I_{OL} = 4\text{ mA}$ ; $1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$                |        | -                    | -                  | 0.4                 | V    |
|                               |                                         | $I_{OL} = 6\text{ mA}$ ; $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$              |        | -                    | -                  | 0.4                 | V    |
| $I_{OH}$                      | HIGH-level output current               | $V_{OH} = V_{DD} - 0.4\text{ V}$ ;<br>$1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$   |        | 4.0                  | -                  | -                   | mA   |
|                               |                                         | $V_{OH} = V_{DD} - 0.4\text{ V}$ ;<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ |        | 6.0                  | -                  | -                   | mA   |
| $I_{OL}$                      | LOW-level output current                | $V_{OL} = 0.4\text{ V}$ ; $1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$               |        | 4.0                  | -                  | -                   | mA   |
|                               |                                         | $V_{OL} = 0.4\text{ V}$ ; $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$             |        | 6.0                  | -                  | -                   | mA   |
| $I_{OHS}$                     | HIGH-level short-circuit output current | $1.62\text{ V} \leq V_{DD} < 2.7\text{ V}$                                         | [2][4] | -                    | -                  | 35                  | mA   |
|                               | drive HIGH; connected to ground;        | $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$                                       |        | -                    | -                  | 87                  | mA   |

**Table 16. Static characteristics: pin characteristics ...continued**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  unless otherwise specified. Values tested in production unless otherwise specified.

| Symbol                                       | Parameter                               | Conditions                             |                        | Min | Typ <sup>[1]</sup> | Max | Unit |
|----------------------------------------------|-----------------------------------------|----------------------------------------|------------------------|-----|--------------------|-----|------|
| I <sub>OLS</sub>                             | LOW-level short-circuit output current  | 1.62 V ≤ V <sub>DD</sub> < 2.7 V       | <a href="#">[2][4]</a> | -   | -                  | 30  | mA   |
|                                              | drive LOW; connected to V <sub>DD</sub> | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V        |                        | -   | -                  | 77  | mA   |
| Weak input pull-up/pull-down characteristics |                                         |                                        |                        |     |                    |     |      |
| I <sub>pd</sub>                              | pull-down current                       | V <sub>I</sub> = V <sub>DD</sub>       |                        | 25  |                    | 80  | μA   |
|                                              |                                         | V <sub>I</sub> = 5 V                   | <a href="#">[2]</a>    | 80  |                    | 100 | μA   |
| I <sub>pu</sub>                              | pull-up current                         | V <sub>I</sub> = 0 V                   |                        | −25 |                    | −80 | μA   |
|                                              |                                         | V <sub>DD</sub> < V <sub>I</sub> < 5 V | <a href="#">[2][7]</a> | 6   |                    | 30  | μA   |

**Table 16. Static characteristics: pin characteristics ...continued**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  unless otherwise specified. Values tested in production unless otherwise specified.

| Symbol                           | Parameter                | Conditions                                                             |                | Min                   | Typ <sup>[1]</sup> | Max                   | Unit |
|----------------------------------|--------------------------|------------------------------------------------------------------------|----------------|-----------------------|--------------------|-----------------------|------|
| Open-drain I <sup>2</sup> C pins |                          |                                                                        |                |                       |                    |                       |      |
| V <sub>IH</sub>                  | HIGH-level input voltage | 1.62 V ≤ V <sub>DD</sub> < 2.7 V                                       |                | 0.7 × V <sub>DD</sub> | -                  | -                     | V    |
|                                  |                          | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V                                        |                | 0.7 × V <sub>DD</sub> | -                  | -                     | V    |
| V <sub>IL</sub>                  | LOW-level input voltage  | 1.62 V ≤ V <sub>DD</sub> < 2.7 V                                       |                | 0                     | -                  | 0.3 × V <sub>DD</sub> | V    |
|                                  |                          | 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V                                        |                | 0                     | -                  | 0.3 × V <sub>DD</sub> | V    |
| V <sub>hys</sub>                 | hysteresis voltage       |                                                                        |                | 0.1 × V <sub>DD</sub> | -                  | -                     | V    |
| I <sub>LI</sub>                  | input leakage current    | V <sub>I</sub> = V <sub>DD</sub>                                       | <sup>[5]</sup> | -                     | 2.5                | 3.5                   | μA   |
|                                  |                          | V <sub>I</sub> = 5 V                                                   |                | -                     | 5.5                | 10                    | μA   |
| I <sub>OL</sub>                  | LOW-level output current | V <sub>OL</sub> = 0.4 V; pin configured for standard mode or fast mode |                | 4.0                   | -                  | -                     | mA   |
|                                  |                          | V <sub>OL</sub> = 0.4V; pin configured for Fast-mode Plus              |                | 20                    | -                  | -                     | mA   |
| Pin capacitance                  |                          |                                                                        |                |                       |                    |                       |      |
| C <sub>io</sub>                  | input/output capacitance | I <sup>2</sup> C-bus pins                                              | <sup>[8]</sup> | -                     | -                  | 6.0                   | pF   |
|                                  |                          | pins with digital functions only                                       | <sup>[6]</sup> | -                     | -                  | 2.0                   | pF   |
|                                  |                          | Pins with digital and analog functions                                 | <sup>[6]</sup> | -                     | -                  | 7.0                   | pF   |

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltage.

[2] Based on characterization. Not tested in production.

[3] With respect to ground.

[4] Allowed as long as the current limit does not exceed the maximum current allowed by the device.

[5] To  $V_{SS}$ .

[6] The values specified are simulated and absolute values, including package/bondwire capacitance.

[7] The weak pull-up resistor is connected to the  $V_{DD}$  rail and pulls up the I/O pin to the  $V_{DD}$  level.

[8] The value specified is a simulated value, excluding package/bondwire capacitance.

[9] Guaranteed by design, not tested in production.

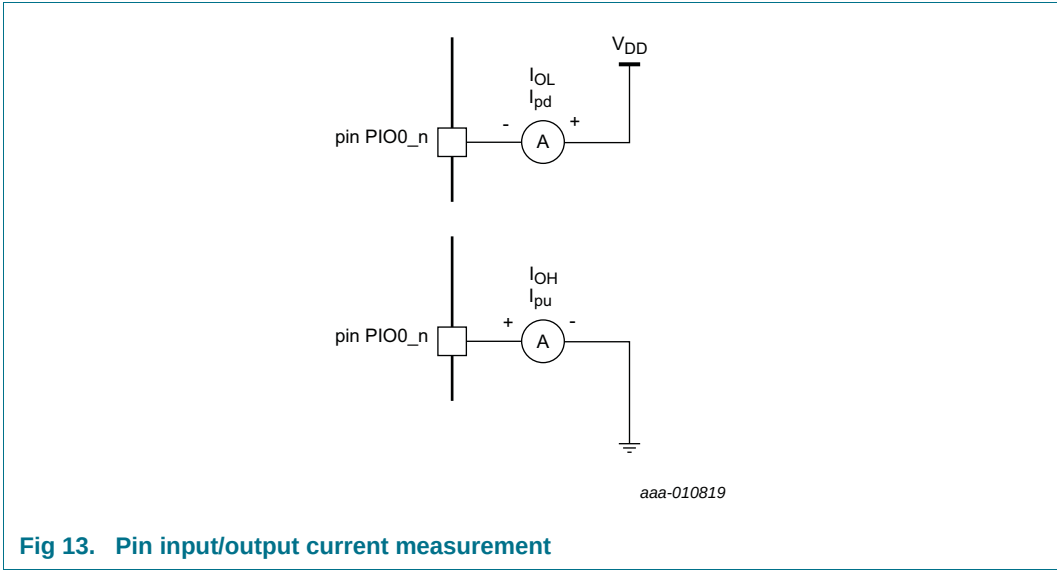
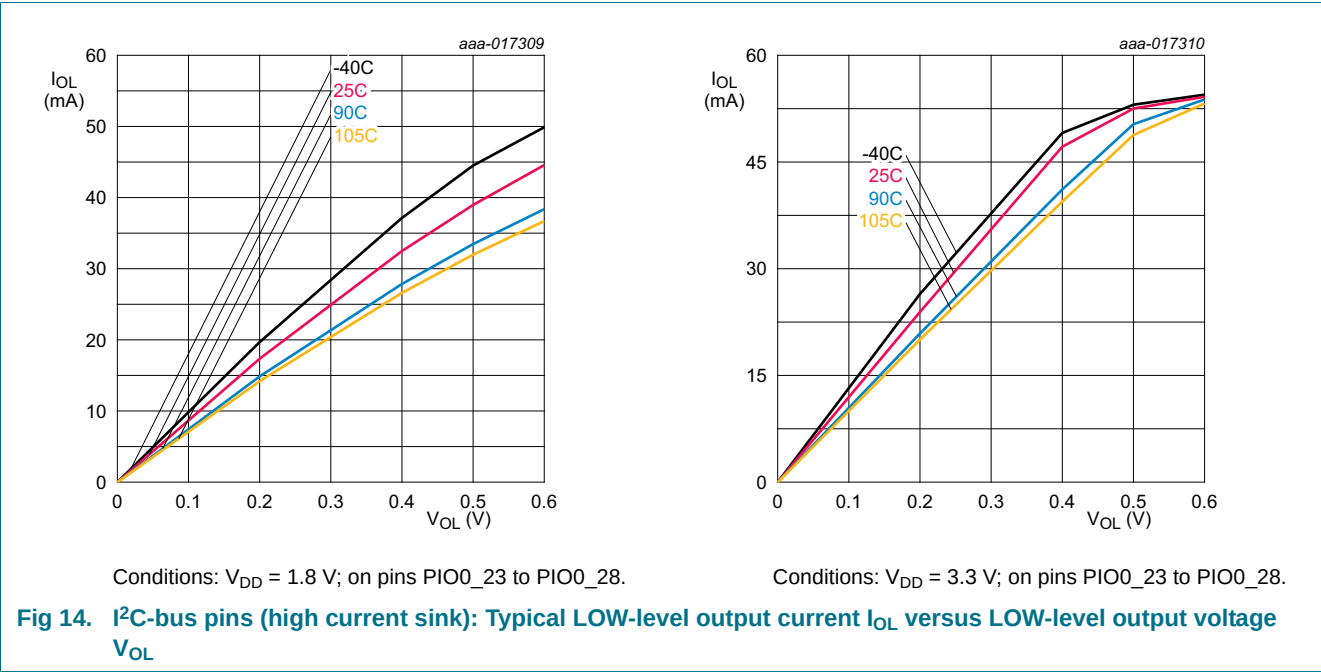
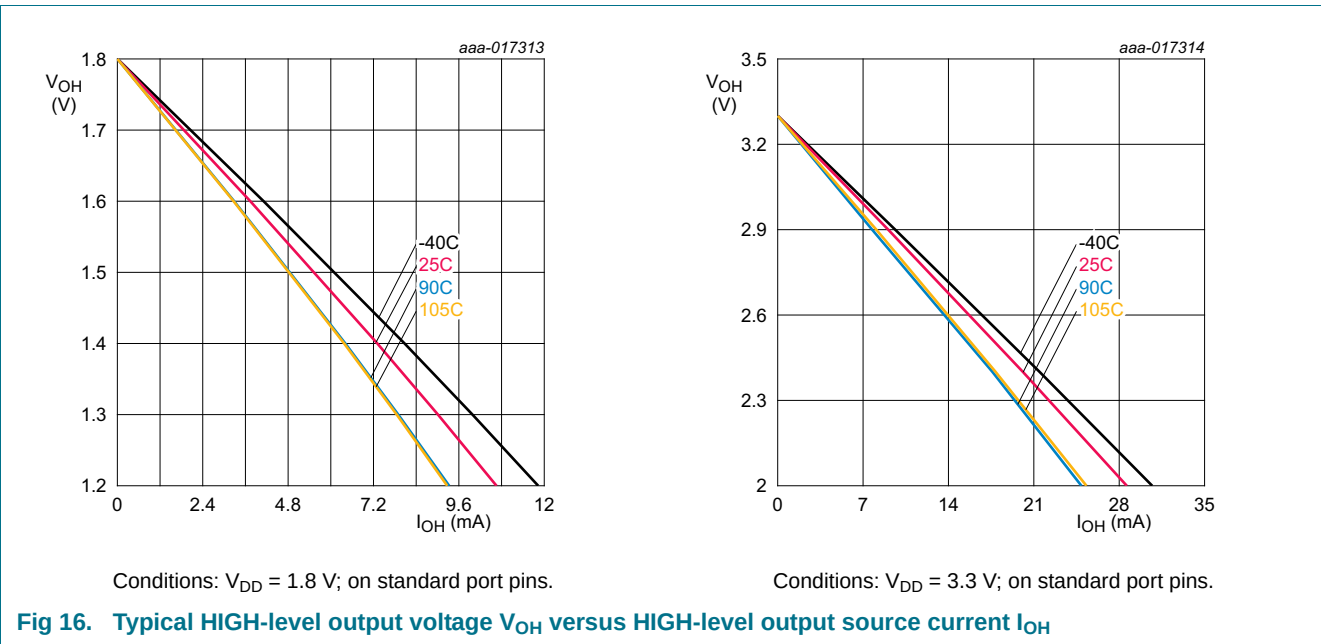
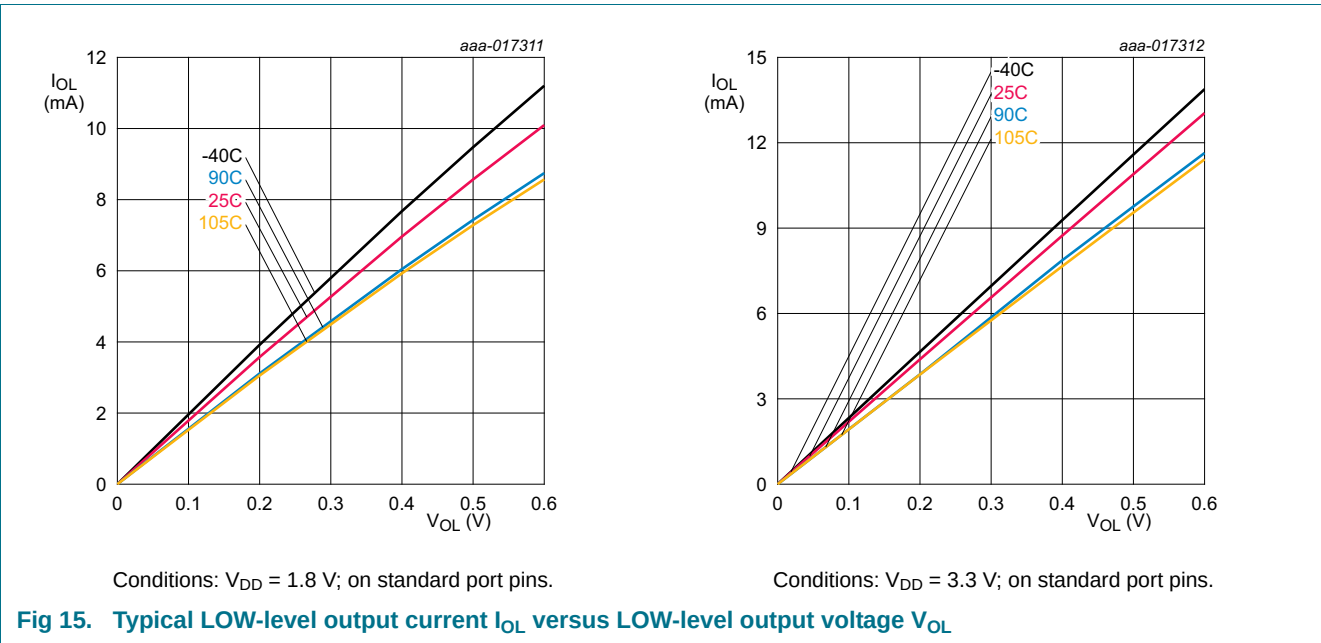
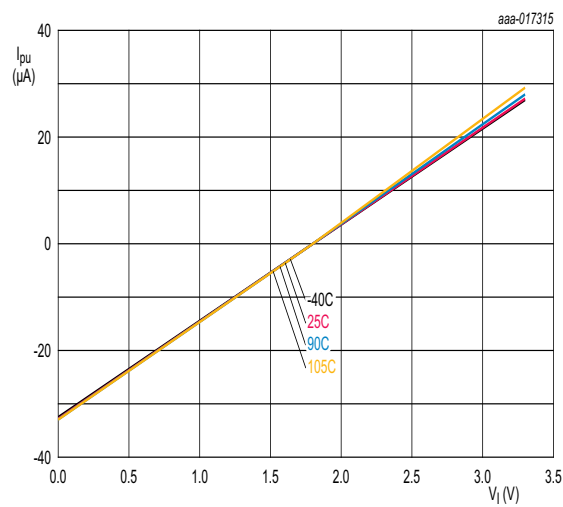


Fig 13. Pin input/output current measurement

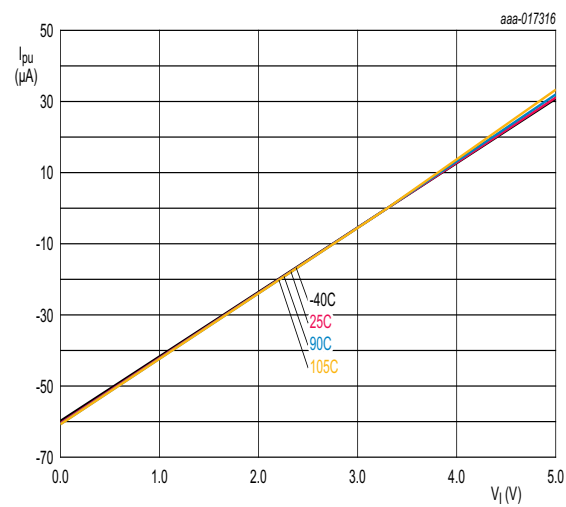
10.4.1 Electrical pin characteristics





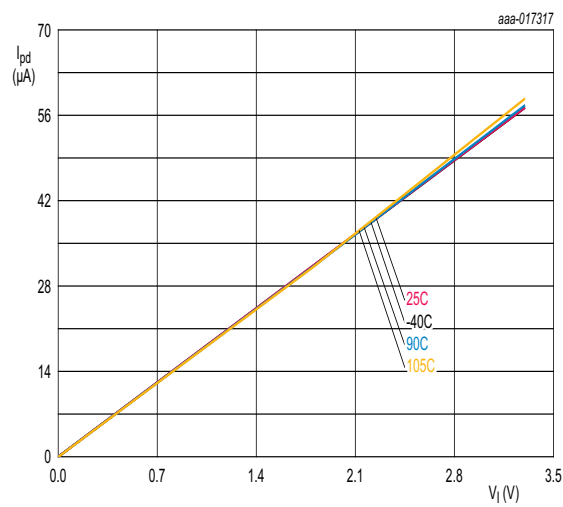


Conditions:  $V_{DD} = 1.8V$ ; on standard port pins.

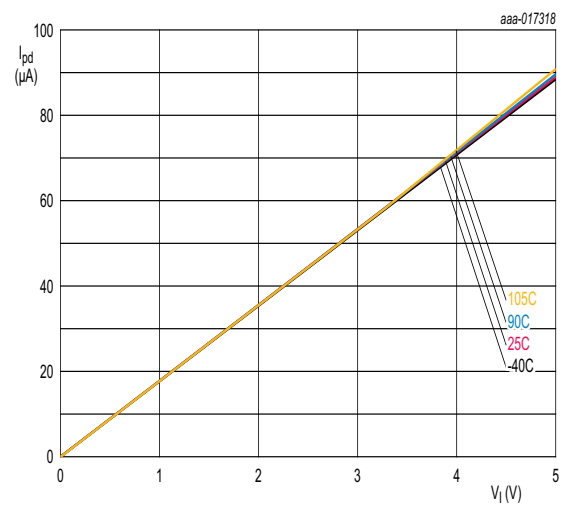


Conditions:  $V_{DD} = 3.3V$ ; on standard port pins.

Fig 17. Typical pull-up current  $I_{pu}$  versus input voltage  $V_i$



Conditions:  $V_{DD} = 1.8V$ ; on standard port pins.



Conditions:  $V_{DD} = 3.3V$ ; on standard port pins.

Fig 18. Typical pull-down current  $I_{pd}$  versus input voltage  $V_i$

## 11. Dynamic characteristics

### 11.1 Power-up ramp conditions

**Table 17. Power-up characteristics**

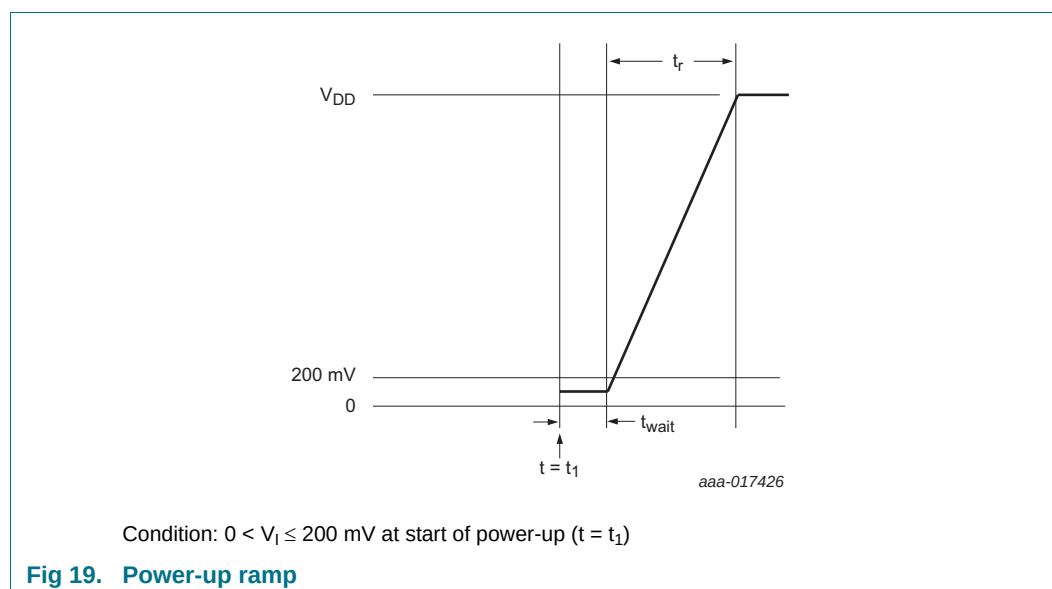
$T_{amb} = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}; 1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$

| Symbol     | Parameter     | Conditions                                  |        | Min | Typ | Max | Unit          |
|------------|---------------|---------------------------------------------|--------|-----|-----|-----|---------------|
| $t_r$      | rise time     | at $t = t_1$ : $0 < V_I \leq 200\text{ mV}$ | [1][3] | 0   | -   | 500 | ms            |
| $t_{wait}$ | wait time     |                                             | [1][2] | 12  | -   | -   | $\mu\text{s}$ |
| $V_I$      | input voltage | at $t = t_1$ on pin $V_{DD}$                | [3]    | 0   | -   | 200 | mV            |

[1] See [Figure 19](#).

[2] Based on simulation. The wait time specifies the time the power supply must be at levels below 200 mV before ramping up.

[3] Based on characterization, not tested in production.



**Fig 19. Power-up ramp**

### 11.2 Flash memory

**Table 18. Flash characteristics**

$T_{amb} = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C, unless otherwise specified. } 1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$

| Symbol     | Parameter        | Conditions                                    |     | Min   | Typ | Max | Unit   |
|------------|------------------|-----------------------------------------------|-----|-------|-----|-----|--------|
| $N_{endu}$ | endurance        | sector erase/program                          | [1] | 10000 | -   | -   | cycles |
|            |                  | page erase/program; page in a sector          |     | 1000  | -   | -   | cycles |
| $t_{ret}$  | retention time   | powered                                       |     | 10    | -   | -   | years  |
|            |                  | unpowered                                     |     | 10    | -   | -   | years  |
| $t_{er}$   | erase time       | page, sector, or multiple consecutive sectors |     | -     | 100 | -   | ms     |
| $t_{prog}$ | programming time |                                               | [2] | -     | 1   | -   | ms     |



[1] Number of erase/program cycles.

[2] Programming times are given for writing 512 bytes from RAM to the flash. Data must be written to the flash in blocks of 512 bytes.

### 11.3 I/O pins

**Table 19. Dynamic characteristic: I/O pins<sup>[1]</sup>**

$T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}; 1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$

| Symbol                                           | Parameter | Conditions                                                                                          |        | Min | Typ | Max | Unit |
|--------------------------------------------------|-----------|-----------------------------------------------------------------------------------------------------|--------|-----|-----|-----|------|
| <b>Standard I/O pins - normal drive strength</b> |           |                                                                                                     |        |     |     |     |      |
| $t_r$                                            | rise time | pin configured as output; SLEW = 1 (fast mode);<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$     | [2][3] | 1.0 | -   | 2.5 | ns   |
|                                                  |           | $1.62\text{ V} \leq V_{DD} \leq 1.98\text{ V}$                                                      |        | 1.6 | -   | 3.8 | ns   |
| $t_f$                                            | fall time | pin configured as output; SLEW = 1 (fast mode);<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$     | [2][3] | 0.9 | -   | 2.5 | ns   |
|                                                  |           | $1.62\text{ V} \leq V_{DD} \leq 1.98\text{ V}$                                                      |        | 1.7 | -   | 4.1 | ns   |
| $t_r$                                            | rise time | pin configured as output; SLEW = 0 (standard mode);<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | [2][3] | 1.9 | -   | 4.3 | ns   |
|                                                  |           | $1.62\text{ V} \leq V_{DD} \leq 1.98\text{ V}$                                                      |        | 2.9 | -   | 7.8 | ns   |
| $t_f$                                            | fall time | pin configured as output; SLEW = 0 (standard mode);<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | [2][3] | 1.9 | -   | 4.0 | ns   |
|                                                  |           | $1.62\text{ V} \leq V_{DD} \leq 1.98\text{ V}$                                                      |        | 2.7 | -   | 6.7 | ns   |
| $t_r$                                            | rise time | pin configured as input                                                                             | [4]    | 0.3 | -   | 1.3 | ns   |
| $t_f$                                            | fall time | pin configured as input                                                                             | [4]    | 0.2 | -   | 1.2 | ns   |

[1] Simulated data.

[2] Simulated using 10 cm of 50  $\Omega$  PCB trace with 5 pF receiver input. Rise and fall times measured between 80 % and 20 % of the full output signal level.

[3] The slew rate is configured in the IOCON block the SLEW bit. See the LPC5410x user manual.

[4]  $C_L = 20\text{ pF}$ . Rise and fall times measured between 90 % and 10 % of the full input signal level.

### 11.4 Wake-up process

**Table 20. Dynamic characteristic: Typical wake-up times from low power modes**

$V_{DD} = 3.3\text{ V}; T_{amb} = 25\text{ }^{\circ}\text{C};$  using IRC as the system clock.

| Symbol     | Parameter    | Conditions                                                                           |        | Min | Typ <sup>[1]</sup> | Max | Unit          |
|------------|--------------|--------------------------------------------------------------------------------------|--------|-----|--------------------|-----|---------------|
| $t_{wake}$ | wake-up time | from sleep mode                                                                      | [2][3] | -   | 1.6                | -   | $\mu\text{s}$ |
|            |              | from deep sleep mode with full SRAM retention:<br>to code executing in flash or SRAM | [2]    | -   | 18                 | -   | $\mu\text{s}$ |

**Table 20. Dynamic characteristic: Typical wake-up times from low power modes** $V_{DD} = 3.3\text{ V}$ ;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ; using IRC as the system clock.

| Symbol | Parameter | Conditions                                                   |                | Min | Typ <sup>[1]</sup> | Max | Unit          |
|--------|-----------|--------------------------------------------------------------|----------------|-----|--------------------|-----|---------------|
|        |           | from power down mode<br>to code executing in flash           | <sup>[2]</sup> | -   | 70                 | -   | $\mu\text{s}$ |
|        |           | to code executing in SRAM                                    | <sup>[2]</sup> |     | 18                 | -   | $\mu\text{s}$ |
|        |           | from deep power-down mode;<br>RTC disabled; using RESET pin. | <sup>[4]</sup> | -   | 200                | -   | $\mu\text{s}$ |

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The wake-up time measured is the time between when a GPIO input pin is triggered to wake the device up from the low power modes and from when a GPIO output pin is set in the interrupt service routine (ISR) wake-up handler.

[3] IRC enabled, all peripherals off.

[4] RTC disabled. Wake-up from deep power-down causes the part to go through entire reset process. The wake-up time measured is the time between when the RESET pin is triggered to wake the device up and when a GPIO output pin is set in the reset handler.

## 11.5 System PLL

**Table 21. PLL lock times and current**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ , unless otherwise specified.  $V_{DD} = 1.62\text{ V}$  to  $3.6\text{ V}$

| Symbol                                                                         | Parameter     | Conditions                                        |  | Min | Typ | Max  | Unit          |
|--------------------------------------------------------------------------------|---------------|---------------------------------------------------|--|-----|-----|------|---------------|
| <b>PLL configuration: input frequency 12 MHz; output frequency 75 MHz</b>      |               |                                                   |  |     |     |      |               |
| $t_{lock(PLL)}$                                                                | PLL lock time | PLL set-up procedure followed <a href="#">[2]</a> |  |     |     | 400  | $\mu\text{s}$ |
| $I_{DD(PLL)}$                                                                  | PLL current   | when locked <a href="#">[1][3]</a>                |  | -   | -   | 550  | $\mu\text{A}$ |
| <b>PLL configuration: input frequency 12 MHz; output frequency 100 MHz</b>     |               |                                                   |  |     |     |      |               |
| $t_{lock(PLL)}$                                                                | PLL lock time | PLL set-up procedure followed <a href="#">[2]</a> |  | -   | -   | 400  | $\mu\text{s}$ |
| $I_{DD(PLL)}$                                                                  | PLL current   | when locked <a href="#">[1][3]</a>                |  | -   | -   | 750  | $\mu\text{A}$ |
| <b>PLL configuration: input frequency 32.768 kHz; output frequency 75 MHz</b>  |               |                                                   |  |     |     |      |               |
| $t_{lock(PLL)}$                                                                | PLL lock time | - <a href="#">[1]</a>                             |  |     |     | 6250 | $\mu\text{s}$ |
| $I_{DD(PLL)}$                                                                  | PLL current   | when locked <a href="#">[1][3]</a>                |  | -   | -   | 450  | $\mu\text{A}$ |
| <b>PLL configuration: input frequency 32.768 kHz; output frequency 100 MHz</b> |               |                                                   |  |     |     |      |               |
| $t_{lock(PLL)}$                                                                | PLL lock time | - <a href="#">[1]</a>                             |  | -   | -   | 6250 | $\mu\text{s}$ |
| $I_{DD(PLL)}$                                                                  | PLL current   | when locked <a href="#">[1][3]</a>                |  | -   | -   | 560  | $\mu\text{A}$ |

[1] Data based on characterization results, not tested in production.

[2] PLL set-up requires high-speed start-up and transition to normal mode. Lock times are only valid when high-speed start-up settings are applied followed by normal mode settings. The procedure for setting up the PLL is described in the LPC5410x user manual.

[3] PLL current measured using lowest CCO frequency to obtain the desired output frequency.

Table 22. Dynamic characteristics of the PLL [1]

| Symbol                                                                                             | Parameter                   | Conditions                |        | Min        | Typ | Max    | Unit |
|----------------------------------------------------------------------------------------------------|-----------------------------|---------------------------|--------|------------|-----|--------|------|
| <b>Reference clock input</b>                                                                       |                             |                           |        |            |     |        |      |
| $F_{in}$                                                                                           | input frequency             | -                         |        | 32.768 kHz | -   | 25 MHz | -    |
| <b>Clock output</b>                                                                                |                             |                           |        |            |     |        |      |
| $f_o$                                                                                              | output frequency            | for PLL clkout output [3] |        | 1.2        | -   | 150    | MHz  |
| $d_o$                                                                                              | output duty cycle           | for PLL clkout output     |        | 46         | -   | 54     | %    |
| $f_{CCO}$                                                                                          | CCO frequency               |                           |        | -          | -   | 150    | MHz  |
| <b>Lock detector output</b>                                                                        |                             |                           |        |            |     |        |      |
| $\Delta_{lock}(PFD)$                                                                               | PFD lock criterion          |                           | [4]    | 1          | 2   | 4      | ns   |
| <b>Dynamic parameters at <math>f_{out} = f_{CCO} = 100</math> MHz; standard bandwidth settings</b> |                             |                           |        |            |     |        |      |
| $J_{rms-interval}$                                                                                 | RMS interval jitter         | $f_{ref} = 10$ MHz        | [5][6] | -          | 15  | 30     | ps   |
| $J_{pp-period}$                                                                                    | peak-to-peak, period jitter | $f_{ref} = 10$ MHz        | [5][6] | -          | 40  | 80     | ps   |

[1] Data based on characterization results, not tested in production.

[2] Output jitter depends on the frequency of input jitter and is equal to or less than the input jitter.

[3] Excluding under- and overshoot which may occur when the PLL is not in lock.

[4] A phase difference between the inputs of the PFD (clkref and clkfb) smaller than the PFD lock criterion means lock output is HIGH.

[5] Actual jitter dependent on amplitude and spectrum of substrate noise.

[6] Input clock coming from a crystal oscillator with less than 250 ps peak-to-peak period jitter.

## 11.6 IRC

Table 23. Dynamic characteristic: IRC oscillator

$1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ .

| Symbol        | Parameter                        | Conditions                                                                   |     | Min       | Typ[1] | Max       | Unit |
|---------------|----------------------------------|------------------------------------------------------------------------------|-----|-----------|--------|-----------|------|
| $f_{osc(RC)}$ | internal RC oscillator frequency | $T_{amb} = 25\text{ }^{\circ}\text{C}$                                       | [2] | 12 -1 %   | 12     | 12 +1 %   | MHz  |
|               |                                  | $-40\text{ }^{\circ}\text{C} \leq T_{amb} \leq +105\text{ }^{\circ}\text{C}$ | [3] | 12 -3.5 % | 12     | 12 +3 %   | MHz  |
|               |                                  | $0\text{ }^{\circ}\text{C} \leq T_{amb} \leq +85\text{ }^{\circ}\text{C}$    | [3] | 12 -2 %   | 12     | 12 +2.5 % | MHz  |

[1] Typical ratings are not guaranteed. The value listed is at room temperature (25 °C).

[2] Tested in production.

[3] Guaranteed by characterization, not tested in production.

## 11.7 RTC oscillator

See [Section 13.5](#) for connecting the RTC oscillator to a crystal or an external clock source.

Table 24. Dynamic characteristic: RTC oscillator

$1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  [1]

| Symbol | Parameter       | Conditions |  | Min | Typ[1] | Max | Unit |
|--------|-----------------|------------|--|-----|--------|-----|------|
| $f_i$  | input frequency | -          |  | -   | 32.768 | -   | kHz  |

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

## 11.8 Watchdog oscillator

Table 25. Dynamic characteristics: Watchdog oscillator

| Symbol                | Parameter                              |                   | Min | Typ <sup>[1]</sup> | Max | Unit |
|-----------------------|----------------------------------------|-------------------|-----|--------------------|-----|------|
| f <sub>osc(int)</sub> | internal watchdog oscillator frequency | <sup>[2]</sup>    | -   | 500                | -   | kHz  |
| D <sub>clkout</sub>   | clkout duty cycle                      |                   | 48  | -                  | 52  | %    |
| J <sub>PP-CC</sub>    | peak-peak period jitter                | <sup>[3][4]</sup> | -   | 1                  | 20  | ns   |
| t <sub>start</sub>    | start-up time                          | <sup>[4]</sup>    | -   | 4                  | -   | μs   |

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The typical frequency spread over processing and temperature ( $T_{amb} = -40\text{ °C}$  to  $+105\text{ °C}$ ) is  $\pm 40\%$ .

[3] Actual jitter dependent on amplitude and spectrum of substrate noise.

[4] Guaranteed by design. Not tested in production samples.

## 11.9 I<sup>2</sup>C-bus

Table 26. Dynamic characteristic: I<sup>2</sup>C-bus pins<sup>[1]</sup>

$T_{amb} = -40\text{ °C}$  to  $+105\text{ °C}$ ;  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ .<sup>[2]</sup>

| Symbol              | Parameter                    |                         | Conditions                  | Min                   | Max | Unit |
|---------------------|------------------------------|-------------------------|-----------------------------|-----------------------|-----|------|
| f <sub>SCL</sub>    | SCL clock frequency          |                         | Standard-mode               | 0                     | 100 | kHz  |
|                     |                              |                         | Fast-mode                   | 0                     | 400 | kHz  |
|                     |                              |                         | Fast-mode Plus              | 0                     | 1   | MHz  |
| t <sub>f</sub>      | fall time                    | <sup>[4][5][6][7]</sup> | of both SDA and SCL signals | -                     | 300 | ns   |
|                     |                              |                         | Standard-mode               | -                     | 300 | ns   |
|                     |                              |                         | Fast-mode                   | $20 + 0.1 \times C_b$ | 300 | ns   |
| t <sub>LOW</sub>    | LOW period of the SCL clock  |                         | Fast-mode Plus              | -                     | 120 | ns   |
|                     |                              |                         | Standard-mode               | 4.7                   | -   | μs   |
|                     |                              |                         | Fast-mode                   | 1.3                   | -   | μs   |
| t <sub>HIGH</sub>   | HIGH period of the SCL clock |                         | Fast-mode Plus              | 0.5                   | -   | μs   |
|                     |                              |                         | Standard-mode               | 4.0                   | -   | μs   |
|                     |                              |                         | Fast-mode                   | 0.6                   | -   | μs   |
| t <sub>HD;DAT</sub> | data hold time               | <sup>[3][4][8]</sup>    | Fast-mode Plus              | 0.26                  | -   | μs   |
|                     |                              |                         | Standard-mode               | 0                     | -   | μs   |
|                     |                              |                         | Fast-mode                   | 0                     | -   | μs   |
| t <sub>SU;DAT</sub> | data set-up time             | <sup>[9][10]</sup>      | Fast-mode Plus              | 0                     | -   | μs   |
|                     |                              |                         | Standard-mode               | 250                   | -   | ns   |
|                     |                              |                         | Fast-mode                   | 100                   | -   | ns   |
|                     |                              |                         | Fast-mode Plus              | 50                    | -   | ns   |

[1] Guaranteed by design. Not tested in production.

[2] Parameters are valid over operating temperature range unless otherwise specified. See the I<sup>2</sup>C-bus specification *UM10204* for details.

[3] t<sub>HD;DAT</sub> is the data hold time that is measured from the falling edge of SCL; applies to data in transmission and the acknowledge.

[4] A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the V<sub>IH(min)</sub> of the SCL signal) to bridge the undefined region of the falling edge of SCL.

[5] C<sub>b</sub> = total capacitance of one bus line in pF. If mixed with Hs-mode devices, faster fall times are allowed.

- [6] The maximum  $t_f$  for the SDA and SCL bus lines is specified at 300 ns. The maximum fall time for the SDA output stage  $t_f$  is specified at 250 ns. This allows series protection resistors to be connected in between the SDA and the SCL pins and the SDA/SCL bus lines without exceeding the maximum specified  $t_f$ .
- [7] In Fast-mode Plus, fall time is specified the same for both output stage and bus timing. If series resistors are used, designers should allow for this when considering bus timing.
- [8] The maximum  $t_{HD;DAT}$  could be 3.45  $\mu$ s and 0.9  $\mu$ s for Standard-mode and Fast-mode but must be less than the maximum of  $t_{VD;DAT}$  or  $t_{VD;ACK}$  by a transition time. This maximum must only be met if the device does not stretch the LOW period ( $t_{LOW}$ ) of the SCL signal. If the clock stretches the SCL, the data must be valid by the set-up time before it releases the clock.
- [9]  $t_{SU;DAT}$  is the data set-up time that is measured with respect to the rising edge of SCL; applies to data in transmission and the acknowledge.
- [10] A Fast-mode I<sup>2</sup>C-bus device can be used in a Standard-mode I<sup>2</sup>C-bus system but the requirement  $t_{SU;DAT} = 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_{r(max)} + t_{SU;DAT} = 1000 + 250 = 1250$  ns (according to the Standard-mode I<sup>2</sup>C-bus specification) before the SCL line is released. Also the acknowledge timing must meet this set-up time.

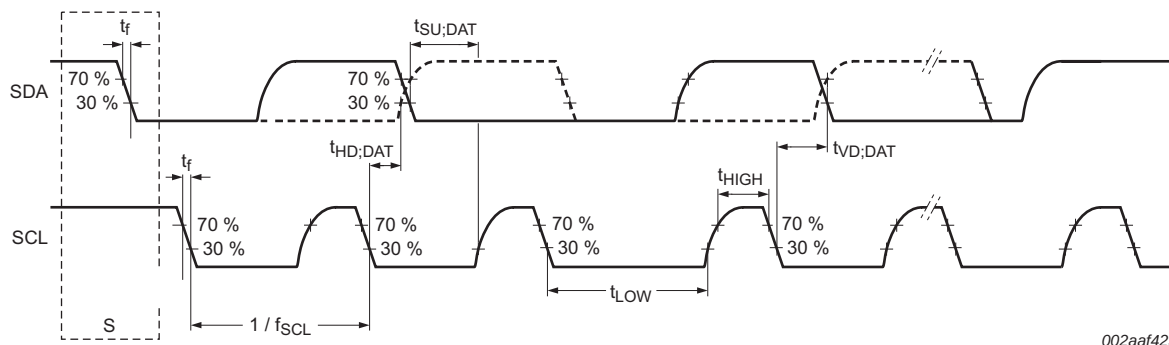


Fig 20. I<sup>2</sup>C-bus pins clock timing

## 11.10 SPI interfaces

The actual SPI bit rate depends on the delays introduced by the external trace, the external device, system clock (CCLK), and capacitive loading. Excluding delays introduced by external device and PCB, the maximum supported bit rate for SPI master mode is 71 Mbit/s, and the maximum supported bit rate for SPI slave mode is 21 Mbit/s.

**Table 27. SPI dynamic characteristics**[\[4\]](#)

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $105\text{ }^{\circ}\text{C}$ ;  $C_L = 30\text{ pF}$  balanced loading on all pins; SLEW = standard mode. Parameters sampled at the 50 % level of the rising or falling edge.

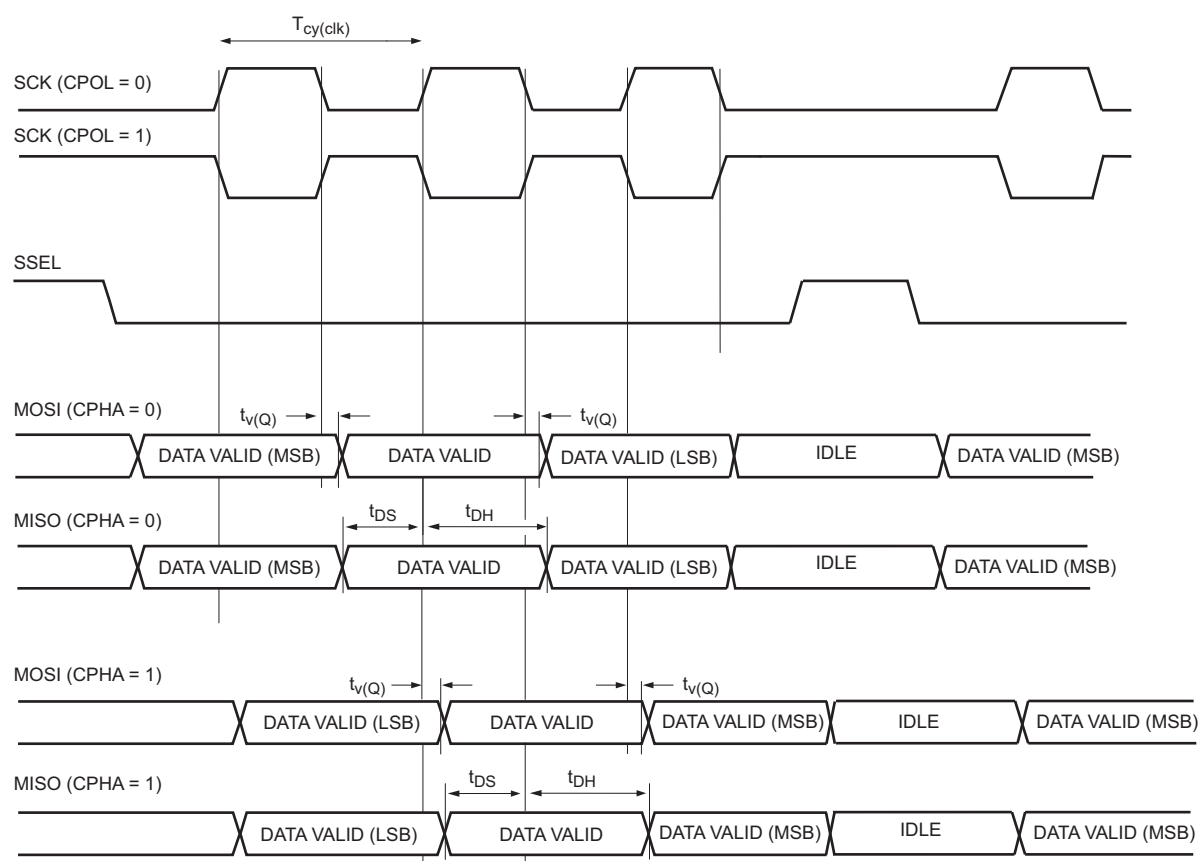
| Symbol                         | Parameter              | Conditions              |  | Min | Max | Unit |
|--------------------------------|------------------------|-------------------------|--|-----|-----|------|
| SPI master 1.62V ≤ VDD ≤ 2.0 V |                        |                         |  |     |     |      |
| t <sub>DS</sub>                | data set-up time       | CCLK = 1 MHz to 12 MHz  |  | 0   | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 0   | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 0   | -   | ns   |
| t <sub>DH</sub>                | data hold time         | CCLK = 1 MHz to 12 MHz  |  | 14  | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 12  | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 9   | -   | ns   |
| t <sub>v(Q)</sub>              | data output valid time | CCLK = 1 MHz to 12 MHz  |  | 0   | 7   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 0   | 2   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 0   | 2   | ns   |
| SPI slave 1.62V ≤ VDD ≤ 2.0 V  |                        |                         |  |     |     |      |
| t <sub>DS</sub>                | data set-up time       | CCLK = 1 MHz to 12 MHz  |  | 22  | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 4   | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 4   | -   | ns   |
| t <sub>DH</sub>                | data hold time         | CCLK = 1 MHz to 12 MHz  |  | 0   | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 0   | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 0   | -   | ns   |
| t <sub>v(Q)</sub>              | data output valid time | CCLK = 1 MHz to 12 MHz  |  | 46  | 70  | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 30  | 37  | ns   |
|                                |                        | CCLK = 96 MHz           |  | 30  | 36  | ns   |
| SPI master 2.7 V ≤ VDD ≤ 3.6 V |                        |                         |  |     |     |      |
| t <sub>DS</sub>                | data set-up time       | CCLK = 1 MHz to 12 MHz  |  | 0   | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 0   | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 0   | -   | ns   |
| t <sub>DH</sub>                | data hold time         | CCLK = 1 MHz to 12 MHz  |  | 10  | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 8   | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 7   | -   | ns   |
| t <sub>v(Q)</sub>              | data output valid time | CCLK = 1 MHz to 12 MHz  |  | 0   | 6   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 0   | 1   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 0   | 1   | ns   |
| SPI slave 2.7V ≤ VDD ≤ 3.6 V   |                        |                         |  |     |     |      |
| t <sub>DS</sub>                | data set-up time       | CCLK = 1 MHz to 12 MHz  |  | 21  | -   | ns   |
|                                |                        | CCLK = 48 MHz to 60 MHz |  | 4   | -   | ns   |
|                                |                        | CCLK = 96 MHz           |  | 3   | -   | ns   |

**Table 27. SPI dynamic characteristics**<sup>[1]</sup>

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $105\text{ }^{\circ}\text{C}$ ;  $C_L = 30\text{ pF}$  balanced loading on all pins; SLEW = standard mode. Parameters sampled at the 50 % level of the rising or falling edge.

| Symbol     | Parameter              | Conditions              | Min | Max | Unit |
|------------|------------------------|-------------------------|-----|-----|------|
| $t_{DH}$   | data hold time         | CCLK = 1 MHz to 12 MHz  | 0   | -   | ns   |
|            |                        | CCLK = 48 MHz to 60 MHz | 0   | -   | ns   |
|            |                        | CCLK = 96 MHz           | 0   | -   | ns   |
| $t_{V(Q)}$ | data output valid time | CCLK = 1 MHz to 12 MHz  | 36  | 61  | ns   |
|            |                        | CCLK = 48 MHz to 60 MHz | 21  | 22  | ns   |
|            |                        | CCLK = 96 MHz           | 20  | 21  | ns   |

[1] Based on characterization; not tested in production.



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$T_{cy(clk)} = \text{CCLK}/\text{DIVVAL}$  with CCLK = system clock frequency. DIVVAL is the SPI clock divider. See the LPC5410x User manual.

**Fig 21. SPI master timing**



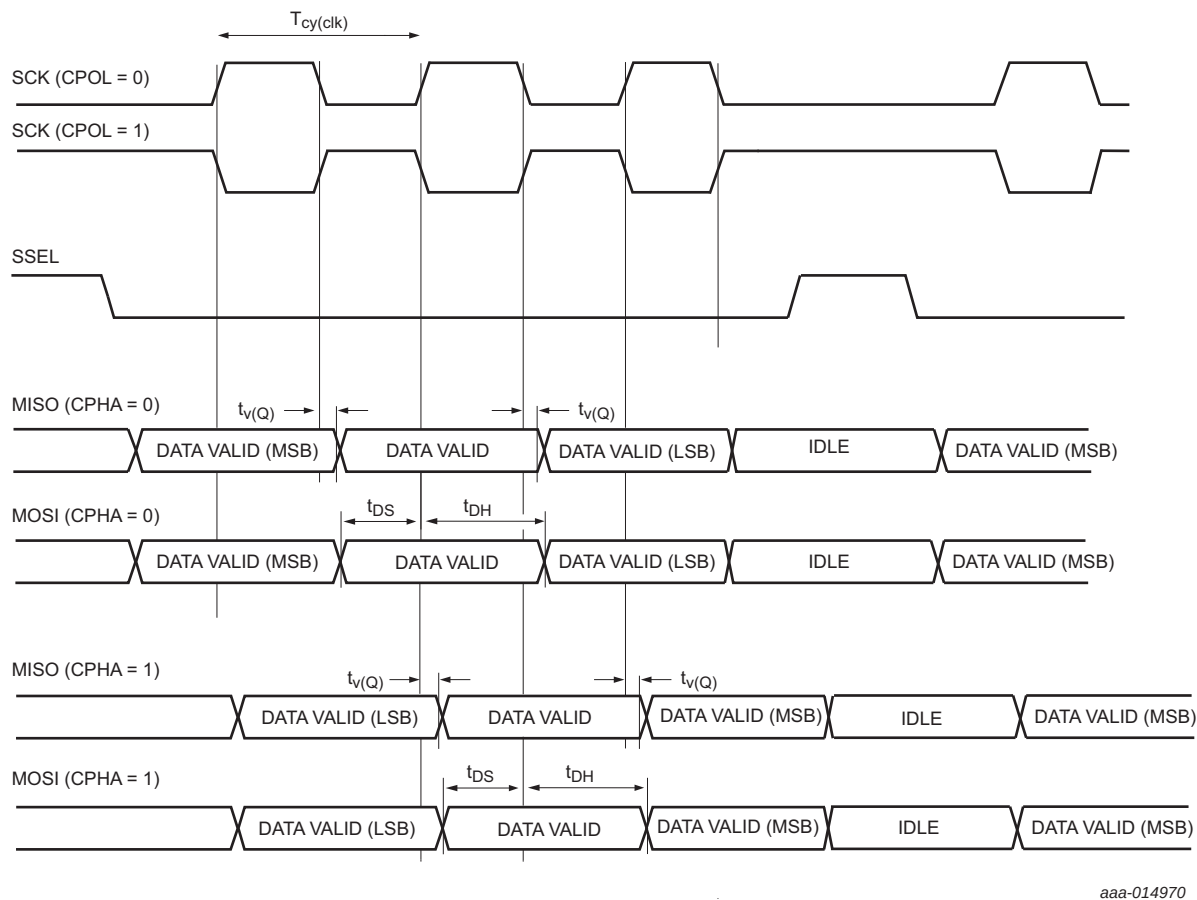


Fig 22. SPI slave timing

## 11.11 USART interface

The actual USART bit rate depends on the delays introduced by the external trace, the external device, system clock (CCLK), and capacitive loading. Excluding delays introduced by external device and PCB, the maximum supported bit rate for USART master and slave synchronous modes is 24 Mbit/s.

**Table 28. USART dynamic characteristics<sup>[1]</sup>**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $105\text{ }^{\circ}\text{C}$ ;  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ ;  $C_L = 30\text{ pF}$  balanced loading on all pins; SLEW = standard mode. Parameters sampled at the 50% level of the falling or rising edge.

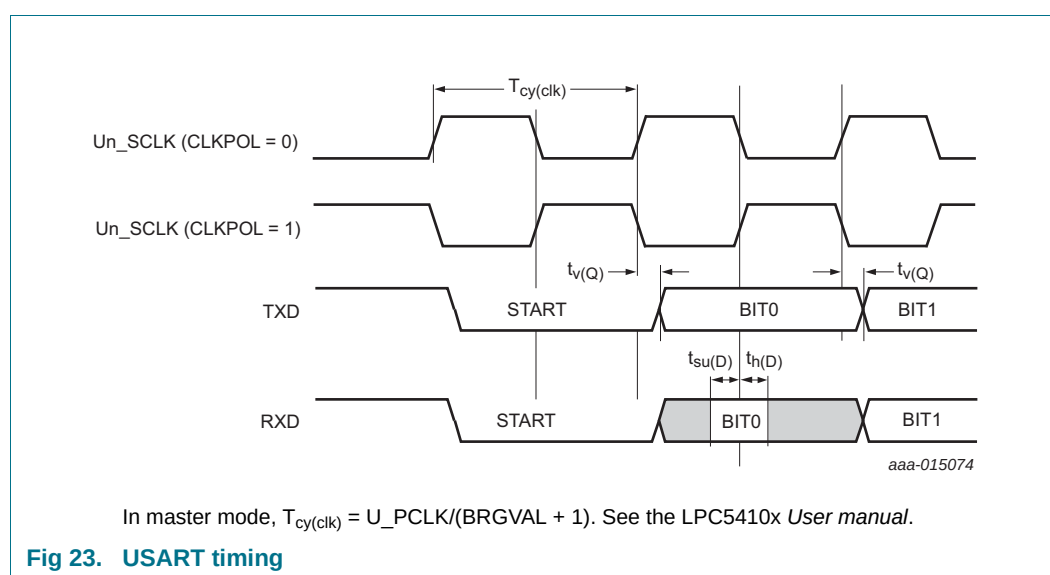
| Symbol                                                 | Parameter              | Conditions              | Min | Max | Unit |
|--------------------------------------------------------|------------------------|-------------------------|-----|-----|------|
| USART master (in synchronous mode) 1.62V ≤ VDD ≤ 2.0 V |                        |                         |     |     |      |
| t <sub>su(D)</sub>                                     | data input set-up time | CCLK = 1 MHz to 12 MHz  | 65  | -   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 35  | -   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 34  | -   | ns   |
| t <sub>h(D)</sub>                                      | data input hold time   | CCLK = 1 MHz to 12 MHz  | 0   | -   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 0   | -   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 0   | -   | ns   |
| t <sub>v(Q)</sub>                                      | data output valid time | CCLK = 1 MHz to 12 MHz  | 0   | 8   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 0   | 2   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 0   | 2   | ns   |
| USART slave (in synchronous mode) 1.62V ≤ VDD ≤ 2.0 V  |                        |                         |     |     |      |
| t <sub>su(D)</sub>                                     | data input set-up time | CCLK = 1 MHz to 12 MHz  | 18  | -   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 5   | -   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 4   | -   | ns   |
| t <sub>h(D)</sub>                                      | data input hold time   | CCLK = 1 MHz to 12 MHz  | 0   | -   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 0   | -   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 0   | -   | ns   |
| t <sub>v(Q)</sub>                                      | data output valid time | CCLK = 1 MHz to 12 MHz  | 50  | 65  | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 35  | 40  | ns   |
|                                                        |                        | CCLK = 96 MHz           | 30  | 36  | ns   |
| USART master (in synchronous mode) 2.7V ≤ VDD ≤ 3.6V   |                        |                         |     |     |      |
| t <sub>su(D)</sub>                                     | data input set-up time | CCLK = 1 MHz to 12 MHz  | 61  | -   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 22  | -   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 21  | -   | ns   |
| t <sub>h(D)</sub>                                      | data input hold time   | CCLK = 1 MHz to 12 MHz  | 0   | -   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 0   | -   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 0   | -   | ns   |
| t <sub>v(Q)</sub>                                      | data output valid time | CCLK = 1 MHz to 12 MHz  | 0   | 7   | ns   |
|                                                        |                        | CCLK = 48 MHz to 60 MHz | 1   | 2   | ns   |
|                                                        |                        | CCLK = 96 MHz           | 1   | 2   | ns   |

**Table 28. USART dynamic characteristics<sup>[1]</sup>**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $105\text{ }^{\circ}\text{C}$ ;  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ ;  $C_L = 30\text{ pF}$  balanced loading on all pins; SLEW = standard mode. Parameters sampled at the 50% level of the falling or rising edge.

| Symbol                                                                                           | Parameter              | Conditions              | Min | Max | Unit |
|--------------------------------------------------------------------------------------------------|------------------------|-------------------------|-----|-----|------|
| <b>USART slave (in synchronous mode) <math>2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math></b> |                        |                         |     |     |      |
| $t_{su(D)}$                                                                                      | data input set-up time | CCLK = 1 MHz to 12 MHz  | 21  | -   | ns   |
|                                                                                                  |                        | CCLK = 48 MHz to 60 MHz | 5   | -   | ns   |
|                                                                                                  |                        | CCLK = 96 MHz           | 4   | -   | ns   |
| $t_{h(D)}$                                                                                       | data input hold time   | CCLK = 1 MHz to 12 MHz  | 0   | -   | ns   |
|                                                                                                  |                        | CCLK = 48 MHz to 60 MHz | 0   | -   | ns   |
|                                                                                                  |                        | CCLK = 96 MHz           | 0   | -   | ns   |
| $t_{v(Q)}$                                                                                       | data output valid time | CCLK = 1 MHz to 12 MHz  | 37  | 62  | ns   |
|                                                                                                  |                        | CCLK = 48 MHz to 60 MHz | 22  | 25  | ns   |
|                                                                                                  |                        | CCLK = 96 MHz           | 19  | 21  | ns   |

[1] Based on characterization; not tested in production.



## 11.12 SCTimer/PWM output timing

**Table 29. SCTimer/PWM output dynamic characteristics**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $105\text{ }^{\circ}\text{C}$ ;  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$   $C_L = 30\text{ pF}$ . Simulated skew (over process, voltage, and temperature) of any two SCT fixed-pin output signals; sampled at 10 % and 90 % of the signal level; values guaranteed by design.

| Symbol      | Parameter        | Conditions | Min | Typ | Max | Unit |
|-------------|------------------|------------|-----|-----|-----|------|
| $t_{sk(o)}$ | output skew time | -          | -   | -   | 3.0 | ns   |

## 12. Analog characteristics

### 12.1 BOD

**Table 30. BOD static characteristics**

$T_{amb} = 25\text{ }^{\circ}\text{C}$ ; based on characterization; not tested in production.

| Symbol   | Parameter         | Conditions        |  | Min | Typ  | Max | Unit |
|----------|-------------------|-------------------|--|-----|------|-----|------|
| $V_{th}$ | threshold voltage | interrupt level 0 |  |     |      |     |      |
|          |                   | assertion         |  | -   | 2.05 | -   | V    |
|          |                   | de-assertion      |  | -   | 2.20 | -   | V    |
| $V_{th}$ | threshold voltage | interrupt level 1 |  |     |      |     |      |
|          |                   | assertion         |  | -   | 2.45 | -   | V    |
|          |                   | de-assertion      |  | -   | 2.60 | -   | V    |
|          |                   | reset level 1     |  |     |      |     |      |
|          |                   | assertion         |  | -   | 1.85 | -   | V    |
|          |                   | de-assertion      |  | -   | 2.00 | -   | V    |
| $V_{th}$ | threshold voltage | interrupt level 2 |  |     |      |     |      |
|          |                   | assertion         |  | -   | 2.75 | -   | V    |
|          |                   | de-assertion      |  | -   | 2.90 | -   | V    |
|          |                   | reset level 2     |  |     |      |     |      |
|          |                   | assertion         |  | -   | 2.00 | -   | V    |
|          |                   | de-assertion      |  | -   | 2.15 | -   | V    |
| $V_{th}$ | threshold voltage | interrupt level 3 |  |     |      |     |      |
|          |                   | assertion         |  | -   | 3.05 | -   | V    |
|          |                   | de-assertion      |  | -   | 3.20 | -   | V    |
|          |                   | reset level 3     |  |     |      |     |      |
|          |                   | assertion         |  | -   | 2.30 | -   | V    |
|          |                   | de-assertion      |  | -   | 2.45 | -   | V    |

## 12.2 12-bit ADC characteristics

**Table 31. 12-bit ADC static characteristics**

$T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+105\text{ }^{\circ}\text{C}$ ;  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ ;  $V_{REFP} = V_{DDA}$ ;  $V_{SSA} = V_{REFN} = GND$ . ADC calibrated at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ .

| Symbol         | Parameter                    | Conditions                           |                    | Min  | Typ <sup>[2]</sup> | Max       | Unit       |
|----------------|------------------------------|--------------------------------------|--------------------|------|--------------------|-----------|------------|
| $V_{IA}$       | analog input voltage         |                                      | <sup>[3]</sup>     | 0    | -                  | $V_{DDA}$ | V          |
| $C_{ia}$       | analog input capacitance     |                                      | <sup>[4]</sup>     | -    | 5                  | -         | pF         |
| $f_{clk(ADC)}$ | ADC clock frequency          |                                      |                    |      | -                  | 80        | MHz        |
| $f_s$          | sampling frequency           |                                      |                    | -    | -                  | 5.0       | Msamples/s |
| $E_D$          | differential linearity error | $V_{DDA} = V_{REFP} = 1.62\text{ V}$ | <sup>[1][5]</sup>  | -    | $\pm 3$            | -         | LSB        |
|                |                              | $V_{DDA} = V_{REFP} = 3.6\text{ V}$  |                    |      | $\pm 2$            |           | LSB        |
| $E_{L(adj)}$   | integral non-linearity       | $V_{DDA} = V_{REFP} = 1.62\text{ V}$ | <sup>[1][6]</sup>  | -    | $\pm 5$            | -         | LSB        |
|                |                              | $V_{DDA} = V_{REFP} = 3.6\text{ V}$  |                    | -    | $\pm 2$            | -         | LSB        |
| $E_O$          | offset error                 | calibration enabled                  | <sup>[1][7]</sup>  | -    | $\pm 5.6$          | -         | mV         |
| $V_{err(FS)}$  | full-scale error voltage     | $V_{DDA} = V_{REFP} = 1.62\text{ V}$ | <sup>[1][8]</sup>  | -    | $\pm 3$            |           | LSB        |
|                |                              | $V_{DDA} = V_{REFP} = 3.6\text{ V}$  |                    | -    | $\pm 3$            |           | LSB        |
| $Z_i$          | input impedance              | $f_s = 5.0\text{ Msamples/s}$        | <sup>[9][10]</sup> | 17.0 | -                  | -         | k $\Omega$ |

[1] Based on characterization; not tested in production.

[2] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[3] The input resistance of ADC channels 6 to 11 is higher than ADC channels 0 to 5.

[4]  $C_{ia}$  represents the external capacitance on the analog input channel for sampling speeds of 5.0 Msamples/s. No parasitic capacitances included.

[5] The differential linearity error ( $E_D$ ) is the difference between the actual step width and the ideal step width. See [Figure 24](#).

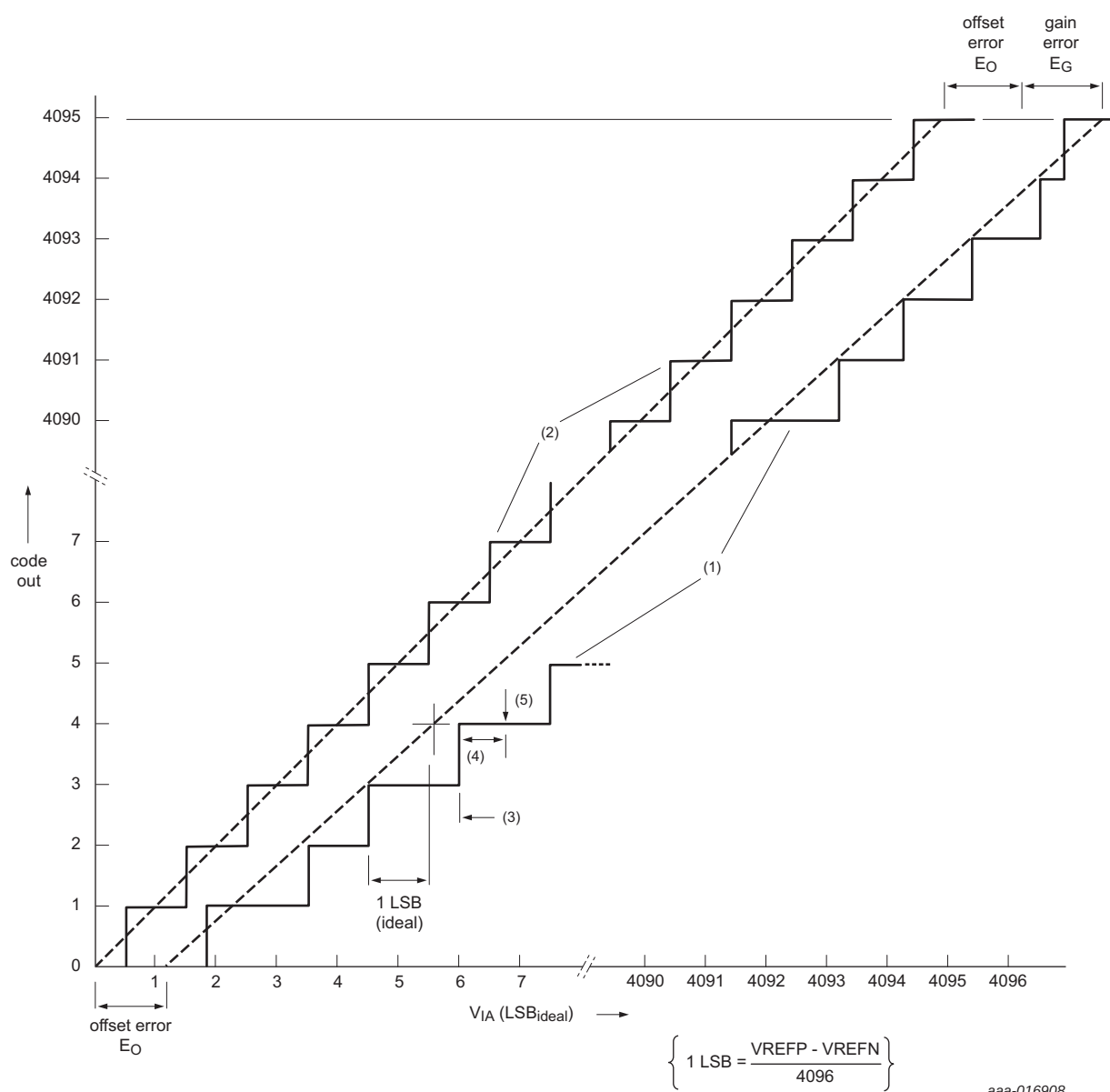
[6] The integral non-linearity ( $E_{L(adj)}$ ) is the peak difference between the center of the steps of the actual and the ideal transfer curve after appropriate adjustment of gain and offset errors. See [Figure 24](#).

[7] The offset error ( $E_O$ ) is the absolute difference between the straight line which fits the actual curve and the straight line which fits the ideal curve. See [Figure 24](#).

[8] The full-scale error voltage or gain error ( $E_G$ ) is the difference between the straight-line fitting the actual transfer curve after removing offset error, and the straight line which fits the ideal transfer curve. See [Figure 24](#).

[9]  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ; maximum sampling frequency  $f_s = 5.0\text{ Msamples/s}$  and analog input capacitance  $C_{ia} = 5\text{ pF}$ .

[10] Input impedance  $Z_i$  is inversely proportional to the sampling frequency and the total input capacity including  $C_{ia}$  and  $C_{io}$ :  $Z_i \propto 1 / (f_s \times C_i)$ . See [Table 16](#) for  $C_{io}$ . See [Figure 25](#).



- (1) Example of an actual transfer curve.
- (2) The ideal transfer curve.
- (3) Differential linearity error ( $E_D$ ).
- (4) Integral non-linearity ( $E_{L(adj)}$ ).
- (5) Center of a step of the actual transfer curve.

**Fig 24. 12-bit ADC characteristics**

**Table 32. ADC sampling times<sup>[1]</sup>**

$-40\text{ }^{\circ}\text{C} \leq T_{amb} \leq 85\text{ }^{\circ}\text{C}$ ;  $1.62\text{ V} \leq V_{DDA} \leq 3.6\text{ V}$ ;  $1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}$

| Symbol                                                              | Parameter     | Conditions                        |     | Min | Typ | Max | Unit |
|---------------------------------------------------------------------|---------------|-----------------------------------|-----|-----|-----|-----|------|
| ADC inputs ADC_5 to ADC_0 (fast channels); ADC resolution = 12 bit  |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 20  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 23  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 26  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 31  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 47  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 75  | -   | -   | ns   |
| ADC inputs ADC_5 to ADC_0 (fast channels); ADC resolution = 10 bit  |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 15  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 18  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 20  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 24  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 38  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 62  | -   | -   | ns   |
| ADC inputs ADC_5 to ADC_0 (fast channels); ADC resolution = 8 bit   |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 12  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 13  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 15  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 19  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 30  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 48  | -   | -   | ns   |
| ADC inputs ADC_5 to ADC_0 (fast channels); ADC resolution = 6 bit   |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 9   | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 10  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 11  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 13  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 22  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 36  | -   | -   | ns   |
| ADC inputs ADC_11 to ADC_6 (slow channels); ADC resolution = 12 bit |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 43  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 46  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 50  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 56  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 74  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 105 | -   | -   | ns   |

Table 32. ADC sampling times<sup>[1]</sup> ...continued-40 °C ≤ T<sub>amb</sub> ≤ 85 °C; 1.62 V ≤ V<sub>DDA</sub> ≤ 3.6 V; 1.62 V ≤ V<sub>DD</sub> ≤ 3.6 V

| Symbol                                                              | Parameter     | Conditions                        |     | Min | Typ | Max | Unit |
|---------------------------------------------------------------------|---------------|-----------------------------------|-----|-----|-----|-----|------|
| ADC inputs ADC_11 to ADC_6 (slow channels); ADC resolution = 10 bit |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 35  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 38  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 40  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 46  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 61  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 86  | -   | -   | ns   |
| ADC inputs ADC_11 to ADC_6 (slow channels); ADC resolution = 8 bit  |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 27  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 29  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 32  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 36  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 48  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 69  | -   | -   | ns   |
| ADC inputs ADC_11 to ADC_6 (slow channels); ADC resolution = 6 bit  |               |                                   |     |     |     |     |      |
| t <sub>s</sub>                                                      | sampling time | Z <sub>0</sub> < 0.05 kΩ          | [3] | 20  | -   | -   | ns   |
|                                                                     |               | 0.05 kΩ ≤ Z <sub>0</sub> < 0.1 kΩ |     | 22  | -   | -   | ns   |
|                                                                     |               | 0.1 kΩ ≤ Z <sub>0</sub> < 0.2 kΩ  |     | 23  | -   | -   | ns   |
|                                                                     |               | 0.2 kΩ ≤ Z <sub>0</sub> < 0.5 kΩ  |     | 26  | -   | -   | ns   |
|                                                                     |               | 0.5 kΩ ≤ Z <sub>0</sub> < 1 kΩ    |     | 36  | -   | -   | ns   |
|                                                                     |               | 1 kΩ ≤ Z <sub>0</sub> < 5 kΩ      |     | 51  | -   | -   | ns   |

[1] Characterized through simulation. Not tested in production.

[2] The ADC default sampling time is 2.5 ADC clock cycles. To match a given analog source output impedance, the sampling time can be extended by adding up to seven ADC clock cycles for a maximum sampling time of 9.5 ADC clock cycles. See the TSAMP bits in the ADC CTRL register.

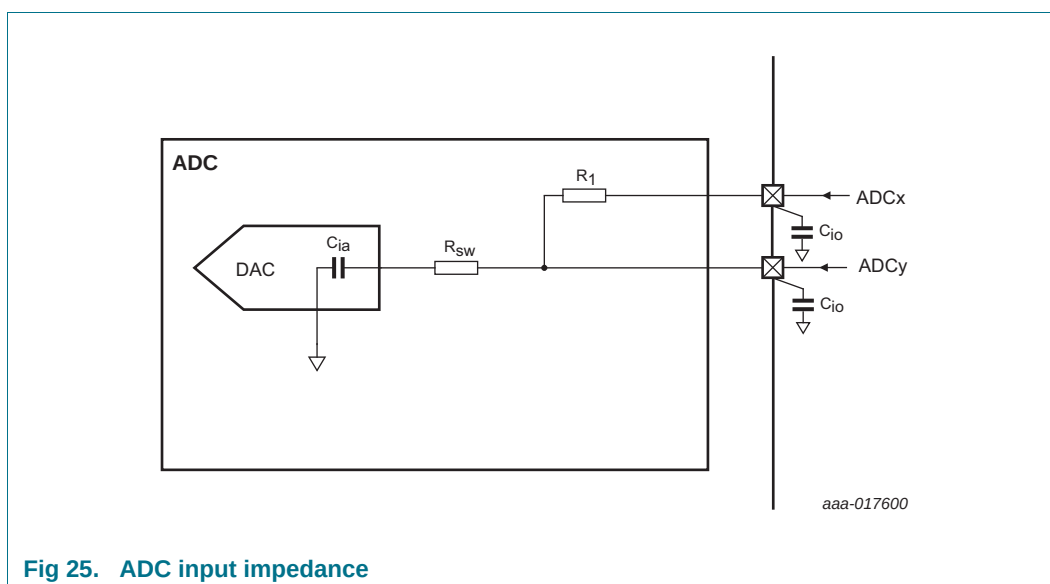
[3] Z<sub>0</sub> = analog source output impedance.



### 12.2.1 ADC input impedance

[Figure 25](#) shows the ADC input impedance. In this figure:

- ADCx represents slow ADC input channels 6 to 11.
- ADCy represents fast ADC input channels 0 to 5.
- $R_1$  and  $R_{SW}$  are the switch-on resistance on the ADC input channel.
- If fast channels (ADC inputs 0 to 5) are selected, the ADC input signal goes through  $R_{SW}$  to the sampling capacitor ( $C_{ia}$ ).
- If slow channels (ADC inputs 6 to 11) are selected, the ADC input signal goes through  $R_1 + R_{SW}$  to the sampling capacitor ( $C_{ia}$ ).
- Typical values,  $R_1 = 487\ \Omega$ ,  $R_{SW} = 278\ \Omega$
- See [Table 16](#) for  $C_{io}$ .
- See [Table 31](#) for  $C_{ia}$ .



**Fig 25. ADC input impedance**

### 13. Application information

#### 13.1 Start-up behavior

Figure 26 shows the start-up timing after reset. The IRC 12 MHz oscillator provides the default clock at Reset and provides a clean system clock shortly after the supply pins reach operating voltage.

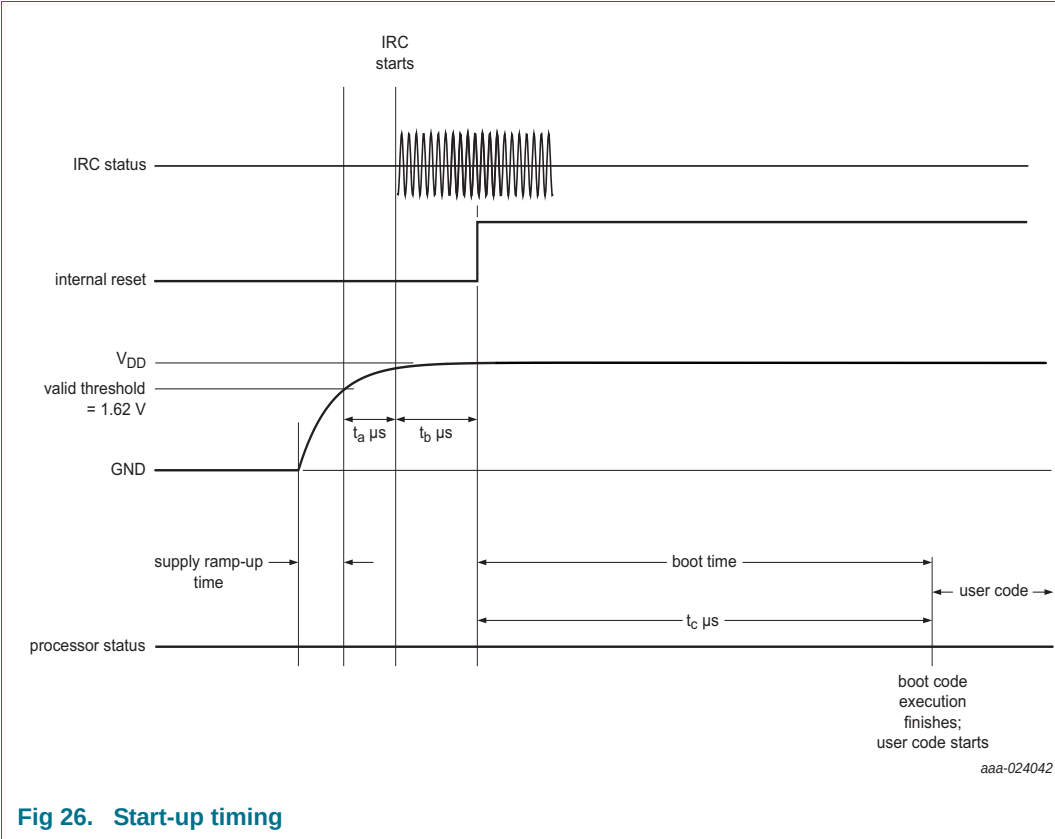


Table 33. Typical start-up timing parameters

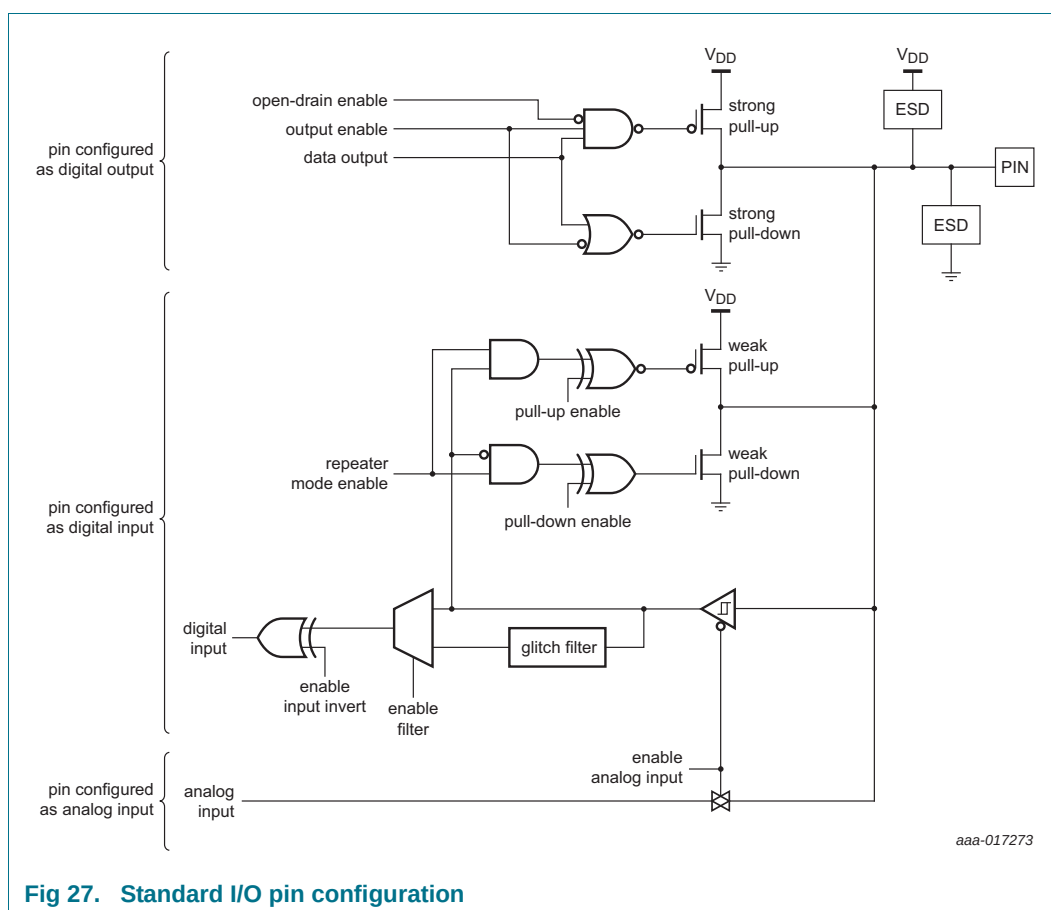
| Parameter      | Description                | Value   |
|----------------|----------------------------|---------|
| t <sub>a</sub> | IRC start time             | ≤ 20 μs |
| t <sub>b</sub> | Internal reset de-asserted | 151 μs  |
| t <sub>c</sub> | Boot time                  | 68 μs   |

## 13.2 Standard I/O pin configuration

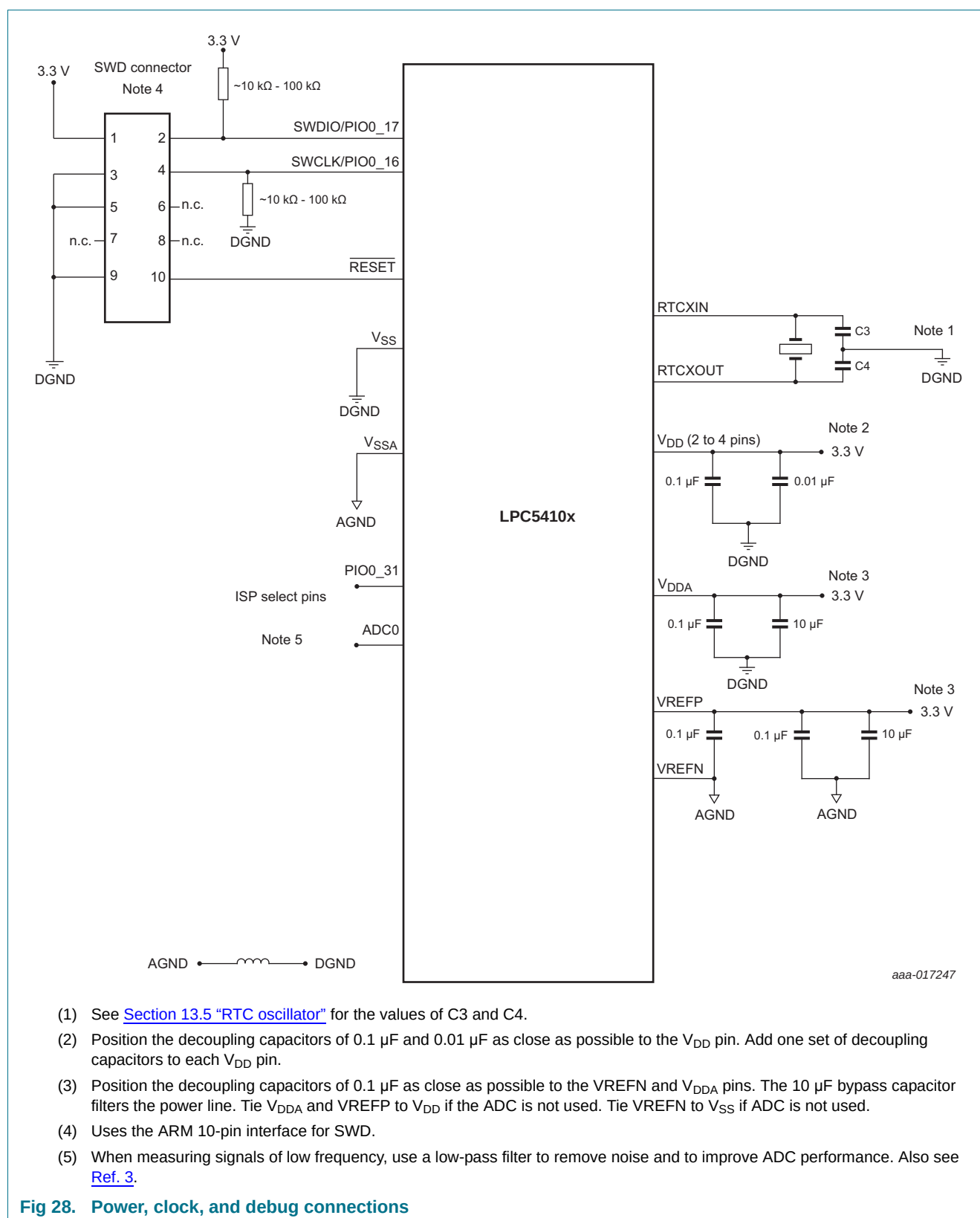
Figure 27 shows the possible pin modes for standard I/O pins:

- Digital output driver: with configurable open-drain output.
- Digital input: pull-up resistor (PMOS device) enabled/disabled.
- Digital input: pull-down resistor (NMOS device) enabled/disabled.
- Digital input: repeater mode enabled/disabled.
- Digital input: programmable input digital filter and input inverter.
- Analog input: selected through IOCON register.

The default configuration for standard I/O pins is input with pull-up resistor enabled. The weak MOS devices provide a drive capability equivalent to pull-up and pull-down resistors.



### 13.3 Connecting power, clocks, and debug functions



### 13.4 I/O power consumption

I/O pins can contribute to the overall static and dynamic power consumption of the part.

If pins are configured as digital inputs with the pull-up resistor enabled, a static current can flow depending on the voltage level at the pin. This current can be calculated using the parameters  $I_{pu}$  and  $I_{pd}$  given in [Table 16](#).

If pins are configured as digital outputs, the static current is derived from parameters  $I_{OH}$  and  $I_{OL}$  shown in [Table 16](#), and any external load connected to the pin.

When an I/O pin switches in an application, it contributes to the dynamic power consumption because the VDD supply provides the current to charge and discharge all internal and external capacitive loads connected to the pin.

The contribution from the I/O switching current  $I_{sw}$  can be calculated as follows for any given switching frequency  $f_{sw}$  if the external capacitive load ( $C_{ext}$ ) is known (see [Table 16](#) for the internal I/O capacitance):

$$I_{sw} = V_{DD} \times f_{sw} \times (C_{i0} + C_{ext})$$

### 13.5 RTC oscillator

In the RTC oscillator circuit, only the crystal (XTAL) and the capacitances  $C_{X1}$  and  $C_{X2}$  need to be connected externally on the RTCXIN and RTCXOUT pins. See [Figure 29](#).

An external clock can be connected to RTCX1 if RTCX2 is left open. The recommended amplitude of the clock signal is  $V_{i(RMS)} = 100\text{ mV}$  to  $200\text{ mV}$  with a coupling capacitance of  $5\text{ pF}$  to  $10\text{ pF}$ .

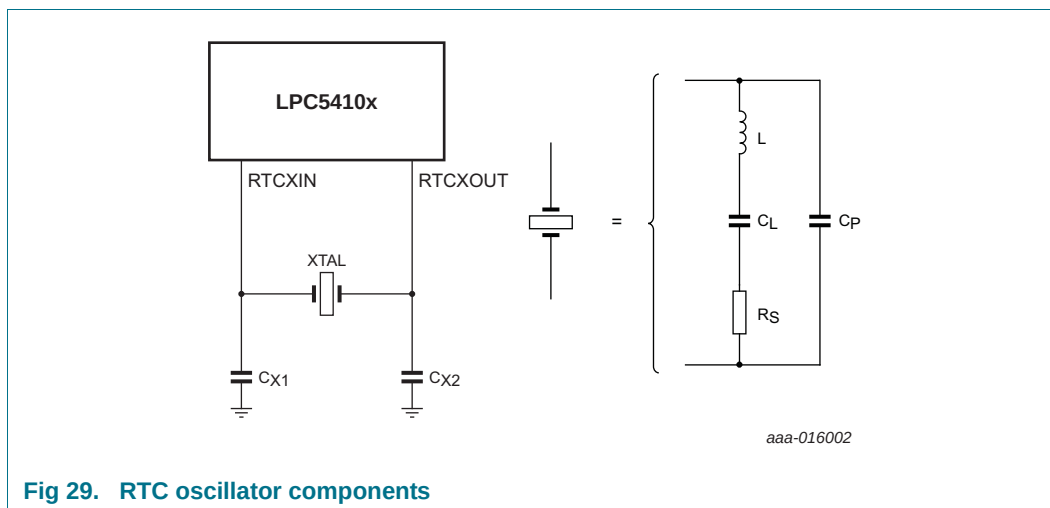


Fig 29. RTC oscillator components

For best results, it is very critical to select a matching crystal for the on-chip oscillator. Load capacitance ( $C_L$ ), series resistance ( $R_S$ ), and drive level ( $D_L$ ) are important parameters to consider while choosing the crystal. After selecting the proper crystal, the external load capacitor  $C_{X1}$  and  $C_{X2}$  values can also be generally determined by the following expression:

$$C_{X1} = C_{X2} = 2C_L - (C_{Pad} + C_{Parasitic})$$

Where:

$C_L$  - Crystal load capacitance

$C_{\text{Pad}}$  - Pad capacitance of the RTCXIN and RTCXOUT pins (~3 pF).

$C_{\text{Parasitic}}$  - Parasitic or stray capacitance of external circuit.

Although  $C_{\text{Parasitic}}$  can be ignored in general, the actual board layout and placement of external components influences the optimal values of external load capacitors. Therefore, it is recommended to fine tune the values of external load capacitors on actual hardware board to get the accurate clock frequency. For fine tuning, output the RTC Clock to one of the GPIOs and optimize the values of external load capacitors for minimum frequency deviation.

**Table 34. Recommended values for the RTC external 32.768 kHz oscillator  $C_L$ ,  $R_S$ ,  $D_L$ , and  $C_{X1}/C_{X2}$  components**

| Crystal load capacitance $C_L$ | Maximum crystal series resistance $R_S$ | Maximum crystal drive level $D_L$ | External load capacitors $C_{X1}/C_{X2}$ |
|--------------------------------|-----------------------------------------|-----------------------------------|------------------------------------------|
| 12.5 pF                        | < 70 k $\Omega$                         | 0.5 $\mu$ W                       | 22 pF, 22 pF                             |

**Remark:** The crystals with lower  $C_L$  (< 12.5 pF) values are not recommended.

### 13.5.1 RTC Printed Circuit Board (PCB) design guidelines

- Connect the crystal and external load capacitors on the PCB as close as possible (within 20 mm) to the oscillator input and output pins of the chip.
- The length of traces in the oscillation circuit should be as short as possible and must not cross other signal lines.
- Ensure that the load capacitors  $C_{X1}$ ,  $C_{X2}$ , and  $C_{X3}$ , in case of third overtone crystal usage, have a common ground plane.
- Loops must be made as small as possible to minimize the noise coupled in through the PCB and to keep the parasitics as small as possible.
- Lay out the ground (GND) pattern under crystal unit.
- Do not lay out other signal lines under crystal unit for multi-layered PCB.

14. Package outline

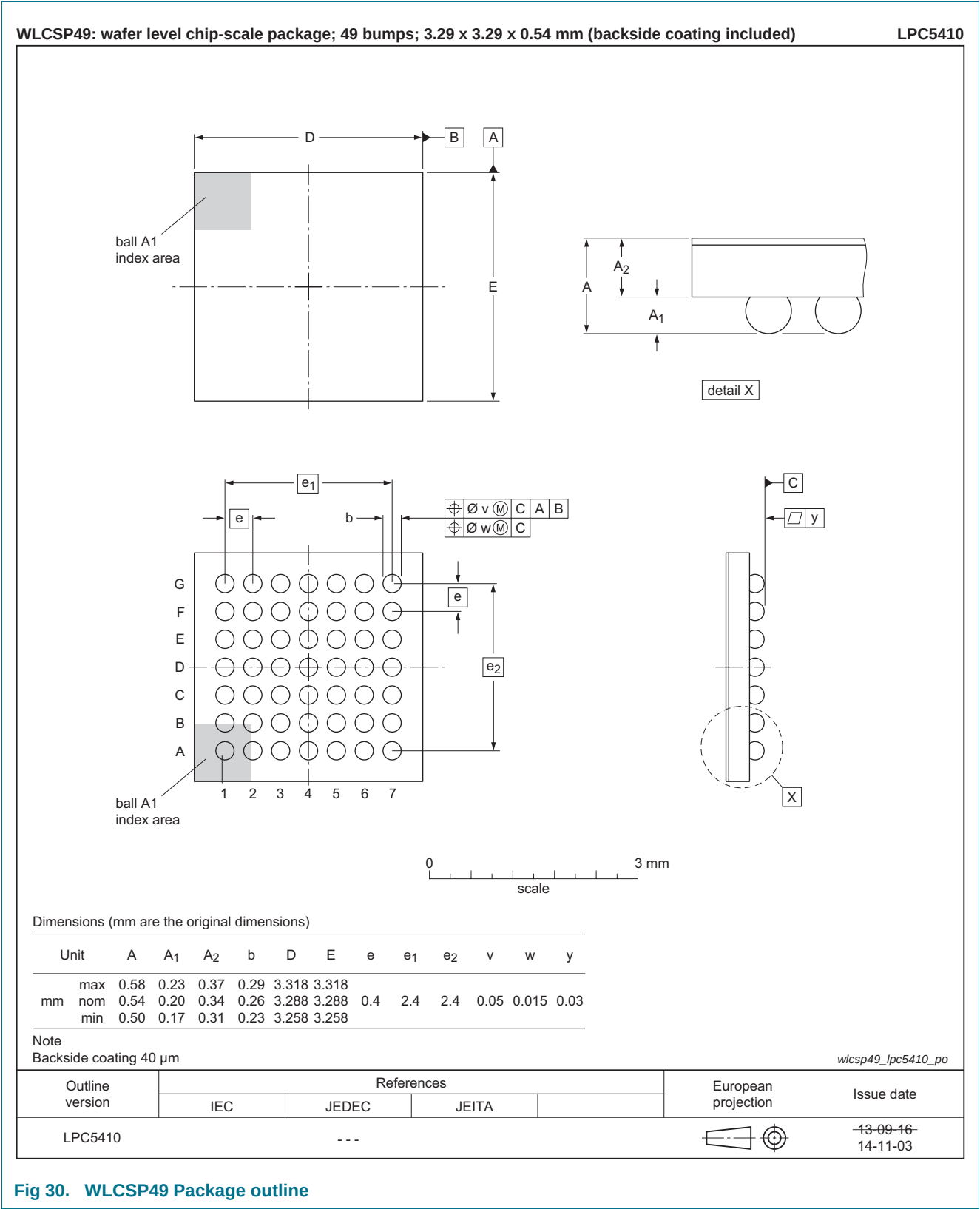
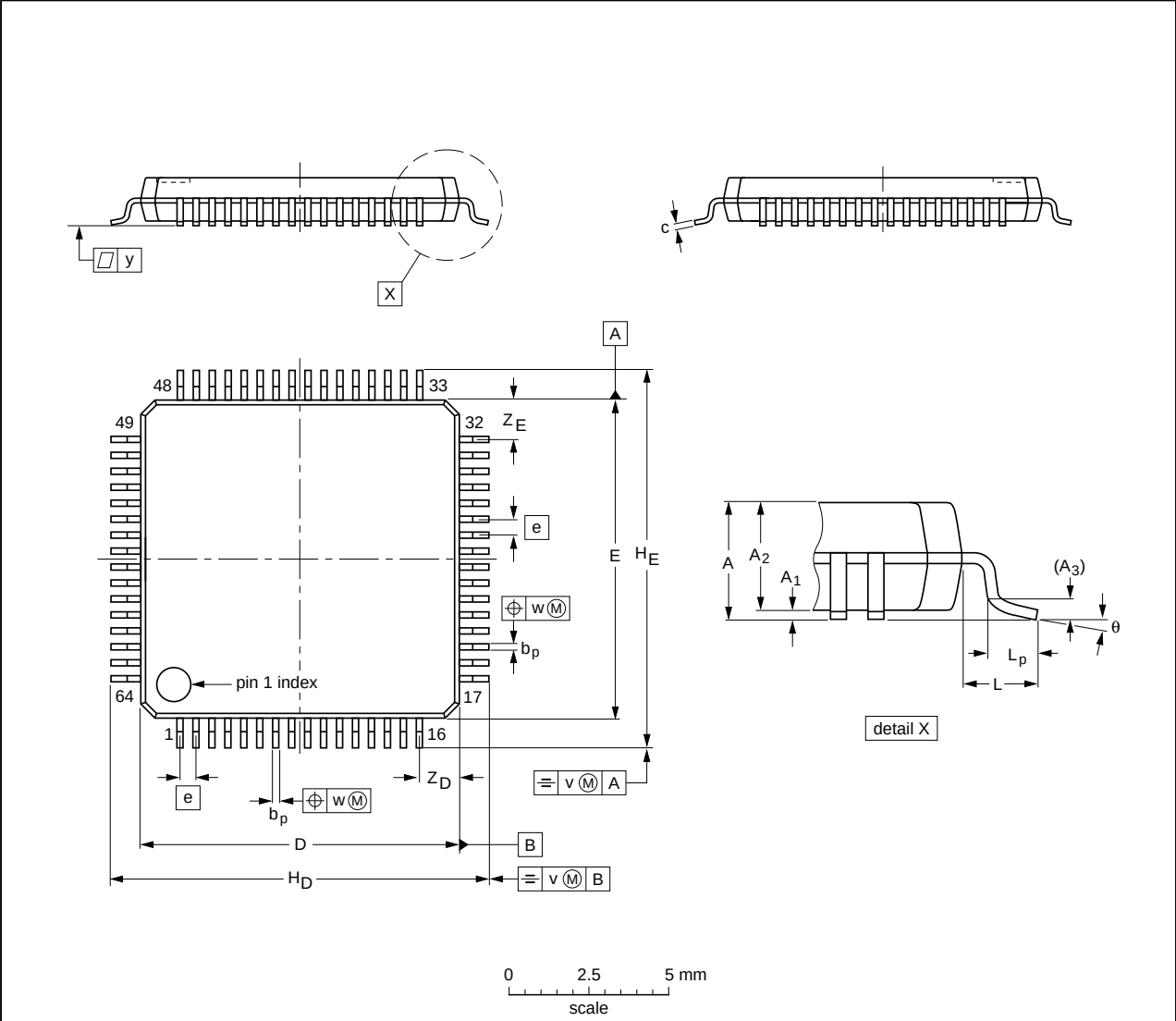


Fig 30. WLCSP49 Package outline

LQFP64: plastic low profile quad flat package; 64 leads; body 10 x 10 x 1.4 mm

SOT314-2



DIMENSIONS (mm are the original dimensions)

| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c            | D <sup>(1)</sup> | E <sup>(1)</sup> | e   | H <sub>D</sub> | H <sub>E</sub> | L | L <sub>p</sub> | v   | w    | y   | Z <sub>D</sub> <sup>(1)</sup> | Z <sub>E</sub> <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-----|----------------|----------------|---|----------------|-----|------|-----|-------------------------------|-------------------------------|----------|
| mm   | 1.6       | 0.20<br>0.05   | 1.45<br>1.35   | 0.25           | 0.27<br>0.17   | 0.18<br>0.12 | 10.1<br>9.9      | 10.1<br>9.9      | 0.5 | 12.15<br>11.85 | 12.15<br>11.85 | 1 | 0.75<br>0.45   | 0.2 | 0.12 | 0.1 | 1.45<br>1.05                  | 1.45<br>1.05                  | 7°<br>0° |

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE                      |
|--------------------|------------|--------|-------|--|------------------------|---------------------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                                 |
| SOT314-2           | 136E10     | MS-026 |       |  |                        | <del>00-01-19</del><br>03-02-25 |

Fig 31. LQFP64 Package outline



15. Soldering

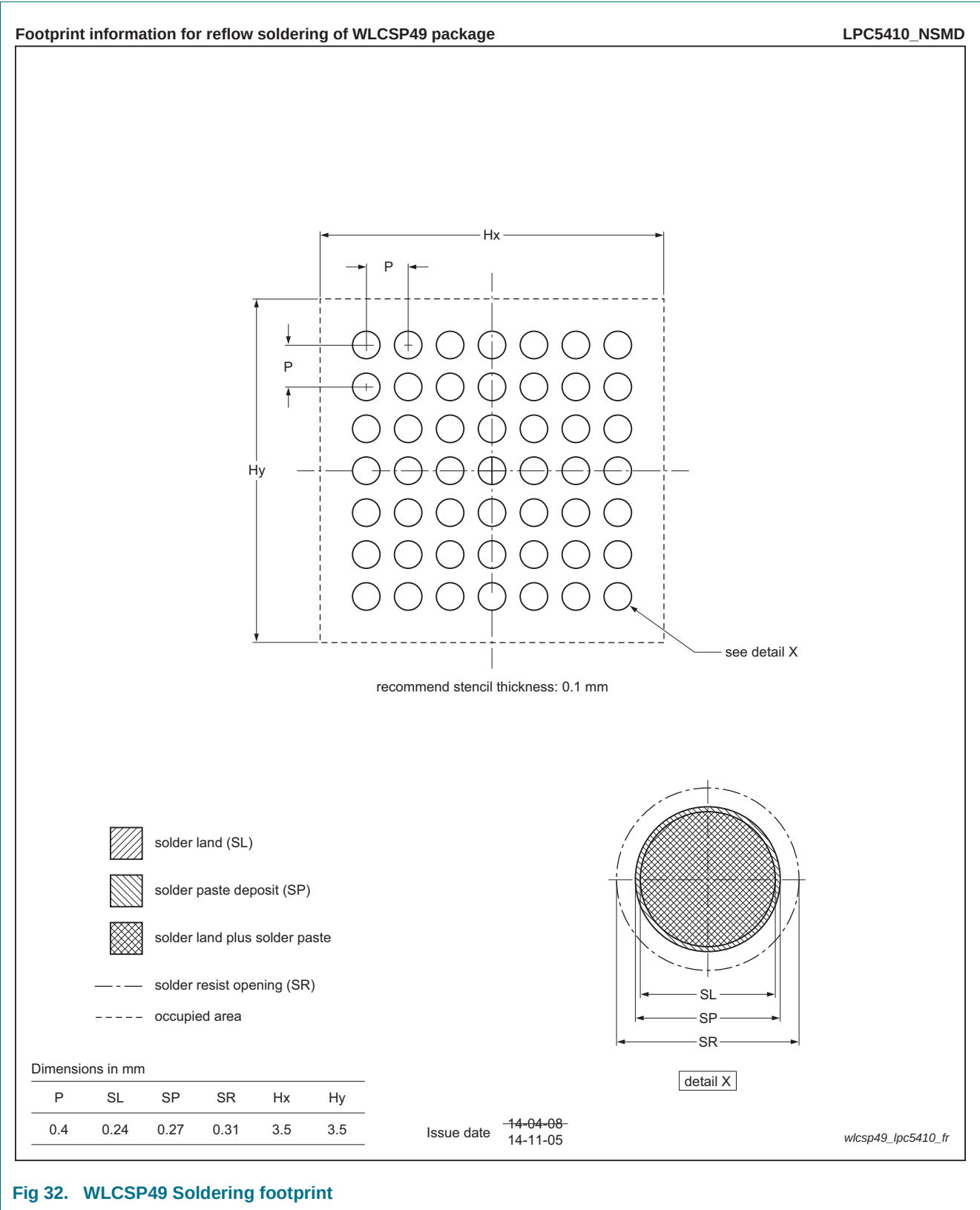
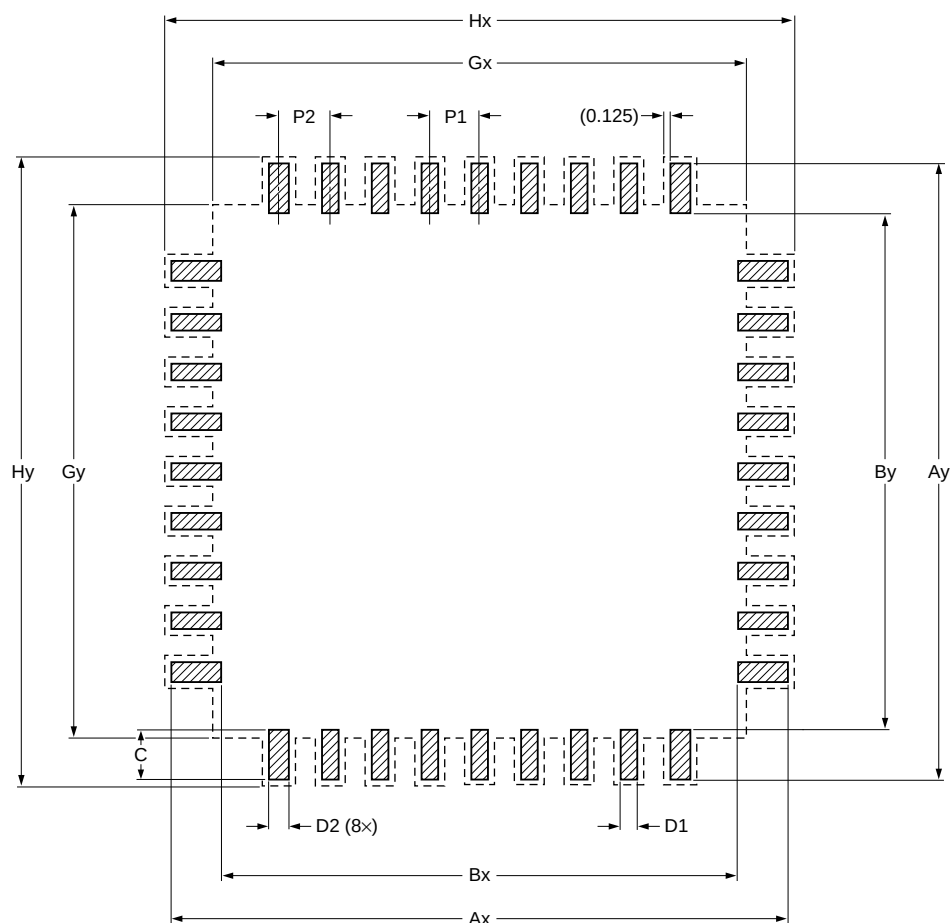


Fig 32. WLCSP49 Soldering footprint

### Footprint information for reflow soldering of LQFP64 package

**SOT314-2**



### Generic footprint pattern

Refer to the package outline drawing for actual layout



solder land

--- occupied area

DIMENSIONS in mm

| P1    | P2    | Ax     | Ay     | Bx     | By     | C     | D1    | D2    | Gx     | Gy     | Hx     | Hy     |
|-------|-------|--------|--------|--------|--------|-------|-------|-------|--------|--------|--------|--------|
| 0.500 | 0.560 | 13.300 | 13.300 | 10.300 | 10.300 | 1.500 | 0.280 | 0.400 | 10.500 | 10.500 | 13.550 | 13.550 |

sot314-2 fr

**Fig 33. LQFP64 Soldering footprint**

## 16. Abbreviations

Table 35. Abbreviations

| Acronym | Description                                 |
|---------|---------------------------------------------|
| AHB     | Advanced High-performance Bus               |
| APB     | Advanced Peripheral Bus                     |
| API     | Application Programming Interface           |
| DMA     | Direct Memory Access                        |
| GPIO    | General Purpose Input/Output                |
| IRC     | Internal RC                                 |
| LSB     | Least Significant Bit                       |
| MCU     | MicroController Unit                        |
| PLL     | Phase-Locked Loop                           |
| SPI     | Serial Peripheral Interface                 |
| TTL     | Transistor-Transistor Logic                 |
| USART   | Universal Asynchronous Receiver/Transmitter |

## 17. References

- [1] LPC5410x User manual UM10850:  
[http://www.nxp.com/documents/user\\_manual/UM10850.pdf](http://www.nxp.com/documents/user_manual/UM10850.pdf)
- [2] LPC5410x Errata sheet:  
[http://www.nxp.com/documents/errata\\_sheet/ES\\_LPC5410X.pdf](http://www.nxp.com/documents/errata_sheet/ES_LPC5410X.pdf)
- [3] Technical note ADC design guidelines:  
[http://www.nxp.com/documents/technical\\_note/TN00009.pdf](http://www.nxp.com/documents/technical_note/TN00009.pdf)

## 18. Revision history

Table 36. Revision history

| Document ID    | Release date                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | Data sheet status  | Change notice | Supersedes    |
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| LPC5410x v.2.4 | 20160713                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | Product data sheet | -             | LPC5410x v2.3 |
| Modification:  | <ul style="list-style-type: none"> <li>Updated <a href="#">Table 27 "SPI dynamic characteristics<sup>[1]</sup></a>:               <ul style="list-style-type: none"> <li>Min values of SPI master <math>1.62\text{V} \leq \text{VDD} \leq 2.0\text{V}</math>, <math>t_{\text{DS}}</math> and <math>t_{\text{V(Q)}}</math>.</li> <li>Min values of SPI slave <math>1.62\text{V} \leq \text{VDD} \leq 2.0\text{V}</math>, <math>t_{\text{DSHand}}</math> and <math>t_{\text{V(Q)}}</math>.</li> <li>Min values of SPI master <math>2.7\text{V} \leq \text{VDD} \leq 3.6\text{V}</math>, <math>t_{\text{DS}}</math>.</li> <li>Min values of SPI slave <math>2.7\text{V} \leq \text{VDD} \leq 3.6\text{V}</math>, <math>t_{\text{DH}}</math>.</li> </ul> </li> <li>Updated <a href="#">Table 28 "USART dynamic characteristics<sup>[1]</sup></a>:               <ul style="list-style-type: none"> <li>Min values of USART master (in synchronous mode) <math>1.62\text{V} \leq \text{VDD} \leq 2.0\text{V}</math>, <math>t_{\text{h(D)}}</math> and <math>t_{\text{v(Q)}}</math>.</li> <li>Min values of USART slave (in synchronous mode) <math>1.62\text{V} \leq \text{VDD} \leq 2.0\text{V}</math>, <math>t_{\text{h(D)}}</math>.</li> <li>Min values of USART master (in synchronous mode) <math>2.7\text{V} \leq \text{VDD} \leq 3.6\text{V}</math>, <math>t_{\text{h(D)}}</math>.</li> <li>Min values of USART slave (in synchronous mode) <math>2.7\text{V} \leq \text{VDD} \leq 3.6\text{V}</math>, <math>t_{\text{h(D)}}</math>.</li> </ul> </li> <li>Updated features of <a href="#">Section 7.16.2 "SPI serial I/O controller"</a>: Maximum supported bit rate for SPI master mode is 71 Mbit/s, and the maximum supported bit rate for SPI slave mode is 21 Mbit/s.</li> <li>Updated features of <a href="#">Section 7.16.1 "USART"</a>: Maximum supported bit rate of 24 Mbit/s for USART master and slave synchronous modes.</li> <li>Updated <a href="#">Table 22 "Dynamic characteristics of the PLL<sup>[1]</sup></a>:               <ul style="list-style-type: none"> <li><math>f_{\text{ref}}</math> changed to <math>F_{\text{in}}</math>; reference frequency to input frequency.</li> <li>removed <math>f_{\text{refjitter}}</math>.</li> </ul> </li> <li>Updated the description for <a href="#">Section 11.10 "SPI interfaces"</a>.</li> </ul> |                    |               |               |
| LPC5410x v2.3  | 20160524                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | Product data sheet | -             | LPC5410x v2.2 |
| Modification:  | <ul style="list-style-type: none"> <li>Updated <a href="#">Table 18 "Flash characteristics"</a>: For <math>N_{\text{endu}}</math> conditions, removed the row with page erase/program; page in small sector 10000 and removed the word large so that it is "page erase/program;page in a sector".</li> <li>Updated <a href="#">Section 7.16.1 "USART"</a> features: changed maximum bit rates to 6.25 Mbit/s in asynchronous mode.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                    |               |               |
| LPC5410x v2.2  | 20151222                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | Product data sheet | 201512007I    | LPC5410x v2.1 |

Table 36. Revision history ...continued

| Document ID   | Release date                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Data sheet status  | Change notice | Supersedes    |
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| Modification: | <ul style="list-style-type: none"> <li>Updated <a href="#">Section 11.6 "IRC"</a>, <a href="#">Table 23 "Dynamic characteristic: IRC oscillator"</a> for IRC frequency tolerance improvement over temperature.</li> <li>Added boot code version and device revision. See <a href="#">Section 4 "Marking"</a>.</li> <li>Added the abbreviation ISP to the Remark: This pin is also used to force In-System Programming mode (ISP) after device reset. See the LPC5410x User Manual (Boot Process chapter) for details to PIO0_31. See <a href="#">Table 4 "Pin description"</a>.</li> <li>Removed 164 uA PLL spec in peripheral power consumption table, <a href="#">Table 15 "Typical AHB/APB peripheral power consumption<sup>[3][4][5]</sup>"</a>.</li> <li>Added <a href="#">Table 21 "PLL lock times and current"</a>.</li> <li>Updated <a href="#">Figure 10 "Deep sleep mode: Typical supply current I<sub>DD</sub> versus temperature for different supply voltages V<sub>DD</sub>"</a>, <a href="#">Figure 11 "Power down mode: Typical supply current I<sub>DD</sub> versus temperature for different supply voltages V<sub>DD</sub>"</a>, and <a href="#">Figure 12 "Deep power-down mode: Typical supply current I<sub>DD</sub> versus temperature for different supply voltages V<sub>DD</sub>"</a>.</li> <li>Updated <a href="#">Table 12 "Static characteristics: Power consumption in deep sleep, power down, and deep power-down modes"</a>: added max values to Deep sleep mode at 25 °C and 105 °C, Power down mode at 25 °C and 105 °C. Changed typ and max values for Deep power-down mode RTC oscillator input grounded (RTC oscillator disabled) at 25 °C; was: typ = 84 nA, max = 240 nA; now: typ = 160 nA, max = 340 nA.</li> <li>Updated <a href="#">Table 13 "Static characteristics: Power consumption in deep sleep, power down, and deep power-down modes"</a>: added max values to Deep sleep mode at 25 °C and 105 °C, Power down mode at 25 °C and 105 °C. Changed typ and max values for Deep power-down mode RTC oscillator input grounded (RTC oscillator disabled) at 25 °C; was: typ = 135 nA, max = 470 nA; now: typ = 200 nA, max = 570 nA.</li> <li>Updated <a href="#">Table 7 "Limiting values"</a>: VESD, electrostatic discharge voltage, human body model; all pins value to 4000 V; was 5000 V.</li> <li>Updated <a href="#">Table 31 "12-bit ADC static characteristics"</a>: ED differential linearity error, VDDA = VREFP = 1.62 V and 3.6 V, typ value ±3 and ±2; EL<sub>(adj)</sub> integral non-linearity, VDDA = VREFP = 1.62 V, typ value ±5; V<sub>err(FS)</sub> full-scale error voltage VDDA = VREFP = 1.62 V and 3.6 V, typ value to ±3</li> </ul> |                    |               |               |
| LPC5410x v2.1 | 20150702                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Product data sheet | -             | LPC5410x v2.0 |
| Modification: | <ul style="list-style-type: none"> <li>Updated Figure 3 "LPC5410x Block diagram". Corrected Sync APB bridge to Async APB bridge.</li> <li>Updated external clock input for clock frequencies of up to 24 MHz to 25 MHz in Section 2 "Features and benefits".</li> <li>Updated Table 12 "Static characteristics: Power consumption in deep sleep, power down, and deep power-down modes". Fixed the unit of the max value from nA to µA for IDD in deep power-down mode; RTC oscillator input grounded (RTC oscillator disabled), T<sub>amb</sub> = 105 °C.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                    |               |               |

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| LPC5410x v2.0 | 20150417                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Product data sheet | -             | LPC5410x v1.1 |
| Modification: | <ul style="list-style-type: none"> <li>Updated the ADC conversion rate from 4.8 Msamples/s to 5.0 Msamples/s.</li> <li>Added Section 7.14 "Pin interrupt/pattern engine".</li> <li>Added Section 7.18.6 "Repetitive Interrupt Timer (RIT)".</li> <li>Updated Table 12 "Static characteristics: Power consumption in deep sleep, power down, and deep power-down modes" on page 44.</li> <li>Updated Table 15 "Static characteristics: pin characteristics" on page 49: <ul style="list-style-type: none"> <li><math>T_{amb} = -40\text{ }^{\circ}\text{C}</math> to <math>+105\text{ }^{\circ}\text{C}</math>, unless otherwise specified. <math>1.62\text{ V} \leq V_{DD} \leq 3.6\text{ V}</math>.</li> <li>updated min and max values.</li> </ul> </li> <li>Added Section 11.1 "Power-up ramp conditions".</li> <li>Added Section 11.9 "SPI interfaces", Section 11.10 "USART interface", and Section 11.11 "SCTimer/PWM output timing".</li> <li>Updated Section 11.5 "IRC": <ul style="list-style-type: none"> <li>added temperature conditions: <math>T_{amb} = 25\text{ }^{\circ}\text{C}</math>, <math>-40\text{ }^{\circ}\text{C} \leq T_{amb} \leq +105\text{ }^{\circ}\text{C}</math></li> <li>updated min and max values.</li> </ul> </li> <li>Added Table 14 "Typical peripheral power consumption".</li> <li>Added Table 28 "12-bit ADC static characteristics": <ul style="list-style-type: none"> <li><math>T_{amb} = -40\text{ }^{\circ}\text{C}</math> to <math>+105\text{ }^{\circ}\text{C}</math>.</li> <li>Values for <math>E_D</math>, <math>E_{L(adj)}</math>, <math>E_O</math>, and <math>V_{err(FS)}</math>.</li> </ul> </li> <li>Added Section 12.2.1 "ADC input impedance"</li> <li>Updated Figure 26 "Standard I/O pin configuration" on page 71</li> <li>Minor updates to Section 13.3 "I/O power consumption".</li> </ul> |                    |               |               |
| LPC5410x v1.1 | 20141117                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Product data sheet | -             | LPC5410x v1.0 |
| Modification: | <ul style="list-style-type: none"> <li>Minor editorial update in Section 1.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |                    |               |               |
| LPC5410x v1.0 | 20141106                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Product data sheet | -             | -             |

## 19. Legal information

### 19.1 Data sheet status

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|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
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| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

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[2] The term 'short data sheet' is explained in section "Definitions".

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